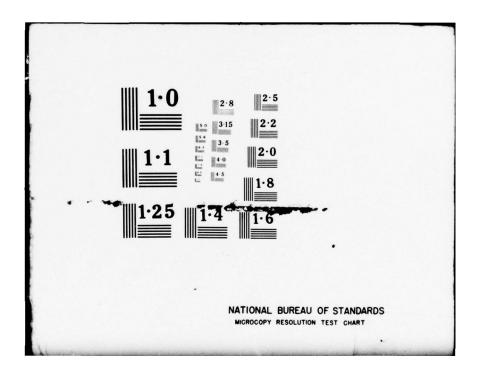
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Develco, Inc. 404 Tasman Drive Sunnyvale, California 94086

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Prepared for

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Final Report

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SUMMARY

The relatively new solid state, nonvolatile Magnetic Bubble Memory (MBM) devices have excellent potential in field data recording applications. This program was, therefore, undertaken to develop and evaluate a prototype subsystem model in order to assess the applicability in using MBM's for DNA event recording, and make system design recommendations that could be implemented when MBM production versions become available in the near future. Although many companies are engaged in MBM development, only three (Rockwell International, Texas Instruments, Plessy Memories) have started selling prototype versions at this time. The detail hardware and software design for the prototype memory evaluation system was based on the Texas Instrument version because of its availability and, more importantly, their approach seems to be the most flexible for general applications. A comprehensive test program was developed and used to evaluate the memory subsystem with favorable results. It is our conclusion that instrumentation can and should be developed to take advantage of the unique benefits possible with MBM devices, especially in rigorous field applications.

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PREFACE

This work was sponsored by the Defense Nuclear Agency under RDT&E RMSS Code B3440 77462 J11AAX5X352-49H2590D, and was performed under contract number DNA 001-77-C-0137.

We would like to thank the various manufacturers of Magnetic Bubble Memory devices, that we contacted, for their cooperation and assistance. In addition, special thanks is due to Mr. Gerald Cox, of the Texas Instruments MBM Product Marketing group, for his aid on design and evaluation test questions.

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SECTION 1 - INTRODUCTION

1.1 GENERAL

Magnetic Bubble Memories (MBM) are solid state devices in which information is stored in the form of a small cylindrical magnetic domain, or bubble, of opposite polarity to the thin layer of magnetic material in which it is located. These devices were first developed at Bell Telephone Laboratories in the 1960's by A.H. Bobeck and others¹, and there are now numerous companies actively engaged in the development of bubble memories for applications ranging from mass memory to digital recording systems.^{2,3} Two companies, Rockwell International and Texas Instruments, have just started to sell prototype versions within the last year or so, and one, Plessy Memories, plans to offer sample quantities by the end of 1977. Other organizations engaged in MBM development (e.g.; Bell, IBM, Hewlett-Packard, Intel, other semiconductor manufacturers, and various foreign sources) are either doing so for their own use, or have not made any decision to market them, or have not reached the prototype production stage.

Because of their non-volatile storage characteristics, relatively low power consumption and solid state construction, MBM's have excellent potential in field data recording applications. Therefore, this technology could have a significant impact on the Defense Nuclear Agency's (and others) field experiment programs by offering a way to achieve a reliable, secure, compact, and cost efficient alternative to tape recorders and recording oscilloscopes in many applications. The work described in this report was, therefore, undertaken to develop and evaluate a prototype memory subsystem model in order to make specific recommendations on data acquisition applications and system designs that could be implemented when MBM production versions become available in the near future.

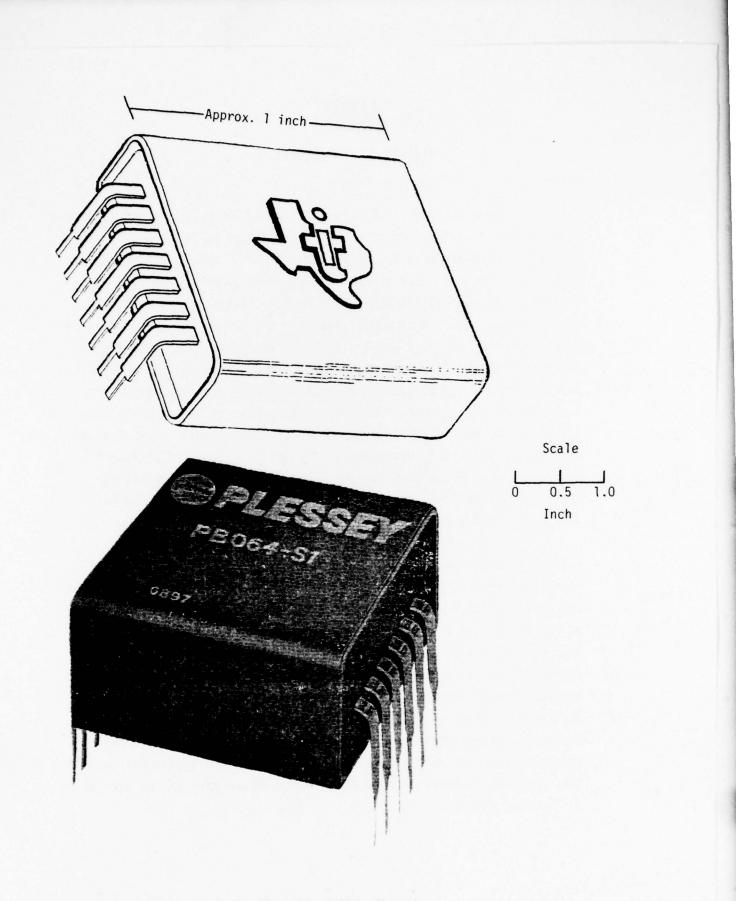


Figure 1-1. Magnetic Bubble Memories

1.2 MBM CHARACTERISTICS

MBM's consist of a wafer, or chip, on which the magnetic bubble circuits are constructed, and external magnets and coils which provide bias, and a rotating magnetic field to move the bubbles. The resulting component, Figure 1-1, is very compact and much like a standard Integrated Circuit (IC) so is inherently quite rugged if the coils are suitably encapsulated. All devices have a self-contained magnetic shield to protect them from external fields less than about 20 to 40 Oersteds, which is roughly 50 to 100 times the earth's field. Peripheral circuits are required for bubble generation, annihilation, control, and sense, as well as to generate rotating magnetic fields. A family of Large Scale Integration (LSI) devices is evolving from several manufacturers for direct MBM interface. There are many ways to organize a MBM chip ranging from a simple endless loop shift register to many parallel shift registers, such as T.I.'s 92K bit major/minor loop arrangement, and others. In addition, there may be one or many chips located within a bias magnet and coil set. Each configuration has significant advantages and disadvantages so it is likely there will be considerable evolution in the industry before some "standard" is settled on. (The theory and operating details of MBM's are extensively described in the literature; see the references and Appendix 1.)

Present manufacturing technology limits the capacity of practical indivisual chip sizes to about 100k bits, but this is expected to grow rapidly. Thus, 200k bit chips will be available soon, Megabit sizes are forecast for the not too distant future, and 10M bits should be achieved by 1982. Operating speeds of present devices are primarily limited by the resistance and inductance in the coil drive circuits which constrains most practical devices to operate below about 200kHz to 400kHz. The components now on the market all operate at a basic rate of 100kHz, but T.I.'s device is limited to a "data rate" of less than 50kHz by a "branching" operation. However, the mobility of even the relatively large bubbles in present devices is much better than that, and ways may yet be found to operate at speeds of up to 1MHz.

It is projected that eventually self biasing versions will be developed which will be capable of much higher speeds (optimistic forecasts suggest 10's of MHz).

One key advantage of some MBM's is that they can start and stop on a bit so power can be removed between operations in long term recording. However, some manufacturer's devices do not permit storage in the major loop which partially defeats this advantage.

Current devices are typically specified over an operating temperature range of 0°C to 70°C although this span can be readily shifted so a -30°C to +40°C range is covered, e.g., which would be more useful for field applications. The magnetic materials used will probably limit high temperature operations to a little over 100°C. But, operating ranges of -50°C to +100°C have been achieved in the laboratory, and it is reasonable to expect production versions with similar performance can be achieved in the future. The devices are also potentially capable of withstanding fairly severe mechanical shock if appropriate packaging methods are used. T.I. currently has a nonoperating specification of 300g, and has done very limited testing to 3000g. There does not seem to be any reason why MBM's could not also be operated at these levels.

1.3 CURRENT MBM ALTERNATIVES

The Rockwell International (Autonetics Group) development work has emphasized digital recorder subsystems. Their first commercial version, the POS/8, is organized as a 100k byte (8 bit word) endless loop recorder (Simple Single Shift Register), achieved by using 8 chips within a common magnetic bias and drive assembly, that can operate at a maximum rate of 100k bytes/second. In addition, they are developing a 10⁸ bit recorder (achieved by large chip arrays) which can operate at a 1MHz to 2MHz rate (achieved by multiplexing) for NASA.³ Although all memory functions are self-contained, external digitizing, multiplexing,

and control circuitry is required for use in a data acquisition system. The POS/8 is moderately expensive (around \$5,000 in small quantities), but it clearly will find use in some field applications, especially those that can use its capabilities directly, because of its current availability and relative simplicity. However, it is unlikely that the simple serial shift register will be implemented in future higher density chips so growth potential, except through the series addition of chips, is limited. Also, the "hybrid" chip packaging approach has limited flexibility for designing integrated general purpose, low cost data acquisition systems.

Texas Instruments and Plessy Memories, on the other hand, have emphasized the single chip approach that is similar to conventional semiconductor memories. That is, each chip has its own bias magnet, drive coils, and external shield in a relatively small dual-in-line type Integrated Circuit (IC) package. This allows considerable flexibility in system design which has obvious advantages in using the devices for diverse applications. There may be some long term price advantages too since this form is more likely to be mass produced, and to have a family of LSI interface devices. There is an efficiency penalty in that more space and support circuitry is required, but the advantages outweigh the problems in many applications.

A more significant problem in data acquisition applications is the fact that the primary market for the single chip devices is as a replacement or alternative to disc and other mass memory forms where random access time is important. This means that some form of major/minor loop architecture, which is difficult to use in straight high speed recording, will predominate until the projected radically different high speed, high density future generation versions emerge from the labs of Bell and IBM. This is further complicated, in the T.I. 92k bit multiloop device at least, by the fact that 13 out of the 157 minor loops are allowed to be bad to compensate for manufacturing yield problems.

(Even when the yield is improved on current low density devices, the push to higher density will keep the problem around for awhile.) It is necessary to keep track of and bypass these bad loops in addition to the normal minor loop transfers, etc. Thus, in straight recording applications a significant amount of additional control circuitry is required to deal with the multiloop structure. However, in advanced data acquisition systems there will be microprocessors, used for automatic data processing and formatting, etc., which can also be used for recording control so the penalty may not be serious.

It is worth noting that Plessy's first device will be a 64k bit serial shift register type that will be useful in simpler applications even though it is of lower capacity. However, they will follow this with a 64k bit multiloop organized device, and it is not clear whether they would continue the simpler serial version for long.

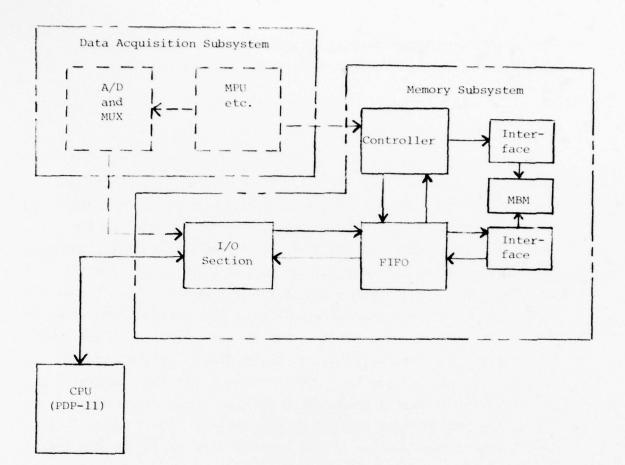
Since the objective of this program was to investigate utilizing MBM's for integrated general purpose low cost data acquisition systems, we chose to base our development work on the single chip devices. It is likely that the discrete devices will be most useful in the long run because of their inherent flexibility, e.g.; many applications can get by with a serial rather than 8 wide organization. Further, the Rockwell/NASA work has amply demonstrated the advantages and drawbacks of the simple shift register architecture in a multiple chip package.^{3,5} Because the Texas Instrument device was the only "discrete" device available to us at the start of this program, prototype versions were purchased for use in the prototype memory model. (The Plessy devices will not be available in sample quantities until late in the fourth quarter of this year.) Also, having to work with the more complex T.I. major/minor loop organization (complicated by the bad loop problem) now is really an advantage since it not only represents a worst case design problem, but this, or similar forms, is probably the organization other manufacturers will emphasize as a way to minimize access time,

particularly with higher density devices, for their most important applications (e.g.; disc memory replacement), at least in first generation devices.

1.4 SYSTEM DESIGN CONSIDERATIONS

There are two major classes of interface functions required for MBM operation as shown in Figure 1-2. The logic control section formats data (if required), sets up the timing, and keeps track of the read/ write operations. A direct MBM chip interface section provides the input drive and output sense functions. T.I. supplies a circuit board that emulates the functions of coil driver, function driver, sense amplifier, etc., specifically for prototype evaluation. This circuit board was used in the evaluation breadboard since these functions should soon be available as dedicated IC's, and are not terribly important to the general system problem. The T.I. design for a function timing generator circuit was used for a similar reason. The logic control section, however, is very dependent on the application requirements, and was the area of major emphasis on this program. For example, T.I. makes a CMOS controller, but it only operates with one device at a time, and cannot be used directly in 8 bit parallel operations. Since high speed 8 bit (or more) parallel operation represents one important category of data acquisition applications, and is the most complex with the T.I. architecture, the prototype memory controller was designed for this case. The design of the controller for the prototype MBM model is governed by two major factors:

- a. Sophisticated control should be incorporated in advanced data acquisition systems to handle such functions as automatic calibration, gain setting, adaptive data sampling, and such housekeeping functions as address, event timing, etc., data.
- b. Sophisticated control is the easiest way to handle the complex operational requirements of the MBM itself such as the major/ minor loop transfers, skipping failed loops, etc.



- 1) Provides input for test operations
- 2) Provides data dump for all operations

Figure 1-2. MBM System for data acquisition applications.

By sophisticated control, we basically mean one that has the power and flexibility of a Microprocessor Unit (MPU), or similar device. In order to consider the worst case design problem, a controller that is directly involved in the data handling was chosen, although this may not be the most generally useful way to do it. (See Section 4.2). Since this requires an operating speed greater than that of the Motorola 6800 MPU, for example, the Advanced Micro Devices AM2901 four bit slice bipolar cascadable microprocessor was chosen to achieve the speed and computational power required. This achieved, in effect, a "nanoprocessor" with considerable add-on capability. It is also needed to interface with more complex functions, e.g.; the MPU in a complete data acquisition system. A further advantage of this approach was that it permitted getting the memory system up and running with a minimum amount of design and software effort. Even so, the resulting design is fairly powerful on its own. For example, not only can it perform the complex MBM control functions for a simple fixed sample rate acquisition in its present form, it could be made to do responsive data acquisition with additional software, or to do limited adaptive data acquisition, event time, and address recording with some additional hardware and software.

A First-In/First-Out (FIFO) buffer memory was also used on the prototype system to provide the required "elasticity" to deal with the bad minor loop problem characteristic of the T.I. "prototype" MBM devices. Note that this function can simply be eliminated when T.I. achieves 100% device yield as eventually expected in "production" devices. An input/output (I/O) section is used to interface with a PDP-11 minicomputer which serves to provide selected data pattern inputs for test operations, and to dump data stored in the memory for all operations. The computer also is very useful for analyzing the data, and as an aid in trouble shooting for test work. For use in a data acquisition system, an A/D converter and multiplexer function would simply be inserted in place of the computer for acquisition, and disconnected for dump. (The details of the system design and test results are discussed extensively in the following sections.)

1.5 FUTURE POTENTIAL

The long term technical potential for MBM devices appears to be very good. They are capable of being operated under fairly extreme environmental conditions, and appear destined to fill a gap in the speed/cost spectrum between existing forms of solid state memories and large mass memory systems. The advantages of non-volatility are obvious regardless of whether the application is cash registers or unattended data recording. MBM technology is radically different, and in its infancy, so it is reasonable to expect that current technical problems will be overcome in the near future. However, the ultimate impact MBM's will have on the market depends to a very great extend on whether they can be made cost competitive. For example, it is estimated that 100k byte memory subsystems, based on production versions of today's devices, could be sold for around \$1,500, or about 0.2 cents per bit, which is higher than most electro-mechanical methods. But, forecasts show that 10M bit chips, and prices per bit of 0.01 cents are possible by 1982, which is competitive with most other methods; so the overall prospects do appear to be good. Therefore, it is our conclusion that MBM technology will survive, in a competitive sense, and that instrumentation should be developed to take advantage of the unique cost and performance benefits that are possible with MBM devices, especially in rigorous field applications.

SECTION 2 - PROTOTYPE MEMORY SYSTEM DESIGN

2.1 SYSTEM DESCRIPTION

The prototype Magnetic Bubble Memory system consists of both hardware and software. The hardware consists of 8 MBM boards and 5 control boards as shown in the block diagram, Figure 2-1. The software consists of micro programs for the MBM controller and PDP-11 programs for communications with the MBM controller. These items are discussed in more detail in the following sections.

A Digital Equipment Corporation PDP-11/05 Computer is used as a means of communicating with the MBM controller for tests and data dump operations. It instructs the controller to read or write a particular file from the MBM. Data is transmitted to or from the memory through 8 First In-First Out (FIFO) devices. Also, on the FIFO board is a Programmable Read Only Memory (PROM) which contains information about the "bad" loops in the MBMs. This map prevents the generation of data in bad loops or the reading of data from bad loops. Commands from the PDP-11 are received by the controller through a branch control board which causes the controller to branch to a Read or Write routine. The PDP-11 sends the first word containing the command and the two most significant bits of the file address. When the controller receives the first word it sends an indication to the PDP-11 which causes the remaining 8 bits of the file address to be transmitted to the controller. In the case of a write-into-memory routine, the PDP-11 sends data to the FIFOs until a FIFO Full signal is received from the controller. It waits until the FIFO is not full and then sends more data. This process is repeated until 144 bytes of information are transferred to the FIFOs.

In the case of a read-from-memory the PDP-11 waits until a FIFO not empty signal is received from the controller and then reads data from the FIFO until the FIFO EMPTY signal is received. The PDP-11 then waits until it has received 144 bytes of information.

The MBM controller board sends signals to the PDP-11 and other function controls via 2 latches on the branch control board. After the controller receives the instruction and file address it enables the MBM boards and shifts the bubbles in the minor loops the number of times specified by the file address. A Transmit Out enable signal is sent to the function timing board which transmits the file (1 bit from each minor loop) into the major loop. The bubbles in the loops are then shifted a number of times (68) then the controller either enables the replicate (read) or annihilate (write) signals from the timing board. The controller shifts the bubbles either 19 times in the read mode or 228 times in the write mode before enabling the FIFO clock and the Detect Strobe (read) or Generate Signal (write) from the timing board. These signals are enabled every other cycle (data occurs every other position) of the bubbles until 157 bits (including zeros in the bad loop positions) are transferred. The bubbles are then shifted until they are again over the minor loops and then transferred in. The bubbles are then shifted until they are back in the same position in the minor loop as they were prior to the start of the operation. Note that data storage in the major loop is not permissible with current T.I. devices. The controller then inhibits or resets all necessary devices and waits for another instruction.

The Magnetic Bubble Memory prototype system is contained in a card file with 14 card positions as follows:

- (5) Controller Boards
- (8) MBM Boards
- (1) Spare

Each board plugs into a 44 pin wire wrap connector on the back plane where power inputs and most interboard signals are wired. However, some inter-controller board communication is accomplished through ribbon cables.

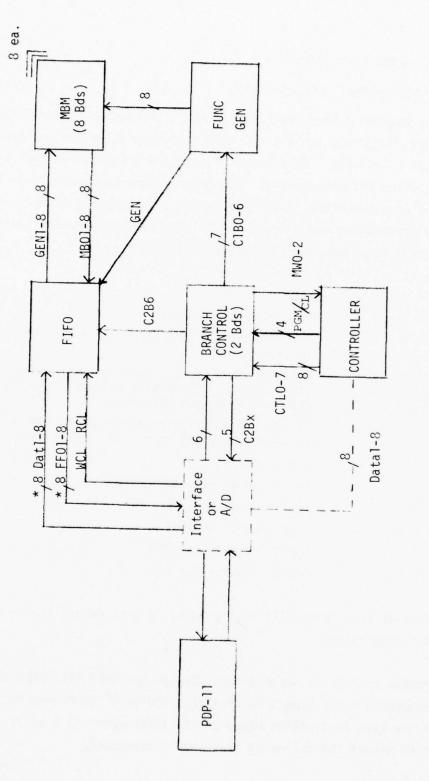


Figure 2-1. Block Diagram MBM System

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2.2 DETAILED HARDWARE DESCRIPTION

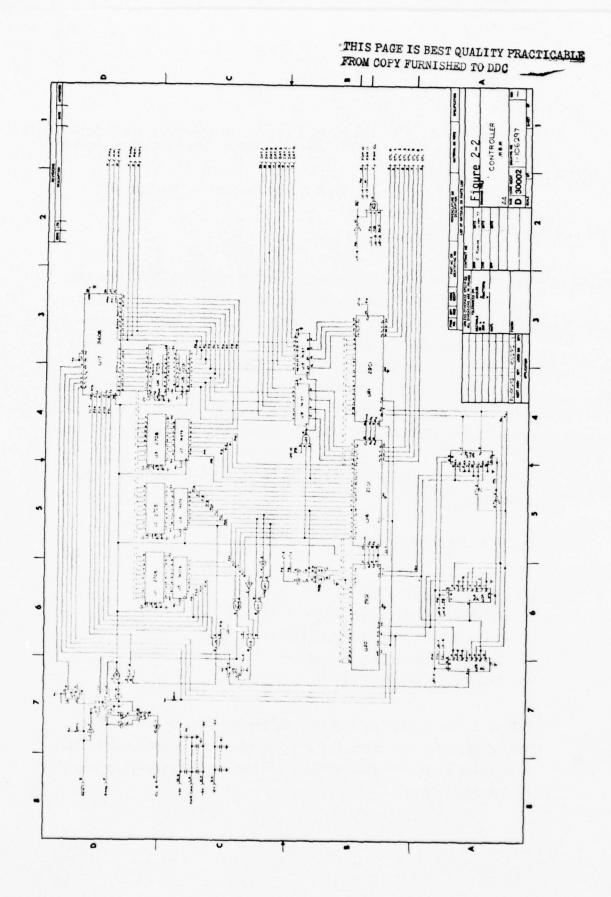
1. Controller Board (Figure 2-2)

This section assumes familiarity with workings of the 2901 Four Bit Slice Microprocessor and the 9408 Microprogram Sequencer, Appendices II and III. This board is designed around three 2901 Four Bit Slice Microprocessors. The micro programs are stored in four 2708 Erasable PROMS, each PROM having a capacity of 1k x 8 bits. The instruction words are 32 bits long, some bits having specific control functions and some having multiple functions.

BITS 0 - 7	Data
BITS 0 - 9	Data of Branch Address
BITS 8 - 9	Shift control of the carry bit during shift instructions.
BITS 0 - 2	Branch control during Multiway Branch instruc- tions (bits 3 - 9 contain the most significant bits of the Branch Address).
BITS 10 - 13	"A" Register designation for the Microprocessor or I/O control during an I/O instruction.
BIT 14	Carry Control
BITS 15 - 18	"B" Register designation for the 2901
BITS 19 - 21	Destination code for 2901
BITS 22 - 24	Source code for 2901
BITS 25 - 27	Operation code for 2901
BITS 28 - 31	Branch Control for 9408

Usage of these bits will be discussed in more detail in the software description.

Program control is accomplished through the 9408 Microprogram Sequencer, i.e.; Branch Controller. The 9408 determines the address of the next instruction based on the instruction in bits 28 - 31 which permit the following types of instruction:



Multiway Branch - The lower 3 bits of the address are determined by an external source (branch control board). Unconditional Branch Conditional Branch - Any 1 of 4 bits tested for True or False. Branch to Subroutine Return from Subroutine

The 9408 controls the 10 address lines of the 2708 PROM directly. Data from the PROMS are clocked into four 8 bit latches (74273). The lower 8 bits of the word go to 2 quad 1 of 2 data selectors (74157). The other 8 inputs to the 74157's are data lines from the PDP-11 through the I/O interface board. Selection of which data are received by the 2901's is a function of other bits in the word determining the type of instruction. Bits 8 and 9 are also gated to the 2901 to load a 10 bit value to the processor.

Eighteen other bits go directly to the 2901 which determine the operation.

Outputs of the three 2901's are as follows:

- a) 8 bits for control
- b) Results = \emptyset (Z bit)
- c) Results = Negative (N bit)
- d) Carry out on left shift (C bit)
- e) Carry out on right shift (C bit)
- f) Arithmetic overflow (V bit)

The V, Z, and N bits go directly to the branch controller which may be tested. The carry (C) bit tested by the branch controller is a function of the instruction. It may be the results of any of the following:

- 1) C_+4 of the most significant 2901
- 2) R₃ of the most significant 2901
- 3) Q_3 of the most significant 2901
- 4) Q₀ of the least significant 2901
- 5) R₀ of the least significant 2901

The R_3 , Q_3 , R_0 , and Q_0 inputs and outputs are also a function of the word such that arithmetic shifts or rotates can be accomplished.

Along with the 8 control line outputs two address lines PGM10 and PGM11 and a clock are generated for steering and clocking data on the branch control board.

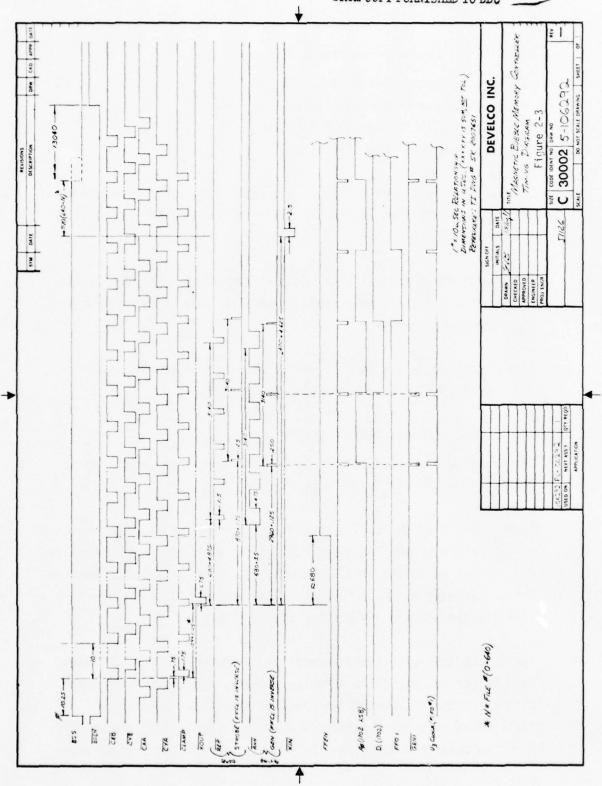
Also generated on the controller board are the 4 clocks required for operation (See Timing Diagram, Figure 2-3).

2. Branch Control Board (Figure 2-4)

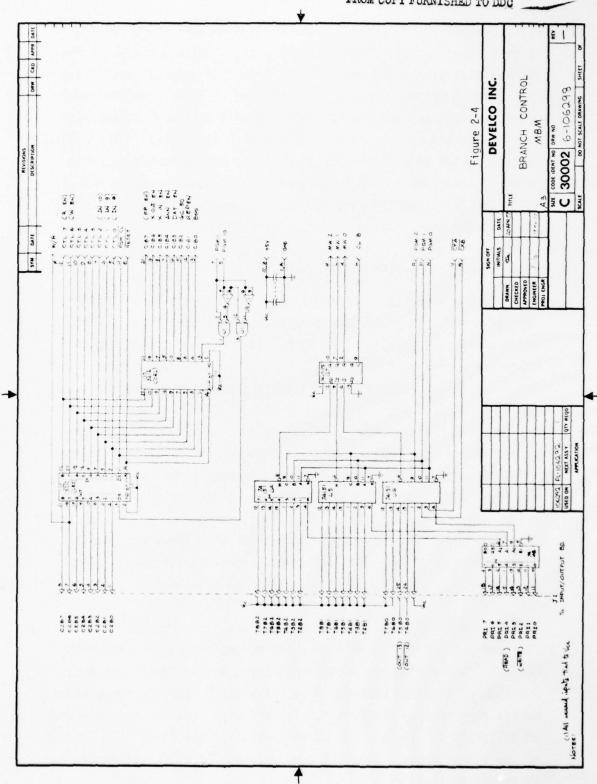
The branch control consists of 2 output latches for data from the controller board and branch control circuitry.

Output data from the 2901's is clocked into 1 of 2 eight bit latches as determined by the PGM10 and PGM11 lines also from the controller. C2B outputs go to the PDP-11 through the I/O board and C2B6 (Write/ Read) also goes to the FIFO board. C1B outputs go to the function timing board and are enables for timing signals.

The branch control circuitry consists of three 74151, one of eight data selectors, one 74148 priority encoder, and one 74L5175 Quad D latch. When the controller executes a multiway branch, instruction bits 0 - 2 determine the gate selection of the 74151's. The 3 outputs then determine the 3 least significant bits of the



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branch address. The priority encoder (branch address 0) allows up to 8 input commands from external sources which would determine the function of the MBM controller. Presently only two inputs are used (Read & Write). However, another device with higher or lower priority could command another task. Branch addresses 1 and 2 are the CXB and CYA signals from the function timing board. These allow the controller to wait for specific points in the bubble cycle in order to count and set control lines. Branch addresses 4 and 5 allow the PDP-11 to indicate when data is ready for the controller, specifically the 2 portions of the file address.

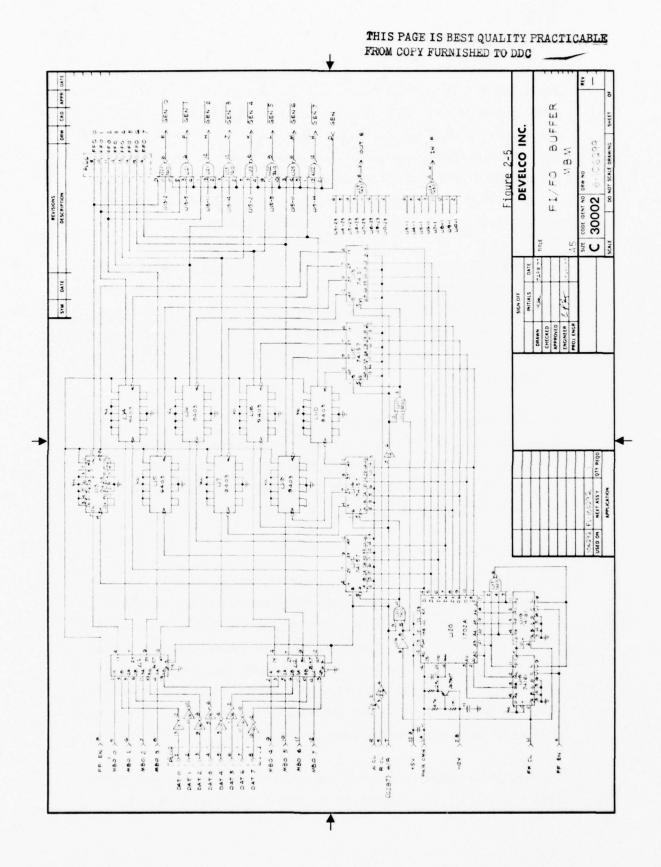
3. FIFO Board (Figure 2-5)

The FIFO board mainly consists of eight 9403 64-bit First In/First Out registers, six 74157 Quad 1 of 2 data selectors for the FIFO clock and data control, a 1702 PROM (256 x 8 bits) containing the bubble map, and two 74161 4-bit counters for the 1702 address control. (Refer to Section 2.3.3 for a discussion of the map.)

Data are clocked into the FIFOS via control of Ul and U2. In the case of write-into-memory, data are entered from the PDP-11 through the DATØ-7 lines. In a read from memory process data are clocked in from the MBM boards via the MBOØ-7 lines.

Data are clocked out of the FIFOS to the FFO \emptyset -7 lines (to PDP-11 in read mode), and the GEN \emptyset -GEN7 gates (in the write mode). The GEN signal comes from the timing board when enabled.

Four of the 74157's gate the FIFO input and output clocks. During the read process the input clocks are controlled by the 1702 PROM Map data, and during the write process the output clocks are a function of the 1702 PROM Map data. The RCL & WCL clocks are 400ms pulses generated by the PDP-11. The W/R line controls the switching of all 74157's. The address clock (FFCL) for the 74161's is generated on the timing board. The FIFO enable/reset (CRFF) is set or cleared by the controller.



Addresses 0 - 157 of the 1702 are programmed with a map of the minor loop status of each MBM. Of the 157 locations there are 144 1's and 13 \emptyset 's in each bit position. The \emptyset 's indicate bad minor loops. For instance WORD \emptyset may consist of minor loop \emptyset on boards 1 - 6, minor loop 1 on board 7 and minor loop 2 on board 8. The output from the PROM also enables or inhibits the GEN gates to prevent writing 1's into bad loops which is not allowed.

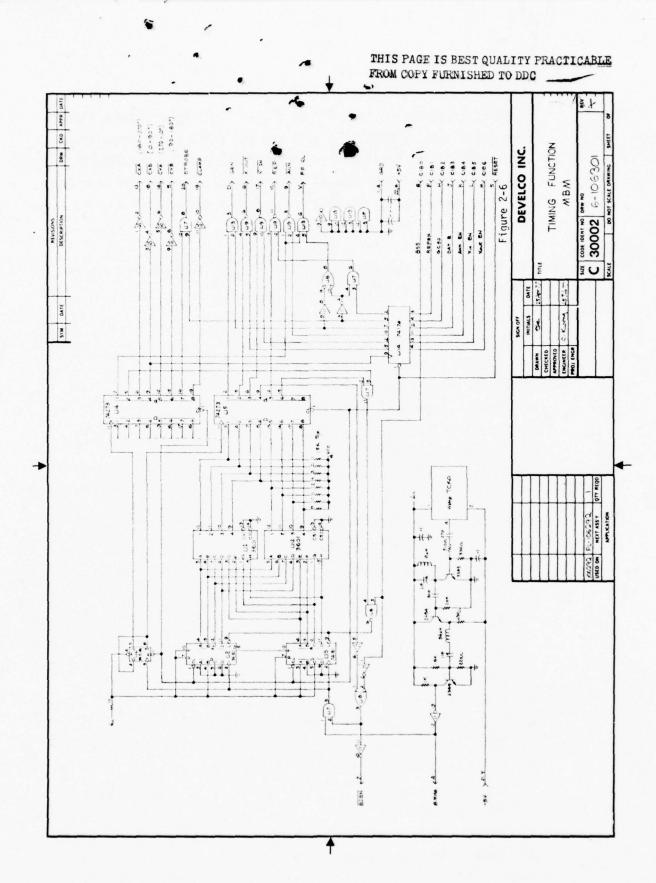
When the FFCL line goes high, the address counter is clocked and the appropriate pair of 74157's is ungated causing any high outputs produced by the 1702 to go low which will clock the FIFOS if outputs were previously high. This in essence says the data at the input is good or the data at the output was written into the bubble, so advance the FIFO.

Two FIFO status signals are sent to the PDP-11 via the I/O boards. These signals are FIFO Empty and FIFO Full. The lines are true if the status is true for any one of the FIFOS. These signals are used by the PDP-11 in loading or unloading the FIFOS during the Write and Read processes.

4. Function Timing Board (Figure 2-6)

This board produces the required accurate timing signals for the MBM control, FIFO clock, and 8MHz clock for the controller board. The function timing code, described in Section 2.3.4, is stored in two 3601 PROMS. Note that the Function Timing Generator Circuit is basically the T.I. design adapted to suit the requirements of this system. The oscillator is a 4MHz TCXO. The timing circuit requires 8MHz, to achieve the desired resolution, thus a frequency doubler circuit was incorporated on the board.

The two 74161 Counters provide the address for the two 3601 PROMS (256×4 bits). The outputs of the PROMS are clocked into two



74273 8-bit latches. In order to obtain 14 different clock signals from the 8 bits of PROM, the data for the 74273's are interleaved and each 74273 is clocked from a different phase of the 4MHz 2 phase clock produced by the 7474. Therefore, the outputs from U4 and U5 are relative to each other in $.125\mu$ s increments, and all signal durations are in multiples of $.25\mu$ s.

The timing board has 8 inputs and 14 outputs. The inputs are as follows:

- 1) Reset
- 2) BSS Enables timing and the MBM board
- 3) REPEN Enables replicate
- 4) ANNEN Annihilate Enable
- 5) XINEN Transfer in Enable
- 6) XOUTEN Transfer out Enable
- 7) DATEN Enables GEN output and FIFO clock
- 8) GC50 Enables Strobe and FIFO clock

Inputs 3 - 8 (above) are clocked into a 74174 6-bit latch. The outputs are as follows:

- A) BDEN MBM board Enable
- B) 8MHz clock
- C) $\overline{\text{CXB}}$ 0-90° of the coil drive
- D) \overline{CYB} 90-180° of the coil drive
- E) $\overline{\text{CXA}}$ 180-270° of the coil drive
- F) \overline{CYA} 270-0° of the coil drive
- G) FFCL FIFO clock
- H) GEN Enables Generate gates on FIFO board
- I) XOUT Transfer Out
- J) XIN Transfer In
- K) REP Replicate
- L) ANN Annihilate
- M) STROBE Data clock for MBM board
- N) CLAMP Sense amplifier control

5. I/O Interface Board (Figure 2-7)

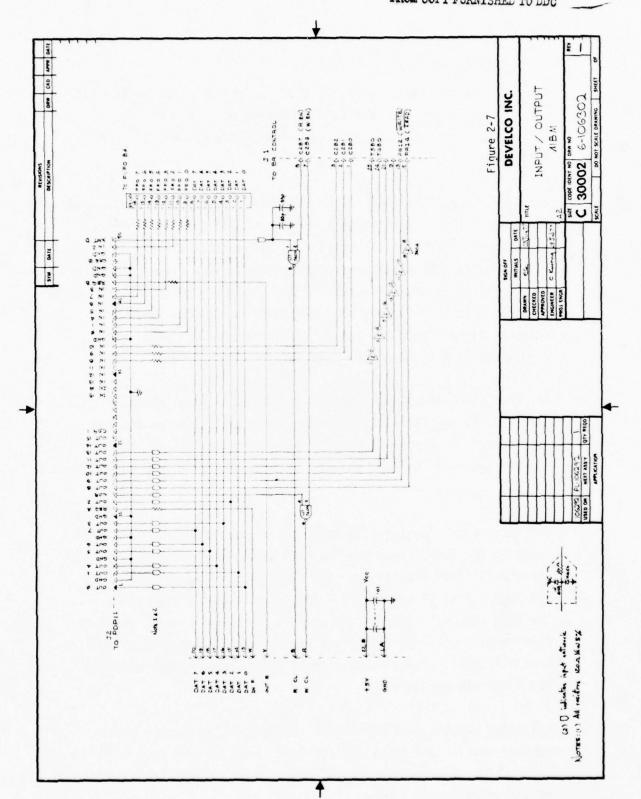
The I/O (Input/Output) interface board interfaces the PDP-11 to the controller boards. The PDP-11 interfaces to the controller through a Digital Equipment Corporation DR11-C general device interface.

All lines on the I/O board are terminated with 120 ohm resistors to reduce the rise time of signals, and thus reduce cross coupling noise over the 25 feet of interface cable to the PDP-11. All inputs to the I/O board are terminated with diode clamps to \emptyset volts and +5 volts, as are the inputs to the DR11-C to limit voltage transients to .6 volts within \emptyset volts and +5 volts. Other individual signal functions were slowed even more by capacitors if they were found to be excessively noisy.

The Read Clock (RCL) and Write Clock (WCL) are 400ns pulses generated by the PDP-11, and correspond respectively to the New Data Ready and Data Transmitted signals from the DR11-C. These signals are gated by C2B6 and C2B7 controlled by the MBM controller board.

The least significant 8 bits of input and output to/from the PDP-11 are used for Data Transfer. The FIFO Output Empty (OUTE) and FIFO Input Full (INF) signals from the FIFO board go to the REQA, and REQB inputs to the DR11-C. Two other inputs are wired to the CSRØ and CRS1 lines of the DR11-C, but are not used. Another 3 lines go to the IN8-IN10 lines of the DR11-C, but only two are presently used for the controller to signal the receipt of each of the 2 address portions.

Six other outputs from the DR11-C (OUT8-OUT14) go to the branch control board, four of which are used. (Two for the Read or Write Instruction, and two for branch control when each of the 2 portions of the address are ready.)



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6. Bubble Memory Board (Figure 2-8)

(Refer to the Timing Diagram, Figure 2-6, and the current MBM Specification, Appendix I.)

The MBM Boards (8) were designed by Texas Instruments specifically for prototype evaluation purposes. The board may be discussed in three parts, i.e.; bubble shifting control, bubble function (generate, transfer, etc.) controls, and sensing.

The current in the X and Y coils controls the shifting of the bubbles in the TBMO101. The currents in these coils are controlled by the $\overline{\text{CXB}}$, $\overline{\text{CYB}}$, $\overline{\text{CSA}}$, and $\overline{\text{CYA}}$ input signals. The alternating currents in the coils are produced by two 75325 Field Drivers and diode matrices at their outputs.

Individual control of bubbles is accomplished by driving three gates with a specified pulse width and current amplitude. The three control gates are Transfer, Replicate/Annihilate, and Generate. The five board input signals are \overline{XIN} , \overline{XOUT} , \overline{REP} , \overline{ANN} , and \overline{GEN} each received by 1/2 of a 75463 Dual Peripheral Driver. The output of each 1/2 of the 75463 controls a constant current source determining the amplitude of the signals to the three control gates. The width and timing relationship of the control signals are determined by the function timing board.

During the Read process, the output of the MBM is detected by a MC1444 sense amplifier. The output of the sense amplifier is clocked into 1/2 7474 as determined by the strobe input from the timing board. The output of the 7474 is buffered through 1/2 of the 75463 peripheral driver. The Clamp input from the timing board to the MC1444 enables the input to be detected when high. During the Write process the Gen line being low will cause a bubble to be created. During the Read process the presence of a bubble will produce a low output.

2.3 DETAILED SOFTWARE DESCRIPTION

This section will discuss in detail four items:

- 1) PDP-11 Programs
- 2) MBM controller micro programs
- 3) MBM map programming
- 4) Timing control program

Items 1 and 2 are interrelated in that each item relies, in part, on the other to produce specific signals as a result of the programming, i.e.; it is a handshaking process. For sections 2.3.1 and 2.3.2 it is assumed that the reader has a basic knowledge or understanding of software. However, it may be helpful to refer to the Digital Equipment Corporation handbooks, references 7 and 8.

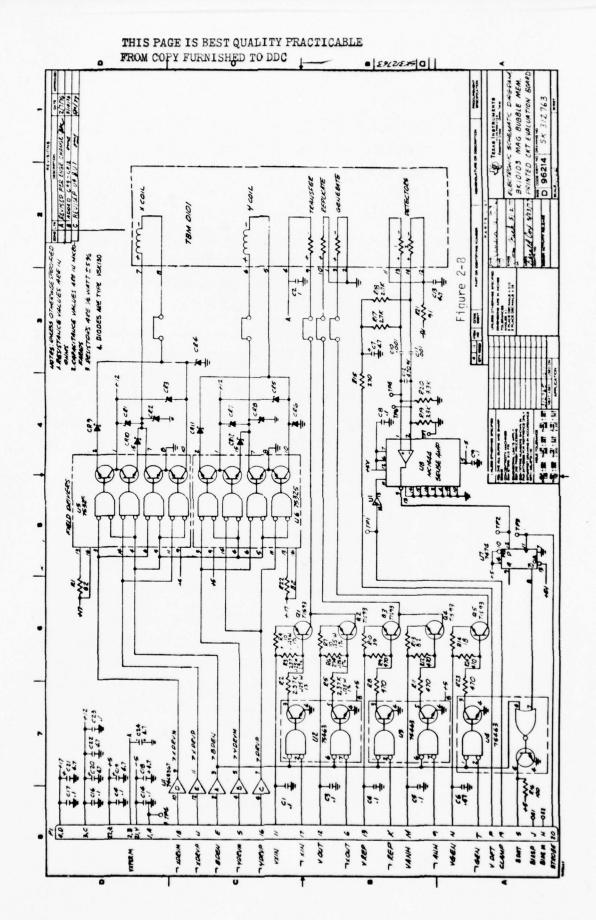
2.3.1 PDP-11 Software

General Description - The programs for testing MBM's and communicating with the MBM controller were written in two computer languages, 1) Fortran, and 2) PDP-11 Assembly language. The reason for this is that direct communications with the MBM controller requires the setting and clearing of bits which is more easily accomplished in Assembly language than in Fortran. However, Fortran facilitates easier analysis of data and implementation of test programs.

A. Fortran Program (Appendix IV)

The Fortran program has four main functions which may be selected at the start of the program.

- Write Writes 144 ASCII characters from the keyboard to a specified file in memory.
- Read Reads 144 ASCII characters from a specified file in memory and outputs them on the teletype.
- Dump Performs the same function as Read, but for all files from the specified start to end.



- 4) Test Has 3 modes that may be requested as follows: (Refer to Section 3 for additional information on the use of these tests.)
 - a. Specify Pattern Allows a pattern of up to 10 byte values to be specified. This pattern will be written into the file (5) specified and read back the specified number of times. This process can also be repeated a specified number of times on each file before proceeding to the next file (if more than 1 file is specified).
 - b. File Integrity Test This test writes a file number based pattern into all files and then all files are read in succession. The number of write passes and number of read passes/write pass are specified by the operator. On every other write pass the file address based pattern is complimented, e.g.; on the first and every other write pass the pattern is as follows:

High byte of address Low byte of address Ones compliment of high byte of address Ones compliment of low byte of address

On the second and every other write pass the pattern is the one's compliment of the above pattern.

- c. Generated Pattern Test Combination of both the Specify Pattern and File Integrity Test. Eight different patterns are written into the memories. Each pattern being repeated every 8 write passes. The patterns are as follows:
 - 1) Word 0 = 0, Word 1 = -1, Word 2 = 0, etc.
 - 2) Compliment of 1
 - 3) All words -86
 - 4) Compliment of 3 (A11 = 85)
 - 5) All words = 0

- 6) All words = -1
- 7) File Integrity Pattern
- 8) Compliment of 7
- NOTE: Values are 2's compliment decimal value of binary pattern, e.g.; -1 = all 1's, etc.

The above patterns were designed to test combinations of all or alternating bubble patterns in major and minor loops and to evaluate system noise conditions.

Detailed description of Fortran software is as follows:

Three single dimension byte arrays are defined as:

- A) Data to/from MBM (145 bytes)
- B) Data from keyboard
- C) Pattern array

The ASCII character definitions are expected inputs from the keyboard to the various questions as follows:

Lines 100 - 901 ask for and analyze the answer to the question of what type of operation, (Read, Write, Test, or

Dump). Single character responses are sufficient.

Lines 200 - 812 perform the single file ASCII read routine and write to keyboard.

Lines 300 - 820 perform the single file ASCII write routine getting the data from the keyboard.

Lines 600 - 601 perform the Dump routine (multiple file ASCII read).

If the answer to the programs first question is "T" (test) the program will jump to line 2000 where the question will be asked; What type of test? The answer may be "S" (Specify Pattern), "F" (File Integrity), or "G" (Generate Pattern). In any case, all three routines use common sections of the program. In order to decrease the run time and increase test throughput subroutines were not used. Instead, two control words were used for program control - KNTRL and KNTRLØ.

The common section of the code used by all three test routines is between 714 and 762. If it is an "S" type test both control words = \emptyset . If it is an "F" type test, KNTRL $\emptyset = \emptyset$. and KNTRL = +1 or -1. If it is a "G" type test. KNTRL = \emptyset , and KNTRL $\emptyset = 1 - 6$ for the first six patterns. For patterns 7 and 8 KNTRL = -1 or +1 and KNTRL $\emptyset = 7$.

When a "S" type test is requested the program will go to 700 where it begins to ask and analyze the answers to a series of questions which determine the parameters of the test. These questions are:

The first and last file numbers to test.

Number of byte patterns and their values.

Number of errors to print.

Number of Write and Reads/Write Pass.

By line 720 these questions have been answered.

Lines 720 through 703 print the header for error analysis. The program then enters the common routine. If the type of test is "F" or "G", lines 2009 - 3002 ask the common questions needed for both tests,

Number of errors to print.

Number of Write and Reads/Write Passes. Both tests automatically test all 641 files.

If the type of test is "F" the program will continue at 3002, and set up values required by the common routine to perform the File Integrity test. Lines 3300 to 3320 set up the file number based pattern and then go to the common routine. Since each file must be written in succession or read in succession the common routine will return to 3200 (Write) or 3600 (Read) based upon the state of KNTRL. After 641 files are written, the program will go to 3500 where conditions are set for the read process.

Lines 4000 - 4201 analyze the results of the test and determine if any more read or write passes are to be executed.

If the type of test is "G", program control goes to line 5000. Lines 5000 - 5006 initialize control values and set up one of six patterns.

Lines 6000 - 6002 set the values required by the common routine, print the test pattern and number on the terminal, and go to the common routine.

The common routine returns to line 9000. Until the first six patterns are generated the program will go to the next pattern generator. Otherwise initial values will be set for generating the 2 file integrity test patterns and program control will then go to line 3005.

The file integrity test returns to line 9900 where any errors are accumulated, $KNTRL\emptyset$ is reset, and control goes to line 9001. This process is repeated until the specified number of write passes is performed.

The common routine starting at 714 sets the A array to the values in the C array modulo NUMPAT (number of patterns), and then calls the macro subroutine (MACWRT), which writes the data into the bubble. MACRED routine is then called, the data being sorted in the A array. The A array is then compared against the C array modulo NUMPAT looking for errors. If errors are found the board number (NUMBRD) on which the error was found is calculated and then the following information is printed.

> Write Pass Number (KNTWRT) Read Pass Number (KNTRD) Good Data [C(K)] Bad Data [A(J)] Board Number (NUMBRD) Word Number (NUMWRD)

This process is repeated for all 144 words in the file (NUMWRD), until the specified number of Read (NUMRD) passes and Write (NUMWRT) passes have been executed.

In all of the above test modes the operator may specify the maximum number of errors to be printed to the keyboard before terminating that portion of the test. In such a case the program would advance to the next file or write pass.

B. Assembly Language Programs (Appendix V)

The two subroutines called by the Fortran program are MACRED and MACWRT (Read and Write respectively). They in turn call another subroutine called ADDXMT which performs the task of sending the file address to the controller. MACRED and MACWRT initially set location MASKI with a value which will indicate to the controller to either read or write. They then call ADDXMT.

ADDXMT adds to MASKI the two most significant bits of the address in the two LSB of the 16 bit PDP-11 word. This word is then moved to address 167772₈ which is the DR11-C output register. ADDXMT then readys the second word which will contain the lower 8 bits of the file address along with a branch control bit (020000). ADDXMT then waits in loop 2 until the controller signals it has received the first word before sending the second word. ADDXMT then points to the core address of the data block and returns to MACRED or MACWRT. In each case both will then wait for the controller to indicate it has received the second byte of information and is ready to proceed with the data transfer.

In the case of Write, MACWRT will send the first 60 bytes of data to the eight 64 x 1 FIFO's (Loop 4). It will then go to loop 5 and move another byte of data only when it has an indication that the FIFO is not full. MACWRT will remain in loop 5 until 144 bytes have been transmitted and then return to the Fortran program.

In the case of Read, MACRED will go to loop 7 after it has received a ready indication from the controller. In loop 7 MACRED will remove data from the FIFO's as long as it receives a FIFO not empty indication. It will wait until it has 144 bytes of information before returning to the Fortran program.

2.3.2 MBM Controller Micro Programs

The heart of the MBM controller consists of three 2901 4 Bit Slice Microprocessors. This allows 12 bit data words. However, only 10 bit values may be accessed from PROM, and only 8 bit values are available from the I/O data lines.

The microprocessor and peripheral functions are controlled by a 32 bit word programmed in 2708 PROMS. The purpose of this section is to provide some insight into writing programs for this controller. However, due to the ability of a single word to produce double operand, double source, and double destinations (including I/O) instructions, it would be an extremely lengthy task to document the full capabilities. A functional description of the 32 bit word is as follows:

BIT NO.

- 0 2 Multiway branch control (will determine bit 0 2 of the branch address).
- 3 9 Most significant bits of a Multiway Branch Address.

0 - 9 Absolute Branch Address.

- 0 7 Absolute Data when the data are from PROM and a shift instruction is present (B21 set).
- 0 9 Absolute Data when the data are from PROM and a shift instruction is not present.
- 8 9 Shift control. Will set the input to the LSB or MSB of the Q or R bidirectional ports to a value determined by the above outputs. The bit of the word will be set to that value during a shift instruction. Table 1 below shows the logic for this function.
- *10 13 "A" Register Address designation if the source code does not indicate the "A" Register address as a source code (B23 = \emptyset).
- 10 13 I/O Control if (B23 = 1) in which case the bits are as follows:

B10, B11 Output Register Address

B12 Output Designation

B13 Input Designation

Note: I/O instructions require that the Branch Control Instruction

(B28-B31) not be a conditional branch instruction (e.g.; $< 8_{_{\rm H}}$).

- *14
 - Carry bit significant only when the Op Code B25-B26 is \emptyset , 1, or 2.
- *15 18 "B" register address designation
- *19 21 Destination Code

*22 - 24 Source Code

*25 - 27 Op Code

**28 - 31 Branch Control

Appendix VII contains a list of some of the more common simple instructions along with a few of the more complicated possibilities. Refer to appendix II which shows the operation source and destination codes for the 2901. However, due to the 2901 and hardware design limitations, caution should be exercised under certain circumstances.

When using source codes 0, 1, 4, and 5 (Register at A address) there may not be a read from the I/O data lines. The data may only be read from PROM.

When loading 10 bits of data from PROM the destination code may not be 4, 5, 6, or 7 since these are shift codes, and B8 and B9 double as shift control bits.

When the instruction consists of a conditional branch, data may not be loaded from the I/O lines. A write into I/O control registers is not allowed 1) On conditional branch instruction, or 2) When "A" Address Register is called for in the source code. Conditional branches do not have the capability of testing more than one bit. Multiple instructions must be written and each except for the last must not effect the test bits.

The carry test bit (charted in Table 2-1) will be set or cleared as a result of the operation if the Op Code is 0, 1, or 2, and the Source Code is 0, 1, 4, 5, or 6. (Otherwise not effected.)

*See Appendix II (2901 Instruction Set) **See Appendix III (9408 Instruction Set)

INPUTS				RESULTS		
Destination	Shift					
Code (Octal)	Control					
(B19-B21)	(B8, B9)	С	Qo	Ro	Q11	R ₁₁
				NON	٩F	
0	Х	Cn+12	X	X	X	X
1	X	Cn+12	X	NON	- X	X
2	Х	Cn+12	x	NOI 	X	X
3	х	Cn+12	x	NOI X	NE 	<u> </u>
4 → Q&R	0	Qo	S	S	Ro	Qo
	1	Qo	S	S	Ro	Cn+12
	2	Qo	S	S	Ro	N
	3	Qo	S	S	Ro	ø
5 →	0	Ro	ZS	S	ZRo	Ro
	1	Ro	ZS	S	ZRo	Cn+12
	2	Ro	ZS	S	ZRo	N
	3	Ro	ZS	S	ZRo	ø
6 ↔ Q&R	0	R ₁₁	R ₁₁	Q ₁₁	S	S
	• 1	R ₁₁	R ₁₁	Q ₁₁	S	S
	2	R ₁₁	ø	Q ₁₁	S	S
	3	R ₁₁	ø	Q ₁₁	S	S
7 ↔	0	R ₁₁	Z	R ₁₁	Z	S
	1	R ₁₁	Z	R ₁₁	Z	S
	2	R ₁₁	Z	ø	Z	S
	3	R ₁₁	Z	ø	Z	S

Table 2-1. Table of carry control and shift control logic

¥ ...

Table 2-1 continued.

S = Signal Source

X = Don't Care

Z = High Impedance State

Therefore, the following shift combinations are available

Dest. Code	Shift Code	MNEMONIC
4		DCR
4	1 + 5 R + Q + 3 C	DRR
4	$2 \times R \rightarrow Q \rightarrow C$	DASR
4	3 p + R + Q + C	DLSR
5		CIR
5	$1 \qquad R \qquad C$	ROR
5	2 R R	ASR
5	$3 \not 0 \rightarrow \qquad \qquad$	LSR
6	0 or 1 C K R K Q K	DCL
6	2 or 3 CK R KQK O	DASL
7	0 or 1 C R R	CIL
7	2 or 3 C R 0	ASL

The V (overflow bit) will be reset on the next instruction following the arithmetic operation.

The Z (Results = \emptyset) and N (Results = minus) bits will be reset on the next instruction, but may be set or reset accordingly by testing the results during any previous condition branch instructions.

Therefore, if V is to be tested following an arithmetic operation, it should be tested first along with a test results instruction. (The Z, V, N, and C bits are a result of the previous instruction.)

Appendix VIII is the listing of the actual program used in the prototype MBM controller. A brief description elaborating on the more complicated instructions follows.

When the hardware is reset the branch controller sets the Program Counter (PC) to Address Ø. The instruction is a multiway branch which will cause the PC to become any of the possibilities between ØØO and ØØ7. The results of Op Code 4_8 and Source Code 3_8 is Ø,

Appendix II. The results are stored in both REG \emptyset (Destination Code 3 and B Address \emptyset) and I/O control REG 1 (Bits 1 \emptyset - 13).

When the PDP-11 sends a Read instruction (PC+ $\emptyset \emptyset 4_{_{\rm H}}$) or a Write instruction (PC+ $\emptyset \emptyset 2_{_{\rm H}}$), the instructions at both addresses clears REG 1 and CR2. Both instructions are unconditional branch instructions which will cause the PC+ $\emptyset \emptyset 8_{_{\rm H}}$ for Write or $\emptyset 8 \emptyset_{_{\rm H}}$ for Read.

The first instruction at both locations is simply branch to subroutine $\emptyset 5 \wp_{\rm H}$. Though the OP and SRC codes in this instruction \wp_8 , \wp_8 call for A+Q function, the destination code only outputs the results and does not affect the values in any internal registers. Since the I/O control is O_H the results of the operation are not stored. The subroutine at 050 receives the file address from the PDP-11, shifts the minor loops a number of times equal to the file address, and determines the number of shifts that will be required at the end of the operation, transfers the bubbles to the major loop, shifts the bubbles until the first bubble is at the Replicate/Annihilate port, and returns to the calling routine.

The instruction at $\emptyset 5\emptyset$ is a BMW4 (BMW = Branch Multi-Way) instruction which will cause the PC+ \emptyset 51 when the 2 MSB's of the file address are present on the data inputs. The bits when received must be multiplied by 2⁸. The instruction of \emptyset 51 loads the data, multiplies R15 by 2 an additional 7 times, and also signals the PDP-11 - data received.

Line \emptyset 57 is a No Operation (NOP) instruction which puts the next BMW instruction at a BMW base address (BO-BZ of address are \emptyset).

The program waits here until the PDP-11 indicates the second portion of the file address is ready, and then $PC \leftarrow 059$ where the data are stored in R14. Ø5A loads R4 with 641, which is the number of positions in a minor loop. Ø5B adds R14 to R15 resulting in a 10 bit file address. If the address is \emptyset the minor loops are already in a position to be transferred out, and the PC $\leftarrow \emptyset$ 61. If the address $\neq \emptyset$ then the bubbles must be shifted a number of times equal to the file address. \emptyset 5D stores the Value \emptyset 1 in CR1 which enables the timing and MBM boards. Ø5E is a BSRØ28 (BSR = Branch to Subroutine) (described in detail below) which will return after a complete bubble cycle. Ø5F decrements the file address. $\emptyset 6 \emptyset$ decrements R4 which will become the shift count after the bubbles have been transferred in at the end of the operation. Ø6Ø also tests the results of Ø5F, and if \neq Ø branches to Ø5D. When the minor loops have been shifted as required, line Ø61 adds 40H to CR1 which enables the Transfer Out (XOUT) pulse from the timing board. Ø62 executes a BSRØ28H to wait for 1 cycle completion, and then Ø63 loads R2 with 67., the number of additional shifts

required, until the first bubble position is at the Annihilate/ Replicate port. $\emptyset 64$ inhibits the XOUT signal. $\emptyset 65 - \emptyset 67$ shifts the bubbles 67 times. Line $\emptyset 68$ returns to the next instruction of the calling routine either $\emptyset 81$ or $\emptyset 99$.

In the case of Write, $\emptyset \emptyset 9$ stores $42_{\rm H}$ at CR2 signaling the PDP-11 that it has received all information and is ready to proceed, and sets the W/R line to 1. Line $\emptyset \emptyset A$ stores a $91_{\rm H}$ at CR1 which keeps the Master Enable high, enables the FIFO and the Annihilate gates. Lines $\emptyset \emptyset B$ - $\emptyset \emptyset E$ shifts the bubbles 228 times annihilating bubbles present in the major loop until the first bubble position is over the Generate port. Lines $\emptyset \emptyset F$ to $\emptyset 15$ go through 157 cycles (314 bubble cycles) of enabling the generation of a bubble in every other position of the major loop while continuing to annihilate any bubbles which appear at the Annihilate port.

Lines \emptyset 16 to \emptyset 1A inhibit the Annihilate and shift the bubbles an additional 3 \emptyset times until they are over the minor loop transfer in ports at which time \emptyset 1B branches to common routine $\emptyset4\emptyset$ which will end the operation.

In the case of Read, Subroutine $\emptyset 5 \emptyset$ returns to $\emptyset 81$ where $\emptyset 3$ is stored at CR1 enabling Replicate. Line $\emptyset 82 - \emptyset 85$ shifts the bubbles 19 more times and signals the PDP-11 that all data have been received and the read process started.

Line \emptyset 85 is somewhat confusing in that data to be stored and a conditional branch address are within 1 of each other. The instruction is literally interpreted as follows:

Load Ø83 Decrement by 1 (= $Ø82_H$) Store in R1 and CR2 Branch if R2 is $\neq Ø$ to Address Ø83

Lines $\emptyset 86 - \emptyset 8D$ enables the FIFO, keeps the master enable high, and repeating 157 times (314 bubble cycles) enabling the data strobe every other bubble cycle.

Instruction Ø8D loads R2 with 239 which is the number of shifts now required to position the bubbles over the minor loops. Line Ø8E inhibits the Replicate gate. $PC \leftarrow 018$ where the bubbles will be shifted 239 times before proceeding to 040H to end the operation.

Instruction line $\emptyset 4 \emptyset$ to $\emptyset 4 4$ enables the XIN gate for 1 cycle, and shifts the bubbles a number of times until R4 becomes \emptyset . The value in R4 was determined by subroutine $\emptyset 5 \emptyset$, and is the number of shift values required to return all bubbles to the same positions they were in before the operation proceeded.

Instructions \emptyset 46 and \emptyset 47 clear CR1 and CR2 and return to instruction \emptyset \emptyset \emptyset where the program again waits for a Multiway Branch.

Subroutine \emptyset 28 consists of 2 Multiway Branch Instructions (\emptyset 28 and \emptyset 3 \emptyset) again at addresses where B \emptyset -B2 = \emptyset .

The BMW1 instruction at $\emptyset 28$ waits for the $27\emptyset^{\circ}$ signal first to insure that the same \emptyset° is not counted twice. PC+ $\emptyset 3\emptyset$ where the BMW instruction waits for the \emptyset° signal and then returns to the calling program.

2.3.3 Magnetic Bubble Memory Maps

When TBM0101 MBM's are received from the Texas Instruments, up to 13 of the 157 minor loops may be marked as unusable. T.I. sends a computer printout of test data with each unit, which also includes their map of the good and bad minor loops. In the Prototype MBM controller, the maps of the 8 memories used are programmed into a 1702 (256 x 8 bit) PROM. The map for each memory occupies 1 bit position in the PROM.

Appendix IX is a sample of the T.I. computer printout of the MBM test data. The T.I. map is located below the date, and consists of 10 groups of 4 hexadecimal digits with the last "digit" being always a 7 (if good) or F (if bad) since only 157 bits are required. When the Hex map is converted into a binary map, 1's indicate a bad minor loop position. The left or MSB represents minor loop #0 (assuming loops are numbered 0 - 156) and is the one closest to the detector. The value NBIT on the T.I. map indicates the total number of bad loops. Example:

In the above example of the first 16 bit binary value, loops 3, 4, 5, and 13 are bad. (Starting with loop \emptyset) In the controller, words 0 - 11 would consist of minor loops 0, 1, 2, 6, 7, 8, 9, 10, 11, 12, 14, and 15. Since only 9 loops were bad in this MBM, an additional 4 would be added to make the maps of all memories have 144 loops marked usable. Therefore, the last group of 4 "digits" would become 007F.

In the 1702 map, bad loops are marked by the presence of a O. Therefore, the T.I. map must be complimented. Appendix X shows a sample System map used to program the PROM. (Rather then complimenting the T.I. map, each position corresponding to bad loops are marked as O. and all unmarked positions are interpreted as 1.) The 8 bit binary values are then converted to Hex for PROM programming.

2.3.4 Timing Control Program

Appendix XI is a sample of the program in the 2 PROMS on the timing control boards, each PROM having 4 bits of the 8 bit words.

Fourteen controls are contained in the 8 bits. This is accomplished by interleaving the control bits (see Section 2.2.4, function timing board):

Data in even numbered words control 8 functions, and odd number words control 6 functions. A table follows:

Bit #	Even Word	Odd Word
0	Annihilate/FIFO Clock	GEN
1	*PROM Address Counter Load	XOUT
2	CXA	XIN
3	CXB/Enable Latch Clock	BRD EN LATCH
4	CYA	Replicate
5	СҮВ	*PROM Address Counter Load
6	Strobe	
7	Clamp	

Table 2-2. Control Function

*AND Function

The timing controls from Address $\emptyset \emptyset$ to 51 rotates the current vector in the shift coils from the origin through 270° to 0° . The timing from 52 to Al is repeated until the BlBØ line (BSS) is set to Ø by the controller. The instruction from A2 to FE returns the current vector to the origin. FF unlatches the BRD Enable, and disables the address counter clock.

SECTION 3 - TEST RESULTS

3.1 OBJECTIVES

Since bubble memories have many new and unique characteristics (and problems), it was not obvious at the outset, what the test methods and, objectives should be. However. as a result of several weeks of intensive effort in learning the problems and characteristics of the device, several specific objectives emerged.

- 1. Determine and characterize the errors of the prototype system.
- 2. Determine the nature or source of the errors as being due to
 - a. System related factors
 - b. Pattern sensitivity
 - c. Operating specification marginality
 - d. Manufacturer's Quality Control
- 3. Determine the correct operating parameters and requirements as they relate to the system and the device performance.

It must be emphasized when interpreting the test results, that the tests were conducted on prototype versions of a new technology memory, and the problems encountered will be solved before the devices reach production status. What is important is that a comprenensive test has been developed which can detect failure modes unique to MBM's, and that the tests show present prototype devices, although imperfect, could be successfully used for data acquisition purposes as they are.

3.2 BACKGROUND

The final tests conducted on the system, though the basis for the majority of conclusions in this report, only represented a small portion of the actual energy spent during the evaluation of the system.

The process from the beginning of the evaluation to the point of defining objectives, and conducting the final error rate tests can be

characterized as a "round-robin bootstrapping process." This process consisted of initially exercising the system, through the use of very simple software in the PDP-11, in order to locate controller hardware and software problems. When the basic problems had been overcome the software capability was increased in the PDP-11 which uncovered further errors in the controller software and PDP-11/MBM controller communication noise problems.

As these problems were being solved it became apparent that the final test software in the PDP-11 would have to provide some degree of diagnosis on the errors detected. This allowed characterization of the errors which in turn allowed the possible sources of the errors to be identified. Because of the unique characteristics of MBM's, a number of direct conversations with T.I. engineers were also found to be necessary when interpreting various problems encountered with the memories.

One example is that information received during the design phase led us to believe that writing into "bad" loops was a "don't care" situation. The hardware was designed accordingly. During the evaluation phase it was learned that this was not always so, and bubbles could get trapped in the bad loops and cause problems. The hardware was modified by taking the bubble map outputs and gating them with the data and GEN signals to create the GEN signals for each memory. Also, a procedure was verbally obtained from T.I. to eliminate any bubbles trapped in bad loops, as a result of writing bubbles in them, that might "migrate" or "seed bubbles" causing errors.

Restoration of a device so affected can be accomplished by collapsing the bias field within the memory which maintains the magnetic bubbles. The procedure consists of writing all bubbles into memory. A permanent magnet with a strength of >40/0e is moved towards the MBM while reading the memory. With the field perpendicular to the top surface of the memory case, the magnet is slowly moved closer until all bubbles are permanently annihilated. Note, this procedure should be used with caution. If the external field becomes to large, it can reverse the internal field.

The restoration procedure produced only the "relative success" T.I. suggested it would. For example, it was used on 7 units with error rates >1 x 10^{-6} , and produced error rate decreases in all units. However, the error rates of 4 units only decreased by a factor of 2-5, where the remaining 3 units improved considerably, and no errors were found in 2.6 x 10^{-7} bits.

Measurements on the control currents of the least improved memories indicated that some were not within published operating specifications. Further circuit analysis and conversations with T.I. indicated the need to change the voltage on the control circuits and/or modify (trim) the T.I. control circuit designs. The following changes were necessary:

- Increase X, Y control voltage to 13.5Vdc. (Required an additional power supply voltage.)
- Adjust Transfer Out (and in some cases Transfer In) currents for each memory. It was found that the XOUT circuit could not be a constant current source at 12.5Vdc over the range in values of the Transfer coil resistance.
- Change the current resistor in the Replicate current source to 36 ohms.

It must be pointed out that T.I.'s MBM circuit board is a preliminary engineering design intended for prototype evaluation only, and is not intended to reflect the performance they plan to achieve in production IC versions of the interface functions. Further, there is insufficient statistical data on the MBM's to be able to precisely define nominal values and tolerances, etc., so these kinds of problems are not unusual at this stage.

The failure of the current control circuits to meet specifications lead to scrutinizing the timing control where a conflict between specifications and the actual requirements were also found. The conflict was in the leading edge timing of the Replicate pulse, generated by the PROM Program (Section 2.3.4), which was found to be 4.875μ s instead of the 5.125μ s minimum specified in the MBM data sheet. Texas Instruments could not tell us what was optimum for our units, and short term tests indicated no effect so the timing was returned to the programmed value of 4.875μ s.

It should be noted here that while the specifications were said to be optimum for the units in our possession, T.I. was respecifying parameters for their latest production units. For some parameters these changes were significant, relative to tolerances. For instance the nominal Generate amplitude had changed from 250mA to 280mA which was previously specified as a maximum. The nominal Replicate and Annihilate leading edges had been changed approximately to what had been the previous max values. The nominal XOUT and XIN leading edges were increased by an amount 2 to 3 times the previous tolerance value. Again, this variation is not unusual at the present stage of development, but it does require a constant awareness of the factors involved.

Also, during this period it was determined that the power up/down sequence was critical. If the correct procedure was not followed it was discovered that current pulses might occur in the memory causing bubble annihilation or generation. A sequence, Table 3-1, was developed which allowed system power control without affecting the data in memory. If an error was made in the procedure, the memory fields were collapsed by the procedure mentioned above to prevent possible effects from bubbles that may have been generated in bad minor loops.

Table 3-1. Power Down Sequence*

1.	13.5Vdc	(X,Y coil down)
2.	17V	(X,Y control logic)
3.	+12V	(Memory control current source)
4.	+5V	(Memory logic)
5.	+12V	(Control logic)
6.	-12V	(Control logic)
7.	-5V	(Control logic)
8.	+5V	(Control logic)

*Reverse the sequence for power up.

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For reference, the power requirements of the prototype memory subsystem are approximately 27 watts in the quiescent state. During the 13ms dynamic period for a full memory (file) cycle the power peaks to approximately 80 watts. Table 3-2 summarizes the power supply requirement for the present prototype system. It is possible to decrease the power of the prototype system somewhat by using lower power equivalent devices in a few limited cases. Lower power consumption is expected to be possible in future operational system designs through the use of IC versions of the interface functions, and use of low power devices in the controller.

After the system and all parameters of the bubble control had been examined and determined to be operating within the latest requirements as specified by T.I., five memories were found to have various and easily detectable problems as follows:

- a. Three were found to have bad minor loops, in addition to those found by T.I., yielding in excess of 13 bad loops.
- b. One determined to be pattern sensitive.
- c. One random errors $3/5 \times 10^{-5}$ errors/bit.

In addition, another unit was determined to have 1 more bad loop than was indicated by the map supplied with it. This would suggest that the T.I. testing process was failing to identify all of the bad loops in 25 - 30% of the units.

Also, two of the five units above exhibited decreased errors when the X and Y coil currents were increased above the maximum tolerance. Since the improvement in error rate was less than a factor of 10 it is difficult to conclude from this that there was a definite marginal operating condition. But, it does illustrate the sensitivity and complex relationships of the various factors involved.

Voltage	Peak Current Drain (Amps)	Supply Capacity* Amps
+5	4.2	5
-5	.3	.5
-12**	.04	.1
+12	.2	.5
+17	.5	.75
+13.5***	4.0	5

Table 3-2. Power supply requirements

*Design Spec. Recommendation

1

**Used only by 1702 PROM Map

***May become 12 volts in final T.I. versions.

In discussing these problems with T.I. they stated that they had recently found an inability of their test procedure to detect a specific type of problem. That is, devices in recent shipments were found to have inherent problems when stopping the bubbles in the minor loop because some bubbles tended to migrate. Our units <u>may</u> have had similar problems. They also emphasized how critical three of the control currents were. In order of priority they were identified as:

- A. Transfer Out
- B. Generate
- C. Replicate

After reevaluating these characteristics, and satisfying T.I. that their specifications were being adhered to, they suggested that all units be returned for reevaluation. It was agreed that the above five units would be returned immediately, and the remainder might be returned pending the results of the final error rate tests. (The five units were returned with a detailed report shown in Appendix XII.) At this time it was decided to specify the final error rate tests based on knowledge gained from previous problems.

3.3 ERROR RATE TEST PROCEDURE

A set of test patterns was developed for conducting extensive error rate testing. The basic concept of the pattern designs is not only to test for pattern sensitivity, which was previously exhibited in a unit, but to also allow some discrimination as to what caused the errors, and identify where (major or minor loops) the sensitivity occured. A short description of the patterns is contained in Section 2.3. A more detailed description follows.

Eight patterns are generated consisting of 4 base patterns and their compliments. It is necessary to generate the compliment of a pattern to test each bubble position in each state for a given pattern. Each

pattern consists of 1, 2, or 4 words repetitively written into the 8 wide memory. Table 3-3 shows the patterns, and the test effect.

Two extensive tests were conducted. In each case the memories were read six times/write cycle. Error printouts were limited to 5/file/ write cycle. The first test consisted of 2.7×10^9 bits read/system. A second test was conducted after the highest error rate memory boards were swapped with the lowest error rate boards. The objective here was to ascertain that the errors were a function of the memory board combinations, and not a unique characteristic of the system. This test consisted of 3.3×10^9 bits read/system.

A report was prepared for T.I. in order to aid them in their reevaluation of the units when returned at the completion of the error rate testing. This report is contained in Appendix XII.

3.4 DATA ANALYSIS

A summary of the computer error printout is contained in Tables 3-4 and 3-5, which were manually prepared in order to characterize the errors since the computer only prints an instant analysis on each error and not cumulative error analysis. Three types of errors were characterized:

- Soft Errors Error detected on a read pass, but not detected on a successive read pass.
- Hard Errors The same error detected on two or more successive read passes.
- 3. Migrating Error This is a unique error type where an error was detected within the first 8 words, and would migrate towards the first word of a file on successive read passes. The error would then disappear after appearing in word Ø or 1. The exact migration characteristic appeared to be pattern related.

Table 3-3. Test patterns

Test Effect	<pre>Tests effect of alternating bubbles in major loops positions and minor loops.</pre>	Test entire bubble in 1 state with high system noise.	Same as pattern 3 & 4, but low noise.	Tests file integrity. Mixed major loop position and minor loop conditions.
Word 3		10101010	00000000	
Word 2	11111111 0000000 Compliment of Pattern 1	10101010 10101010 Compliment of Pattern 3	00000000 00000000 Compliment of Pattern 5	ADD _L ADD _H Compliment of Pattern 7
Word 1	Compliment c	10101010 Compliment c	00000000 Compliment c	ADD _L Compliment o
Word Ø	0000000	01010101	00000000	ADD _H
Pattern	- 2	w 4	6 5	8*

ADD_H = High Byte ADD_L = Low Byte

By determining the frequency of errors in each pattern it could be shown that a definite pattern sensitivity characteristic existed. Approximately 55% of the errors detected occurred during patterns 1 and 2. This indicated a sensitivity to patterns where alternate minor loops had a large majority of bubbles interleaved with minor loops having a large majority of absence of bubbles. Another 30% of the errors occurred in patterns 7 and 8. Since these patterns are file address based, it was necessary to determine the minor loop status in the area of the errors. It was found that patterns similar to those produced by patterns 1 and 2 existed in the minor loops around the loop in which the error was found. The remaining 15% of the errors occurred in patterns 3 - 6. Two other characteristics were immediately obvious during the data analysis:

- A. 90% of the hard errors occurred on the first read pass whice would indicate a marginal write operation.
- B. 85% of the errors were the result of gaining a bubble.

Comparing the results from the two tests separately it can be seen that in 3 of 4 cases where the boards were swapped that the high error rates followed the boards. In the fourth case the high error rate stayed with the bit position in the system. However, the errors in the latter case have the same general characteristics as the others. This tends to decrease the possibility that a unique position related problem exists in the system, and tends to suggest that there may have been some slight differences in the tests. These differences might include ambient temperature, slight voltage change, or negative effects from collapsing the memory fields.

Table 3-6 is a composite of Tables 3-4 and 3-5. The overall results of the two tests are summarized on the following page.

System Error Rate	5 x 10 ⁻⁸ errors/bit
Unit Error Rate - High - Low	2×10^{-8} errors/bit 1.6 x 10^{-10} errors/bit
Soft Error Rate	3 x 10 ⁻⁹ errors/bit
Soft Migrating Error Rate Hard Error Rate	4.7 x 10^{-9} errors/bit 4.3 x 10^{-8} errors/bit
Percent of Hard Errors detected on 1st read	87%
Percent of Error due to bubble gained	85%

It is important to note that although these rates are higher than the specified soft error rate of 10^{-9} errors/bit and hard error rate of 10^{-10} to 10^{-11} errors/bit, they would be acceptable in data acquisition system applications. There did <u>not</u> appear to be any failure modes (other than those that could be controlled such as the power on sequence) that would cause random data scrambling.

3.5 TEXAS INSTRUMENT REEVALUATION OF BUBBLE MEMORIES

On 19 September 1977 a verbal report was received from Gerald Cox of the Magnetic Bubble Memory Product Marketing group for T.I. The report consisted of only general statements and not specific error rates, error characterization or errors relative to specific units by serial number. Their reevaluation test consisted of individually testing 11 of the 14 units returned, for approximately 5 minutes, by alternately writing and reading a "simple shift pattern." Their results and comments on the results were as follows:

 One unit had a low threshold sense amplifier (Motorola device) on the memory board. They had previously identified this problem, and are presently producing their own chip with a minimum guaranteed sense threshold.

- 2. One unit exhibited no errors.
- 3. The remaining 7 memories, mounted on boards, and 2 of the original 5 units returned exhibited problems due to the generate process. The characteristic of the error was that extra bubbles were being generated, an effect they had only recently discovered. This problem can be reduced or eliminated by reducing the generate current pulse in both width and amplitude since only 50 nanoseconds are required to reliably generate a bubble. (Note that the present T.I. timing design only allows 250 micro-second resolution, and this would require some design changes.) They stated, however, that the real solutions to eliminate the problem were 1) more stringent material control, and 2) a redesign of the generate method.
- 4. No explanation was given for not testing the remaining 3 units.

Only a general correlation between Develco's test results and T.I.'s evaluation and previous inputs is possible since T.I. did not maintain records as to the error rate relative to unit serial number. However, their findings confirm our test results in several areas.

- A. They found 1 unit without problems which confirms our finding.
- B. They found 1 unit in the last 9 returned with a sense amplifier problem. This agrees with our results in that the errors on 1 unit not used in the final tests could not be easily characterized.
- C. Seven of the units from the final tests exhibited generate problems which created excess bubbles. This generally correlates with the test data in that 85% of all errors were hard, and 87% of those errors resulted in a gained bubble, and occurred on the 1st read pass.
- D. They found 2 units with suspected additional bad loops. Our tests indicated a total of 4 units. However, they did not test 3 of the first 5 units returned of which we had found 3 that had additional bad loops.

- E. During the evaluation, they suggested the possibility that our units <u>might</u> have problems related to stopping the bubble cycle. This may explain the remainder of the hard errors which occurred after the 1st read pass.
- F. No explanation or correlation has been determined for the migrating errors.
- G. Possible explanations of the soft error could be many in number, but in most cases would be confined to noise and/or signal to noise margin of the sensing circuitry. Another possibility is that some errors may result if nominal timing values are not optimum.

After completing their tests, T.I. agreed that there are performance problems in the prototype devices, both those they are currently making and those purchased for evaluation on this program, which are due to design and manufacturing problems. As a result of their evaluation of the devices we used, T.I. recalled all the MBM's used in this program. It is clear that T.I. has some more development work to do before their MBM's reach production status. However, it is extremely important to recognize that:

- a) This is a new and radically different technology, so a longer learning curve can be expected.
- b) T.I. took a calculated risk, but we believe a worthwhile one, in releasing prototype versions at this stage of development so the industry could learn to use them.
- c) The error rates that resulted from the prototype units used in the final tests would have been entirely acceptable in many data acquisition system applications.
- d) T.I. will undoubtedly solve the device problems, and it is our opinion that refined devices will be back on the market by the 1st quarter of 1978.

Table 3-4. Test results 5 August 19772.7 x 10⁹ bits/system (3.38 x 10⁸ bits/board.)

TBM S/N	BRD S/N	BRD Bit S/N Position	Ľ.	Failures vs. Pattern	ure	~		Dati	cerr	_	Total Failures	Types	of Fa	Types of Failures	Hard Errors on 1st Read	But	Bubble
				~	m	4	2	9	2	œ		Soft	Hard	Error Shift		Lost	Gained
72-53-11 09	60	0	2	-	-	0	2	0	-	e	13	2	10	-	9	4	б
74-36-08 05	05	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
74-36-01	10	2	0	0	0	0	0	0	0	0	0	0	0	С	0	0	0
78-13-15	08	e	6	6	0	0	0	0	5]	Ξ	34	0	33	-	33	-	33
54-24-02	02	4	2	13	-	0	0	0	7	15	43	0	40	ŝ	38	e	40
72-63-06 07	07	2	4	4	2	0	-	2	0	4	20	0	19	-	12	2	18
72-63-04	90	9	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
68-94-00	03	2	0	-	0	0	-	0	0	0	2	0	-	-	-	-	-
		TOTAL	28	28	2	0	4	2	13.3	33	112	2	103	7	90	10	101
													91%				

Table 3-5. Test Results 15 August 19773.32 x 109 bits/system (4.15 x 108 bits/board)

TBN S/N	BRD S/N	Bit Position	Fa	Failures	res	vs.		att	Pattern	Total Failures	Types	of Fa	Types of Failures	Hard Error on 1st Board		Bubble
			-	2	6	4	2	9	7 8		Soft	Hard	Error Shift		Lost	Gained
74-36-01 01	10	0	0	0	0	0	0	0	0 0	0	0	0	0	0	0	0
78-13-15	08	-	20 1	12	0	-	0	0	5 10) 48	-	44	2	44	4	44
72-53-11	60	2	-	4	-	0	2	0	0 0	8	2	5	-	-	с	5
74-36-08	05	e	0	0	-	-	0	2	0	9 4	4	0	0	0	-	e
72-63-04	90	4	-	0	0	0	0	0	0 0	-	0	٢	0	-	0	-
68-94-00	03	2	23 1	18	0	2	9	0	0 0	52	4	40	8	24	12	40
54-24-02	02	9	16 2	20	9	0	2	0	2 12	83	2	67	10	99	14	69
72-63-06 07	07	7	-	0	0	0	0	0	0 0	-	0	-	0	-	0	-
		TOTALS	60 5	54	œ	7 1	15	2	7 22	197	17	158	21	137	34	163

Table 3-6. Test results composite of tables 3-4 and 3-5 6.02 x 10^9 bits/system (7.53 x 10^8 bits/board)

TBM S/N	BRD S/N	BRD Bit S/N Position	tion	_	Failures vs. Pattern	ure	S	15.	Pat	ter	F	Total Failures	Type	s of F	ailures c	Hard Errors Types of Failures on lst read	Bu	Bubble
		lst 2nd Test Test	2nd Test	-	2	e	4	ъ С	9	7	œ		Soft	Hard	Error Shift		Lost	Lost Gained
74-36-01 01	10	2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
78-13-15 08	08	e	-	29	21	0	-	0	0	10	۲2	82	-	78	e	77	5	11
72-53-11 09	60	0	2	9	5	2	0	4	0	-	e	21	4	15	0	0	0	0
74-36-08 05	05	-	e	0	0	-	-	0	2	0	0	4	4	0	0	0	-	З
72-63-04	90	2	4	-	0	0	0	0	0	0	0	-	0	-	0	-	0	-
68-94-00 03	03	2	2	23	19	0	2	7	0	0	0	54	5	40	6	25	13	41
54-24-02 02	02	4	9	23	33	7	0	7	0	29	27	126	5	108	13	104	17	109
72-63-06 07	07	2	2	5	4	2	0	-	2	0	4	21	0	21	-	13	2	19
		TOTALS		88	82	82 15	1 1	7 19	1 1	4 40 55	55	309	19	261	28	227	44	264

SECTION 4 - DATA ACQUISITION SYSTEM DESIGN RECOMMENDATIONS

It is clear from our investigations that MBM technology is progressing rapidly, and that even today's prototype versions can be successfully used in field data acquisition applications. The relatively crude architecture and lack of a full family of peripheral components for presently available MBM devices makes design difficult and limits flexibility. However, advantages such as nonvolatility, ruggedness, and relatively low power consumption make these devices useful even in todays technology. Thus, we recommend that some first generation system designs be developed now to take advantage of MBM features in special applications, and gain operational experience. It then appears that the technology will reach a level of maturity in time to coincide with the development of second generation systems for broad based general use in the next 1 to 2 years.

As an example of the progress being made, T.I. has already incorporated MBM material and generate pulse specification changes to eliminate the major error source problem we encountered as described in Section 3. Although the changes are probably not final, prototype units can now be obtained (with a 16 to 20 week delivery) that have satisfactorily improved performance. At present T.I. expects to be in production within the year, however, details on price and delivery are not yet available.

There is also considerable progress in the area of support chips. T.I. has had an I.C. version of a controller available for some time, but it does not appear to be generally useful in data acquisition applications particularly for 8 bit wide storage. It is conceivable the controller could be of use in limited applications whether for single channel serial recording or where a poling arrangement can be tolerated in parallel applications. Although some consideration has been given to an 8 wide, or byte, memory controller, it is not expected one will be available in the near future. However, the development of other support devices is nearing completion, and it is expected that they will be available by late in the first quarter of 1978. The custom IC's that are now undergoing family tests include seven IC's for use with each MBM and one IC for each system as follows:

- 1. One 16 pin DIP (Dual-Inline Package) with the 5 control current sources including temperature compensation (range not specified) and the \triangle current/ \triangle temperature requirements for the memory.
- Two 8 pin DIP's with the coil drivers. and two with the diode packs for the coil drivers.
- 3. One 8 pin DIP with a sense amplifier that has guaranteed threshold detection and the required output logic. This will also be available in a 14 pin DIP that provides a tri-state output. An additional 8 pin Hybrid containing the sense amplifier RC, etc., components is also required.
- 4. A single 22 pin DIP is being developed to replace all of the function timing circuitry with the exception of an external oscillator. This will have a fanout capacity of 17 T²L loads which will allow it to be used directly in an 8 wide system.

The system design requirements for 3 cases of first generation data acquisition systems using MBM's have been considered as discussed in the following sections. The first is based on utilizing the prototype memory model which was designed to explore the advantages of doing the control operations in real time. Although the expected benefits did not materialize, because of the complexities of the major-minor loop operating requirements and the fact that storage in the major loop is not possible in present T.I. devices, it can certainly be used in a data system with a minimum of additional development. An alternate configuration, also based on the T.I. MBM, was considered to achieve a simplified controller design, more flexibility for strobed operation at lower data rates, and lower standby power. Finally, a straight serial recorder was considered that would take advantage of the simplicity possible with the single loop memory such as that available form Plessey.

4.1 DATA ACQUISITION SYSTEM USING 8 BIT PARALLEL PROTOTYPE MEMORY

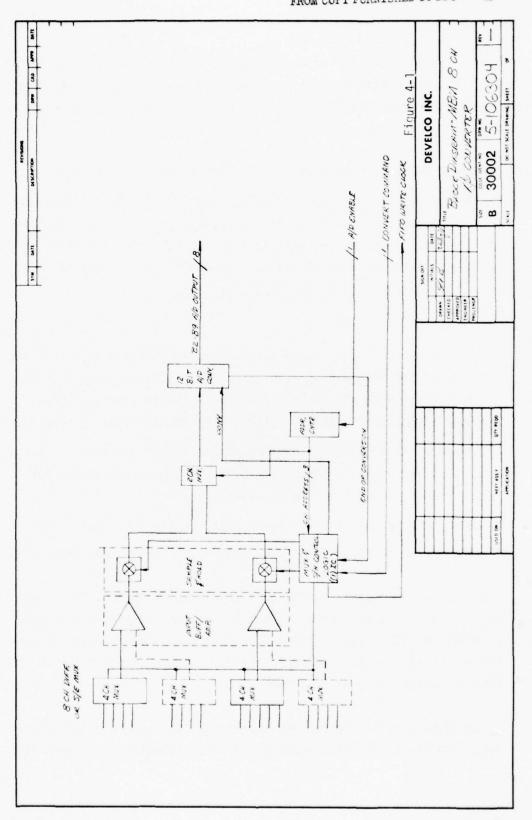
The Prototype Magnetic Bubble Memory system was designed (in terms of both hardware and software) to be easily used in a data acquisition system. However, several additions will be required to bring the system from its present status to a field usable piece of hardware. This would include the following steps:

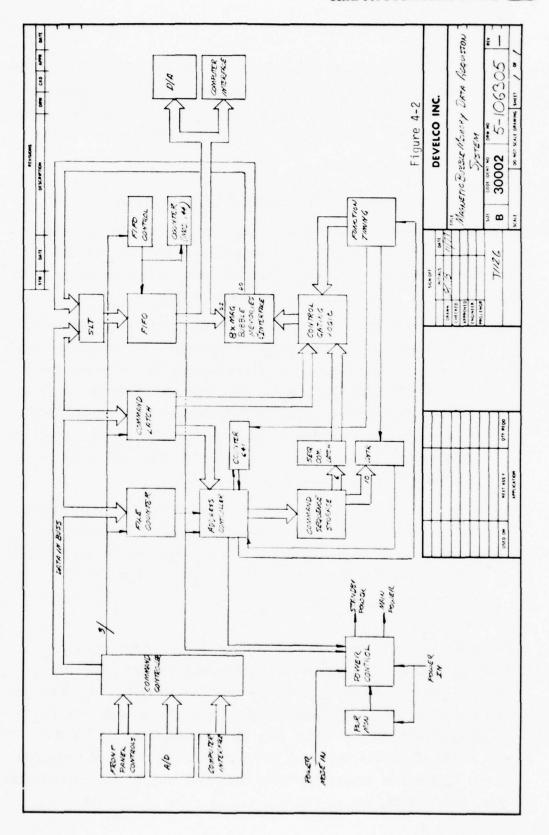
- Add an A/D converter board which could be the same as a modification of the Mighty Epic Underground Telemetry System 2 channel multiplex input and boards. Of course, other configurations, such as multiple channel multiplexing, are possible, Figure 4.1.
- Prepare the additional software required which consists of bubble controller programs for multiplexer and A/D operation and PDP-11 Fortran programs for data printout operation.
- 3. Add the necessary battery power supplies for field use.
- 4. Add a D/A converter for field checkout and quick look capability.

These steps would yield a data acquisition system with a fixed data rate of 50k bytes/sec. with a 92k byte capacity, allowing a 12.5kHz response (@-3dB). The system would require a constant power source, though provision will be made for power up/down control prior to and after all data has been recorded.

It would be possible to further modify the system to also allow variable data rate input of < 20k bytes/second. To accomplish this each FIFO

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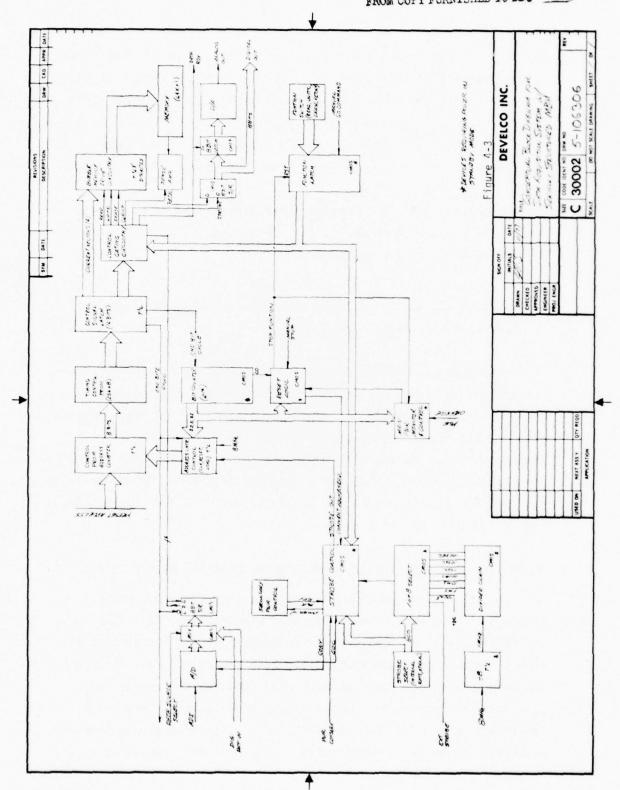
register would require 256 bits of storage (64 presently) allowing the data to be buffered until a full files worth of data were ready for storage. Some additional control circuitry would be required, however, 256 bit FIFO's are available that will directly replace the 64 bit units.

4.2 ALTERNATE 8 BIT PARALLEL DIGITAL DATA ACQUISITION DESIGN CONCEPT

A possible alternate design for a data acquisition system is shown in block diagram 4-2. The concept assumes use of the T.I. MBM and peripheral devices. The main objectives of an alternate design would be to produce a data acquisition system with

- A) Variable data rates within the limits or constraints imposed by the T.I. unit, e.g.; data rates of 50k bytes/sec. or < 20k bytes/ second. (The gap between the fixed maximum data rate and lower variable rates results from the fact that the major loop must be cleared before powering down between samples. The possibility of permitting such storage under some conditions is being investigated, and if it turns out to be possible, the control design problem will be greatly simplified.)
- B) Minimum power consumption by means of powering down unnecessary devices during periods of not recording data at low data rates. By properly selecting devices, it is believed standby power can be reduced to <100mW (possibly at the expense of chip count).</p>
- C) Simplified control logic.

The function timing would be the same as for the existing system. The FIFO control would remain the same expect for the expansion of the FIFO memory size to implement variable data rates. The remainder of the system concept changes. The basic control concept would consist of using direct PROM control. This is implemented by programming PROMS with a set of control sequences for each different type of operation (e.g.; file add-on access, variable data rate acquisition, maximum data rate, acquisition, etc.).



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The base address of the PROM is a result of the function input. A command consisting of Annihilate, Generate Replicate, (etc.) bits, and count value would be clocked from the PROMS to registers. The counter would be decremented every 10μ s bubble cycle. When the counter was decremented to 0 the next command and count would be loaded. This process would continue until an entire sequence had been executed.

The controller could be commanded by a computer for test and data retrieval or commanded manually for field operation. A file number counter would serve two purposes;

- 1. To access a specific file number, and
- To count the number of files recorded in field operations for automatic shut-down.

In a data acquisition mode the entire system would be powered when 144 bytes were stored in the FIFO. The next sequential file in the minor loops would be transferred out, annihilated, and then recorded with the 144 bytes. Other data could be strobed into the FIFOS simultaneously. The new file would then be transferred into the minor loops, bubbles stopped, and the system would go into standby power mode. This process would repeat unit1 all 641 files were recorded at which time all power would shut down.

4.3 CONTROL CONCEPT FOR A SERIAL ARCHITECTURE MAGNETIC BUBBLE MEMORY

The parallel digital recorders described in Sections 4.1 and 4.2, although they have important potential applications, lack the flexibility required for general use because of the limitations of present major-minor loop devices for data recording use. Although the major-minor loop configuration will continue to receive the most emphasis because it has the widest application, there may be sufficient demand for the simplicity of Plessey's single loop device to keep it alive for several years until the others evolve to a point where they are easier to use. (We have just learned that Rockwell has dropped its serial configuration, at least in commercial versions. So far, Plessey is advertizing plans to offer both kinds, but more inquiries are necessary to confirm their long range goals.) We have, therefore, considered a simple recorder type design, discussed below, that sacrafices speed for flexibility and lower cost in an initial attempt to achieve a general purpose machine.

The concept for a single serially structured bubble memory in a data storage system is illustrated in the block diagram, Figure 4-3. The concept assumes that data will be stored in serial units of 8 bit words (bytes), and as a result of this the integrity of a byte boundry must be maintained. The concept provides four main functions:

- 1. Read
- 2. Write
- 3. Erase
- 4. Return (to start point)

An exclusive function is latched into memory by a go command which executes the command. A command will be terminated at the end of the memory or when an external stop is commanded (recognized on byte boundaries).

In the read or write mode the data (byte) rate is variable. A byte cycle may be stimulated from 1 of 7 internal selectable rates ranging in decade steps from 1 byte/100µs to 1 byte/100 sec. A cycle or groups of cycles may also be stimulated from an external strobe source. The fastest byte cycle rate is obtained by maintaining a logic 1 on the strobe control circuitry.

If it were desirable to store blocks of data consisting of more than 1 byte, the END BYTE signal could be used to control a multiplexer. After

the number of bytes in a block had been counted the external strobe would be returned to logic "O" until the next sample was desired.

If an internal byte rate were selected, all noncritical devices would be powered down at rates \leq 1 byte/100ms. This obviously would reduce standby power and allow extended field operations on a battery power source.

When in the external strobe mode an external input would be required to cause the system to go into standby power mode when the strobe cycle had been completed.

The control currents for the memory are provided by the memory drive circuitry which would provide seven current signals to the memory. The timing of the signals would be programmed into a 256 x 8 bit PROM. Sixteen timing channels would be available by interleaving 8 channels in alternate PROM addresses. Some of the remaining 9 timing channels would be used for control timing, and some of these would also be gated depending on the function.

An 8 bit counter, operating at 8mHz, would provide the addressing control for the PROM yielding $1/4\mu$ s resolution in the timing controls. The PROM outputs would be stored in two 8 bit latches, each receiving data from alternate PROM addresses. Some of the control signals would be gated to the memory drive circuitry dependent on the function signals.

A 16 bit counter would be used to count the number of bits processed allowing end of memory detection. The 3 least significant bits would be used to cause timing cycles in groups of 8 bits, thus maintaining byte boundaries.

The system described in the diagram also provides for both digital and analog I/O interfaces. This would provide for either mode of operation

or both where it might be desirable to interleave both types of data. The main power control would shut down the entire unit after the entire memory had been accessed if the power override were turned off after the system was initialized. The system would also automatically shut down if the power source dropped below a level where improper operation might effect data in the memory.

The block diagram may be simplified as follows:

- A. Limit the data rate to an external source eliminating approximately 10 IC's.
- B. Eliminating power control circuitry.

Further simplification in the control circuitry could be realized by producing an 8 bit wide system. This would require the memory drive circuitry to be produced 8 times which offsets the savings in control complexity, but the maximum throughput would increase by a factor of 10.

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APPENDIX I TEXAS INSTRUMENTS EQUIPMENT SPECIFICATION TBM0101 BUBBLE MEMORY DEVICE

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	*
1.0	SCOPE
	This specification describes the electrical, mechanical and environmental
	characteristics of the TBM 0101 Bubble Memory Device.
2.0	GENERAL DESCRIPTION
	The TBM 0101 Bubble Memory Device is a 14 pin dual in-line module
	containing a 92 K bit bubble memory chip, coils for providing a rotating
	magnetic field, a permanent magnet structure for providing the required
	static magnetic field, and a magnetic shield assembly.
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3.0	FEATURES
5.0	FEATURES 92K bit nonvolatile memory
	Occupies less than 0.5 cubic inch
	Consumes less than 0.7 watts for continuous operation
	Weighs less than 25 grams
	Rugged package with self-contained magnetics
	Major/minor loop architecture
	Average access time (first bit) - 4 ms
	100 KHz read/write operation
	50 Kb/s data rate
	SIZE GODE IDENT NO DRAWING NO
	A 96214
	SCALE REV A SHEET 1 of 17
	SCALE REV A SMEET 1 of 1/

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4.0

5.0

5.1

92 K chip specification TI Drawing No. SK 2007653 TMS 5502 Bubble Memory Controller Specification TI Drawing No. SK 2007654 Schematic - Bubble Memory Card TI Drawing No. SK 2007655

FUNCTIONAL DESCRIPTION

Bubble Chip Operation

The 92 K bit bubble chip consists of a substrate of gadolinium gallium garnet on which is grown an epitaxial film of magnetic garnet material. This film supports 5μ m cylindrical bubble domains.

Patterns of permalloy metal are deposited on the epitaxial film to define the path of the cylindrical bubble domain in the presence of a rotating magnetic field. As the field rotates, the bubble domains move under the metallic patterns in shift register fashion.

F

A static magnetic field (bias field) is provided perpendicular to the plane of the chip to control the size and shape of the bubble domains.

Control functions (i.e. generate, transfer in, transfer out, replicate and annihilate) are accomplished by providing current pulses through the appropriate control elements on the chip. Current flowing through a control element causes a local alteration in the magnetic field. This field alteration, in conjunction with the local permalloy pattern, accomplishes the control function.

After generation, the bubble domains move $22.5 \,\mu$ m during each rotation of the magnetic field. Control functions must be timed to ensure that the bubble domain has arrived at the proper location on the chip.

9136	SCALE		REV A		SHEET 2 of 17
	A	962	14	SK 2007651	
	3.26	CODE DE			

To detect the presence or absence of bubbles, two magneto-resistive elements are provided. These elements may be used as part of a bridge circuit configuration which provides a high degree of noise cancellation when used with an external differential amplifier.

Major/Minor Loop Operation See Figure 1.

Bubble domains representing bits may be created under the generate loop. These domains step through the major loop in the indicated direction.

When a data string has been generated, equal in length to the number of minor loops (a page), and shifted such that the first bit is positioned over the first minor loop, the transfer gate may be energized. This operation transfers the page from the major loop into the minor loops. The data now circulates in the minor loops. New data may be generated, shifted, and transferred into each of 641 different minor loop page positions.

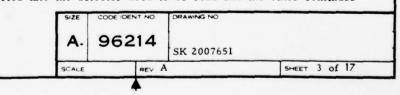
Data is retrieved by doing a transfer out operation when the desired page rotates to the top of the minor loops. This moves the page out of the minor loop structure and puts it back into the major loop. The page now moves around the major loop in bit serial form until the first bit arrives at the replicate/annihilate element. One of two control operations may now be performed:

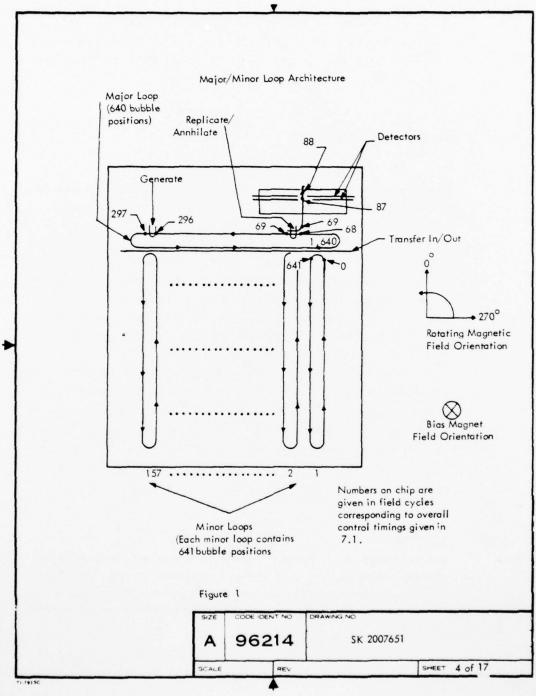
5.2.1 Replicate

1 7915

5.2

If a replicate pulse is issued each time a bubble domain arrives at the replicate/annihilate gate, each domain is stretched and cut. One portion is diverted into the detector area to be read and the other continues





moving in the major loop. It is thus possible to read a page, recirculate the information around the major loop and put it back into the minor loops for nonvolatile storage. This operation provides a nondestructive read capability.

¥

5.2.2 Annihilate

Annihilation is accomplished by applying a current pulse to the replicate/ annihilate gate that transfers the bubble out of the major loop and into the detector track where it propogates off the chip.

Redundancy

5.3

To enhance production yields and reduce device cost, 144 of the 157 minor loops are guaranteed to be useful. The user's system must insure that information is not written into defective loops and it must ignore any information read from these loops.

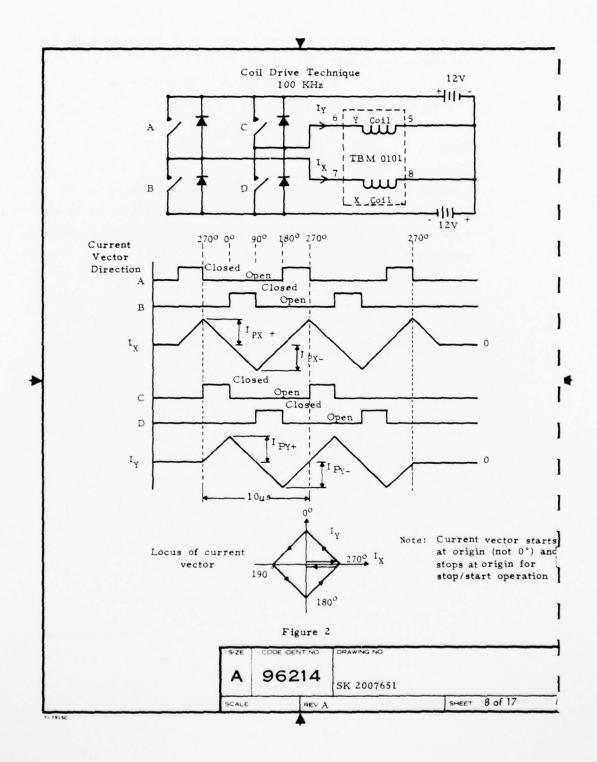
Defective minor loops result from manufacturing processes related to the small geometry of the permalloy patterns. Defective minor loops are identified during factory testing and in no way relate to a field failure mode. A map of the defective minor loop location will be written into the device at the factory before shipment. This map must be read by the user in order to implement data transfers to the device.

		SCALE	REV	4	s	HEET	5 of 1	7
		AS	6214	SK	2007651			
		SIZE CO	DE DENT NO	DRAWING NO				
	Minor loop count	(unuse	d)	13				
	Minor loop count	(usefu	1)	144				
	Minor loop count	(total)	157				
5.4	Device Capacity							

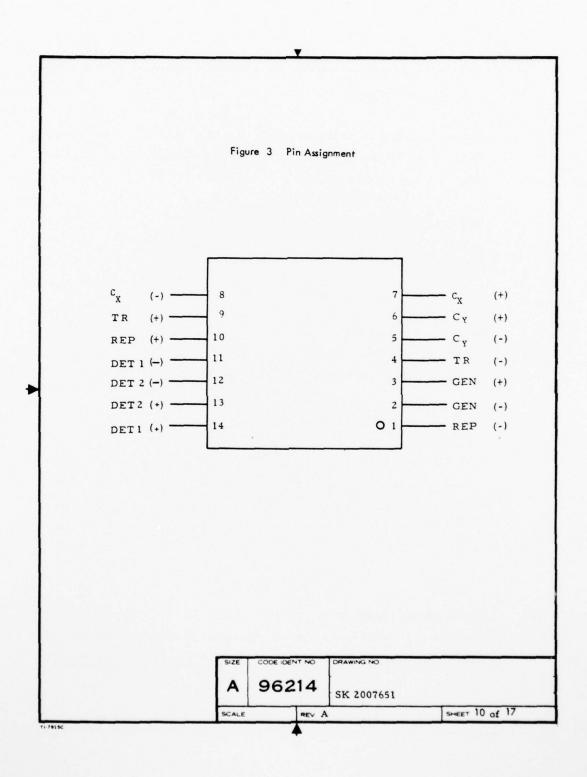
5.4	Device Capacity (Continued)	
	Major loop length	640 periods
	Minor loop length	641 periods
	Raw data capacity	100,637 bits
	Useful data capacity (92 K bits nominal)	92,304 bits
	Percent redundant storage	8.28 percent
	Redundancy shall be implemented by avoiding t	the writing of bubbles into any
	defective loop and neglecting bubble information	tion read from any defective loop.
5.5	Performance Specifications at 100 KHz Operat:	ion
	Min	Nom Max Unit
	Average access time (first bit) -	4 - ms
	Average cycle time (144 bit page) -	9.6 - ms
	Hard error rate after N years -	10 ⁻⁹ Na errors/bit
	residence time with operating duty cycle d **	
	Soft error rate*	10 ⁻⁹
	Data rate -	50 - Kbits/sec
	*Depends upon sense electronics and layout	
	**This maximum error rate shall be sustained	on reading data that has been
	resident in the device for Nd years of conti	nuous READ/WRITE operation, e.g.,
	for N = 1 and d = $1/100$, hard error rate = 1	0 ⁻¹¹ errors/bit; for N = 0.1 and
	d = 1, hard error rate = 10^{-10} errors/bit.	, 그렇는 것은 동물 것은 것을 물
5.6	Bias Margin	김 위원님께 관계하는 것을 가지 않는 것을 가지 않는 것을 가지 않는 것을 하는 것을 수가 있다. 말하는 것을 하는 것을 하는 것을 하는 것을 하는 것을 수가 있는 것을 하는 것을 수가 있는 것을 수가 있다. 귀에서 있는 것을 수가 있다. 귀에서 이 같이 같
	The chip shall have an operating bias margin of no	less than 8 Oe. This
	minimum margin shall be achieved under any c	combination of the parameters
	SIZE CODE DENT NO DRAWING	NO
	A 96214 SK	2007651
	SCALE REV	SHEET 6 of 17
791 SC		0.011/

TI-7915C	
	SCALE REV SHEET 7 of 17
	A 96214 SK 2007651
1	SIZE CODE IDENT NO DRAWING NO
I	
1	
1	
1	
1	See Figure 2.
1	approach renus reserv to precise digital control of the drive field.
1	Triangular current waveforms are recommended for driving the two coils. This approach lends itself to precise digital control of the drive field.
1	
	mode.
1	not required, a power savings can be realized by operating in the start/stop
1	motion can be started and stopped without error. Thus, if continuous duty is
1	If the two coils are turned on and off in the prescribed manner, bubble domain
	patterns.
1	It is this rotating field that causes bubble domains to move under the permallo
1	out of phase, produce a rotating magnetic field in the plane of the bubble chip
	The bubble chip is surrounded by two orthogonal coils which, when driven 90°
6.0	ELECTRICAL Coil Drive
1	
•	amplitude and timing, humidity and vibration.
	specified herein, i.e., temperature, drive field, control pulse current
5.6	Bias Margin (continued)

v



.1.1	Coil Drive Requirements				
		Min	Nom	Max	Unit
	Peak field strength for triangular drive	48	50	54	Oerstee
	Field rotation frequency	99.99	100.00	100.01	KHz
	Phase lag(inner coil with respect to outer coil)	87	90	93	Degree
	Total coil power		0.7	1.1	Watts
	X Coil				
	Inductance	62	64	66	μh
	Resistance (DC)	-	3.9	-	Ohms
	Resistance (AC at 100 KHz)	-	4.8	-	Ohms
	IPX+ (Positive peak current)	445	460	485	ma
	IPX- (Negative peak current)	445	460	485	ma
	Y Coil				
	Inductance	60	62	64	μh
	Resistance (DC)	-	3.0	-	Ohms
	Resistance (AC at 100 KHz)	-	4.3	-	Ohms
	IPY+ (Positive peak current)	465	480	495	ma
	IPY- (Negative peak current)	465	480	495	ma
.0	CONTROL CURRENT TIMINGS AND AMPLITUDES				
	All timings are based on the direction of t	the rotatin	ng field w	ith respec	t to th
	bubble device orientation. These timings an Size CODE DENT NO DRA A 96214	re delays f wing no SK 2007		ime when t	he fie



	Lea	Leading Edge (µs)	(h s)	Pulse	Pulse Width (µs)	hs)	Ampli	Amplitude* (mA)	
	Min	Nom	Max	Min	Nom	Мах	Min	Мош	Мах
Generate	0.125	.25	. 375	0.125	.25	.375	240-1.2T	250-1.2T	280-1.2T
Replicate	5.125	5.25	5.375	1.375	1.50	1.625	12557T	13557T	14557T
Ann 1 h1 late	3.375	3.5	3.625	4.625	4.75	4.875	40	60	80
Transfer Out	0.875	1.0	1.125	1.625	1.75	1.875	4009T	4209T	4409T
Transfer In	4.625	4.75	4.875	2.375	2.5	2.625	25	27	30
Detector	DC	DC	pc	DC	DC	DC	4.8	5.5	6.2
clamp t	.625	.75	.875	1.625	1.75	1.875		TTL	
Strobe T	1.625	1.75	1.875	0.125	.25	.375		TTL	
<pre>*T is degrees Celsius ** Strobe i* an edge sensitive function and is defined for a positive edge</pre>	elstus dge sens	itive fun	ction and	ts defined	d for a	positive	edge		
t Suggested timings only; See 9.0.	s :vlno st	ee 9.0.							

*

7.0

CONTROL CURRENT TIMINGS AND AMPLITUDES (Continued)

is 0° . The current conventions are in accordance with Figure 3.

7.1 Control Timings (Overall)

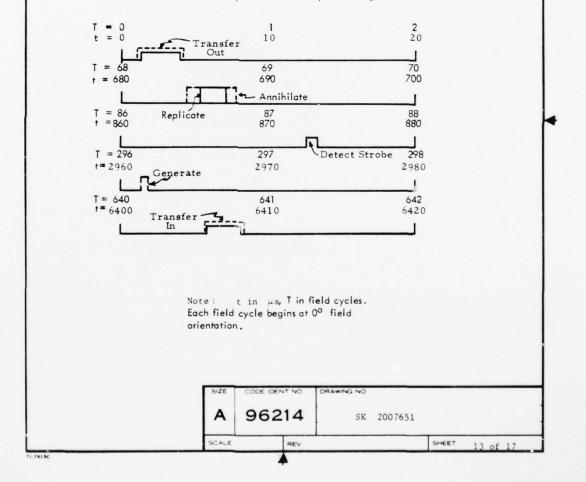
The following timings refer to the first bubble to be read or written in a page of bubble data. A "page" is the block of information obtained from the transfer operation, i.e., one bit from each of the 157 loops. The timings are taken from the leading edge of the first control pulse to the leading edge of the second control pulse. These timings are used only to verify the overall control sequence and should not be used to verify the timings within each drive field cycle as given in 7.0. The timings are based on use of a 100 KHz drive field accurate to 0.01% in frequency. If the user's drive field frequency F (KHz) differs from 100.00 KHz his timings should be multiplied by the factor F/100 before comparison with these values.

Transfer out to replicate	684	±l µs
Transfer out to bubble signal peak	872	±1µs
Transfer out to generate	2962	±1 µs
Transfer out to transfer in	6405	±1 µs

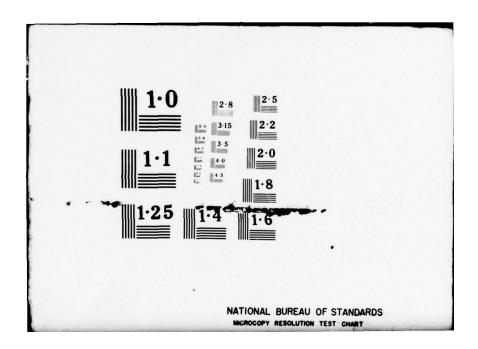
SCALE	REV	-	SHEET	12 of 17
A	96214	SK 2007651		
SIZE	CODE IDENT NO	DRAWING NO		



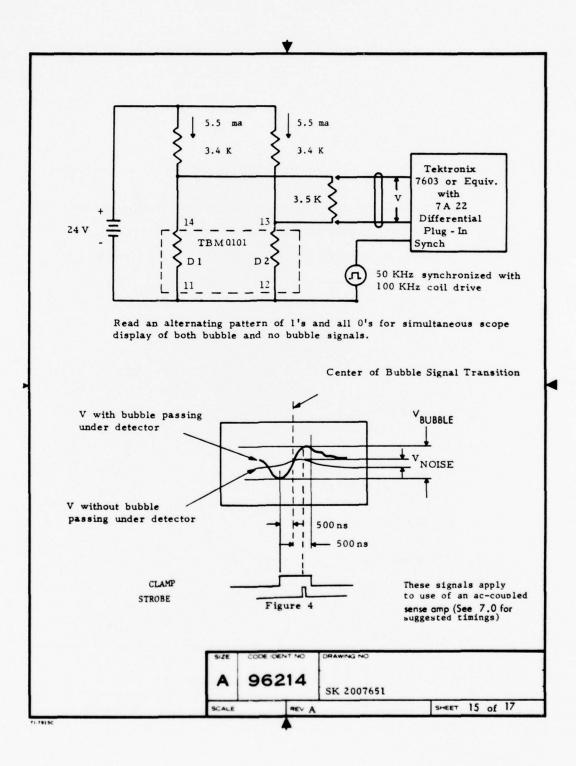
The bubble functions are shown schematically on the following diagram to show the operations necessary to read (solid lines) or write (dashed lines) the first bit in a page (the bit from minor loop number 1). The minor loops are spaced such that one void bit position exists between all data bits after transfer out operation. Therefore, all major loop functions are repeated at a 50 KHz frequency. The drawing below is arranged so that the functions may be set up in the proper synchronism. The timings are given in both field cycles and microseconds. The field cycle counts corresponds to Figure 1.



SSIFIED 2 OF 2 ADA 056391		1026-			 DNA-44		甗	NL	-	蔚
								The second state	Press. Sta	4.
			Hardwood Control of Co						-22-	
			Statester 1974 - Statester FILL	atta.	-					
min	L L L L L L L L L L L L L L L L L L L				addishinadda faalalaa	hallow the second	END DATE FILMED 8 -78 DDC			



	¥		_				
8.0	FUNCTION RESISTANCE						
		Min	Nom	Max	Unit		
	Detector 2 (closest to bar edge)	950	1100	1300	Ohms		
	Detector 1	950	1100	1300	Ohms		
	Detector 2 - Detector 1 mismatch	-10	-	+10	Ohms		
	Generator	2	3	5	Ohma		
	Replicator	5	6	8	Ohms		
	Transfer	260	310	350	Ohms		
9.0	DETECTOR SIGNAL AND NOISE						
	The following information presumes bridge connected detectors with 5.5 ma						
	DC flowing in each bridge arm as in	Figure 4	4.				
	resistive detectors produces a signal of several millivalts with two positive peaks and two negative peaks. Noise Sources: 1) Since the magnetoresistive elements are surrounded by a rotating magnetic field, any detector mismatch will produce nois at twice the rotating field frequency. 2) Control pulses can produce high frequency noise com- ponents due to circuit coupling. 3) Incorrect circuit layout can produce noise at the rotating						
	field frequency. See Figure 4 for test set up.						
	SIZE CODE IDENT NO	DRAWING NO					
	A 96214	GH 3005					
		SK 20076	51				
	SCALE REV A			SHEET	14 of 17		



	Min	Nom	Max	Units
VBUBBLE	2	-	7.5	mv
VBUBBLE / VNOISE	4	-	-	mv/mv

V

 V_{NOISE} is defined as the maximum positive transition of the no-bubble signal within a \pm 500 ns window on either side of the center of the bubble signal transition.

The bubble signal transition time shall not vary more than $\pm 0.1 \ \mu s$ under all conditions.

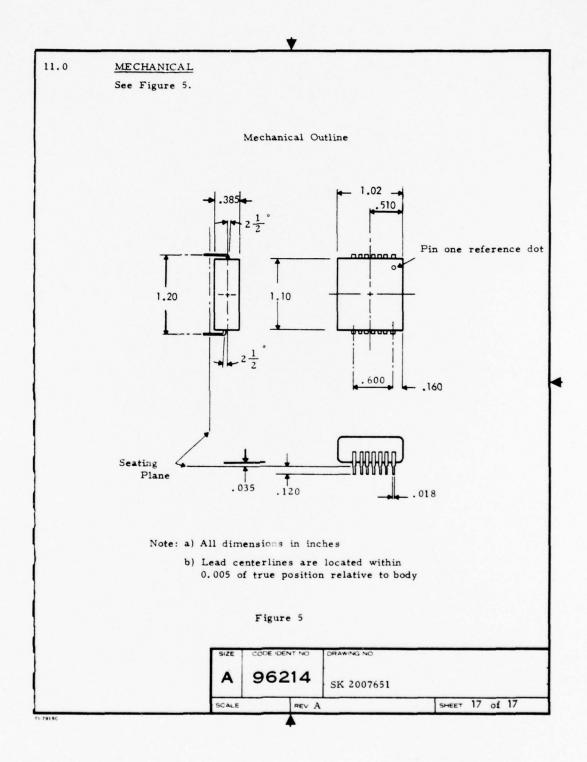
10.0

ENVIRONMENTAL SPECIFICATIONS

	Min	Nom	Max	Unit
Weight		25	-	Grams
Operating temperature	0	-	70	°c
Nonvolatile* storage temperature	-40	-	85	°c
Non-use storage temperature	-40	-	100	°c
Non-operating handling shock	-	-	300	G
Operating vibration up to 500 KHz	-	-	5	G
Humidity (Up to 70°C)	-	-	95	Percent
DC magnetic field, any direction	-	-	20	Oersteds

*Without memory loss

Г	SIZE CODE IDENT NO		DRAWING NO			
A 96		962	14	SK 2007651		
-	SCALE		REV		SHEET	16 of 17



APPENDIX II

MC2901 FOUR-BIT MICROPROCESSOR SLICE

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FOUR-BIT TTL MICROPROCESSOR SLICE

DISTINCTIVE CHARACTERISTICS

- Two-address architecture -
- Independent simultaneous access to two working registers saves machine cycles.

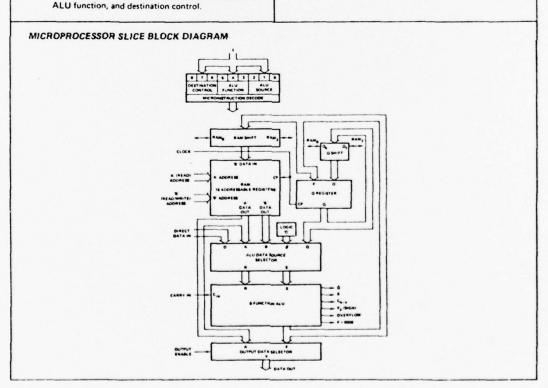
Eight-function ALU -

- Performs addition, two subtraction operations, and five logic functions on two source operands.
- Flexible data source selection ALU data is selected from five source ports for a total of 203 source operand pairs for every ALU function.
- Left/right shift independent of ALU Add and shift operations take only one cycle.
- Four status flags -
- Carry, overflow, zero, and negative.
- Expandable Connect any number of MC2901's together for longer word lengths.
- Microprogrammable Three groups of three bits each for source operand, All foresting and design and source operand.

GENERAL DESCRIPTION

The four-bit bipolar microprocessor slice is designed as a high-speed cascadable element intended for use in CPU's, peripheral controllers, programmable microprocessors and numerous other applications. The microinstruction flexibility of the MC2901 will allow efficient emulation of almost any digital computing machine.

The device, as shown in the block diagram below, consists of a 16-word by 4-bit two-port RAM, a high-speed ALU, and the associated shifting, decoding and multiplexing circuitry. The nine-bit microinstruction word is organized into three groups of three bits each and selects the ALU source operands, the ALU function, and the ALU destination register. The microprocessor is cascadable with full look-ahead or with ripple carry, has three-state outputs, and provides various status flag outputs from the ALU. Advanced low-power Schottky processing is used to fabricate this 40-lead LSI chip.



MC2901

ARCHITECTURE

A detailed block diagram of the bipolar microprogrammable microprocessor structure is shown in Figure 1. The circuit is a four-bit slice cascadable to any number of bits. Therefore, all data paths within the circuit are four bits wide. The two key elements in the Figure 1 block diagram are the 16-word by 4-bit 2-port RAM and the high-speed ALU.

Data in any of the 16 words of the Random Access Memory (RAM) can be read from the A-port of the RAM as controlled by the 4-bit A address field input. Likewise, data in any of the 16 words of the RAM as defined by the B address field input can be simultaneously read from the B-port of the RAM. The same code can be applied to the A select field and B select field in which case the identical file data will appear at both the RAM A-port and B-port outputs simultaneously.

When enabled by the RAM write enable (RAM EN), new data is always written into the file (word) defined by the B address field of the RAM. The RAM data input field is driven by a 3-input multiplexer. This configuration is used to shift the ALU output data (F) if desired. This three-input multiplexer scheme allows the data to be shifted up one bit position, shifted down one bit position, or not shifted in either direction.

The RAM A-port data outputs and RAM B-port data outputs drive separate 4-bit latches. These latches hold the RAM data while the clock input is LOW. This eliminates any possible race conditions that could occur while new data is being written into the RAM.

The high-speed Arithmetic Logic Unit (ALU) can perform three binary arithmetic and five logic operations on the two 4-bit input words R and S. The R input field is driven from a 2-input multiplexer, while the S input field is driven from a 3-input multiplexer. Both multiplexers also have an inhibit capability; that is, no data is passed. This is equivalent to a "zero" source operand.

Referring to Figure 1, the ALU R-input multiplexer has the RAM A-port and the direct data inputs (D) connected as inputs. Likewise, the ALU S-input multiplexer has the RAM A-port, the RAM B-port and the O register connected as inputs.

This multiplexer scheme gives the capability of selecting various pairs of the A, B, D, O and "O" inputs as source operands to the ALU. These five inputs, when taken two at a time, result in ten possible combinations of source operand pairs. These combinations include AB, AD, AO, AO, BD, BO, BO, DO, DO and OO. It is apparent that AD, AO and AO are somewhat redundant with BD, BO and BO in that if the A address and B address are the same, the identical function results. Thus, there are only seven completely non-redundant source operand pairs for the ALU. The MC2901 microprocessor implements eight of these pairs. The microinstruction inputs used to select the ALU source operands are the IO, II, and I2 inputs. The definition of IO, II, and I2 for the eight source operand combinations are as shown in Figure 2. Also shown is the octal code for each selection.

The two source operands not fully described as yet are the D input and Q input. The D input is the four-bit wide direct data field input. This port is used to insert all data into the working registers inside the device. Likewise, this input can be used in the ALU to modify any of the internal data files. The Q register is a separate 4-bit file intended primarily for multiplication and division routines but it can also be used as an accumulator or holding register for some applications.

The ALU itself is a high-speed arithmetic/logic operator capable of performing three binary arithmetic and five logic functions. The I₃, I₄, and I₅ microinstruction inputs are used to select the

ALU function. The definition of these inputs is shown in Figure 3. The octal code is also shown for reference. The normal technique for cascading the ALU of several devices is in a look-ahead carry mode. Carry generate, \overline{G} , and carry propagate, \overline{P} , are outputs of the device for use with a carry-look-ahead-generator such as the MC2902 ('182). A carry-out, C_{n+4} , is also generated and is available as an output for use as the carry flag in a status register. Both carry-in (C_n) and carry-out (C_{n+4}) are active HIGH.

The ALU has three other status-oriented outputs. These are F₃, F = 0, and overflow (OVR). The F₃ output is the most significant (sign) bit of the ALU and can be used to determine positive or negative results without enabling the three-state data outputs. F₃ is non-inverted with respect to the sign bit output Y₃. The F = 0 output is used for zero detect. It is an open-collector output and can be wire OR'ed between microprocessor slices. F = 0 is HIGH when all F outputs are LOW. The overflow output (OVR) is used to flag arithmetic operations that exceed the available two's complement number range. The overflow output (OVR) is HIGH when overflow exists. That is, when C_{n+3} and C_{n+4} are not the same polarity.

The ALU data output is routed to several destinations. It can be a data output of the device and it can also be stored in the RAM or the Q register. Eight possible combinations of ALU destination functions are available as defined by the I₆, I₇, and I₈ micro-instruction inputs. These combinations are shown in Figure 4.

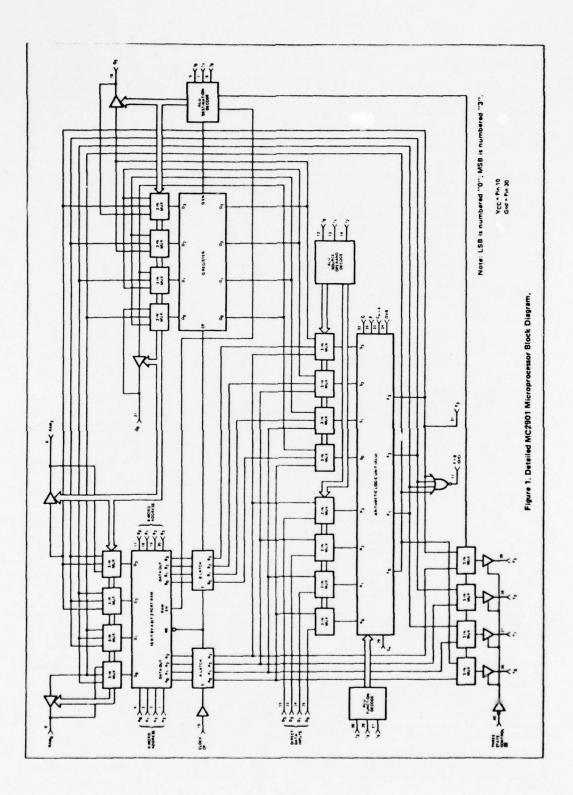
The four-bit data output field (Y) features three-state outputs and can be directly bus organized. An output control (\overline{OE}) is used to enable the three-state outputs. When \overline{OE} is HIGH, the Y outputs are in the high-impedance state.

A two-input multiplexer is also used at the data output such that either the A-port of the RAM or the ALU outputs (F) are selected at the device Y outputs. This selection is controlled by the 16, 17, and 1g microinstruction inputs. Refer to Figure 4 for the selected output for each microinstruction code combination.

As was discussed previously, the RAM inputs are driven from a three-input multiplexer. This allows the ALU outputs to be entered non-shifted, shifted up one position (X2) or shifted down one position (± 2). The shifter has two ports; one is labeled RAM₀ and the other is labeled RAM₃. Both of these ports consist of a buffer-driver with a three-state output and an input to the multiplexer. Thus, in the shift up mode, the RAM₃ buffer is enabled and the RAM₀ multiplexer input is enabled. Likewise, in the shift down mode, the RAM₀ buffer and RAM₃ input are enabled. In the no-shift mode, both buffers are in the high-impedance state and the multiplexer inputs are not selected. This shifter is controlled from the I_B, I₂ and I_B microinstruction inputs as defined in Figure 4.

Similarly, the Q register is driven from a 3-input multiplexer. In the no-shift mode, the multiplexer enters the ALU data into the Q register. In either the shift-up or shift-down mode, the multiplexer selects the Q register data appropriately shifted up or down. The Q shifter also has two ports; one is labeled Q₀ and the other is Q₃. The operation of these two ports is similar to the RAM shifter and is also controlled from Ig, I₂, and Ig as shown in Figure 4.

The clock input to the MC2901 controls the RAM, the D register, and the A and B data latches. When enabled, data is clocked into the Q register on the LOW-to-HIGH transition of the clock. When the clock input is HIGH, the A and B latches are open and will pass whatever data is present at the RAM outputs. When the clock input is LOW, the latches are closed and will retain the last data entered. If the RAM-EN is enabled, new data will be written into the RAM file (word) defined by the B address field when the clock input is LOW.



	MICR		ANDS		
Pin 14 12	Pin 13	Pin 12 40	Octail Code		8
L	L	L	0		٥
L	L	H	1	A	
L	н	L	2	0	٥
L	н	H	3	0	
н	L	L	4	0	
H	L	H	8	D	
H	н	L		D	٥
н	H	H	7	0	0

MICRO CODE ALU Function Pin 27 Pin 28 Pin 26 15 14 13 Symbol Octal Code R Plue S S Minue R R Minue S R OR S R AND S R EX-OR S R EX-NOR S R + S S - R R - S R V S R A S R A S R A S R V S ----.......... 01234567

Figure 2. ALU Source Operand Control.

Figure 3. ALU Function Control.

	MIC	RO COD	E		RAM		O-REG. FUNCTION		RAM SHIFTER		Q SHIFTER	
Pin 6	Pin 7 17	Pin 5	Octal Code	Shift	Land	Shift	Load	OUTPUT	RAMO	RAM3	00	0,
L	L	L	0	×	NONE	NONE	F+Q	F	×	×	x	×
L	L	н	1	×	NONE	×	NONE	F	×	×	×	×
L	н	L	2	NONE	F-+B	×	NONE	•	×	×	x	×
L	н	н	3	NONE	F8	×	NONE	F	×	x	×	x
н	L	L	•	DOWN	F/2 → B	DOWN	a/2 + a		Fo	1N3	00	IN
н	L	н	6	DOWN	F/2 → B	×	NONE	+	FC	18.3	00	×
н	н	L	6	UP	2F → B	UP	20 +0	F	INO	f3	INO	0
н	н	н	,	UP	2F → B	×	NONE		INO	F3	×	0

X= Don't care. Electrically, the shift pin is a TTL input internally connected to a three state output which is in the high-impodance state. B = Register Addressed by B inputs. Up is toward MSB, Down is toward LSB.

Fi	gure 4.	ALU	Destination	Control
	yure 4.	ALO.	Destination	Control

~	210 OCTAL	0	1	2	3	4	5	6	7
01543	ALU Source ALU Function	A, Q	A, B	o, a	0, B	0, A	D, A	D, Q	D, 0
0	Cn=L R Plus S	A+0	A+8	٥	•	•	D+A	D+Q	D
	Cn = H	A+Q+1	A+8+1	0+1	8+1	A+1	D+A+1	D+Q+1	D+1
1	Cn = L S Minus R	Q-A-1	8-A-1	0-1	8-1	A-1	A-D-1	Q-D-1	-D-1
_	Cn-H	0-A	B-A	0	8	•	A-D	0-D	-D
2	Cn = L R Minus S	A-Q-1	A-8-1	-0-1	-0-1	-A-1	D-A-1	D-0-1	D-1
_	Cn-H	A-0	A-8	-0	-8	-A	D-A	D-0	D
3	RORS	Ava	Av8	o	•	•	DVA	DVQ	D
4	R AND S	A^Q	A^8	0	٥	0	D^A	DAQ	0
8	Ř AND S	۸۸a	2	٥			D ^A	ōna	0
	R EX-OR S	A+0		٩		•	DVA	0¥0	0
,	REXNORS	A+0		٥		X	DYA	0+0	õ

SOURCE OPERANDS AND ALU FUNCTIONS

There are eight source operand pairs available to the ALU as selected by the I_0 , I_1 , and I_2 instruction inputs. The ALU can perform eight functions; five logic and three arithmetic. The I_3 , I_4 , and I_5 instruction inputs control this function selection. The carry input, C_n , also affects the ALU results when in the arithmetic mode. The C_n input has no effect in the logic mode. When I_0 through I_5 and C_n are viewed together, the matrix of

Figure 5 results. This matrix fully defines the ALU/source operand function for each state.

The ALU functions can also be examined on a "task" basis, i.e., add, subtract, AND, OR, etc. In the arithmetic mode, the carry will affect the function performed while in the logic mode, the carry will have no bearing on the ALU output. Figure 6 defines the various logic operations that the MC2901 can perform and Figure 7 shows the arithmetic functions of the device. Both carry-in LOW (C_n = 0) and carry-in HIGH (C_n = 1) are defined in these operations.

Octal 1543, 1210	Group	Function
40		AAQ
41	AND	A^B
4 5	AND	DAA
4 6		DVO
30		AVO
31	OR	AVB
3 5	Un	DVA
36		DVQ
60		AVO
6 1	EX-OR	AVB
6 5	EXOH	DYA
66		DAO
70		AVQ
71		AVB
75	EX-NOR	DVA
76		DAG
72		ā
73		B
74	INVERT	Ā
77		ō
6 2		0
63	PASS	B
64	FASS	A
67		D
3 2		a
3 3	PASS	B
34	PASS	A
37		D
4 2		0
4 3	"ZERO"	0
4 4	Leno	0
47		0
50		ĀAQ
5 1	MASK	Ā∧B
5 5	MASK	DAA
56		DAQ

Figure 6. ALU Logic Mode Functions. (Cn Irrelevant)

Octal	Cn = 0	Low)	$C_n = 1$ (High)		
1543. 1210	Group	Function	Group	Function	
0.0		A+Q		A+Q+1	
0 1	ADD	A+B	ADD plus	A+B+1	
0 5		D+A	one	D+A+1	
06		D+Q		D+Q+1	
0 2		۵		Q+1	
03	PASS	в	Increment	B+1	
04		A		A+1	
07		D		D+1	
1 2		Q-1		a	
1 3	Decrement	B-1	PASS	в	
14		A-1		A	
27		D-1		D	
2 2		-0-1		-0	
2 3	1's Comp.	-8-1	2's Comp.	-B	
24		-A-1	(Negate)	-A	
17		-D-1		-D	
10		Q-A-1		Q-A	
11	Subtract	8-A-1	Subtract	B-A	
1 5	(1's Comp)	A-D-1	(2's Comp)	A-D	
1 6		Q-D-1		0-D	
20		A-Q-1		A-Q	
2 1		A-B-1		A-B	
2 5		D-A-1		D-A	
26		D-Q-1		D-Q	

Figure 7. ALU Arithmetic Mode Functions.

APPENDIX III 9408 MICROPROGRAM SEQUENCER

9408 MICROPROGRAM SEQUENCER FAIRCHILD I³L[™] MACROLOGIC

DESCRIPTION – The 9408 Microprogram Sequencer controls the order in which microinstructions are fetched from the control memory. It contains a 10-bit program counter, a 4-level last-in first-out stack and associated control logic. It can control up to a maximum of 1024 words of memory. For larger word capacities external paging can be used. The 9408 is controlled by a 4-bit instruction input. The instruction set includes Fetch, Conditional and Unconditional Branches, Branch to Subroutine and Return from Subroutine.

There are seven test inputs – four participate in conditional branches, and three in multiway branches. The conditional test lines are flip-flop buffered. These flip-flops can be tested individually by appropriate branch instructions. The three multiway test inputs are used to form the least significant three bits of the branch address for a multiway branch. Thus, branching occurs at one of eight unique locations depending on the bit pattern present on these three inputs.

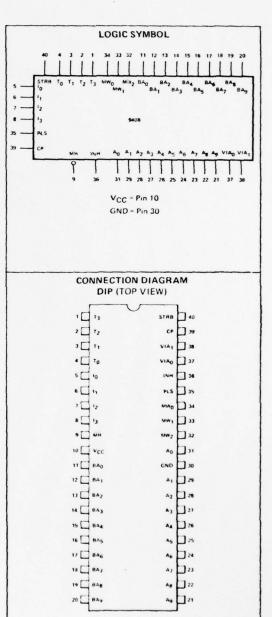
The 9408 is designed to operate in pipeline or non-pipeline mode as desired by the user. The device operates synchronously with the clock input and can be initialized using the Master Reset input.

The 9408 is fabricated using Integrated Injection Logic (I³L^{TV}) technology and fully compatible with all TTL families.

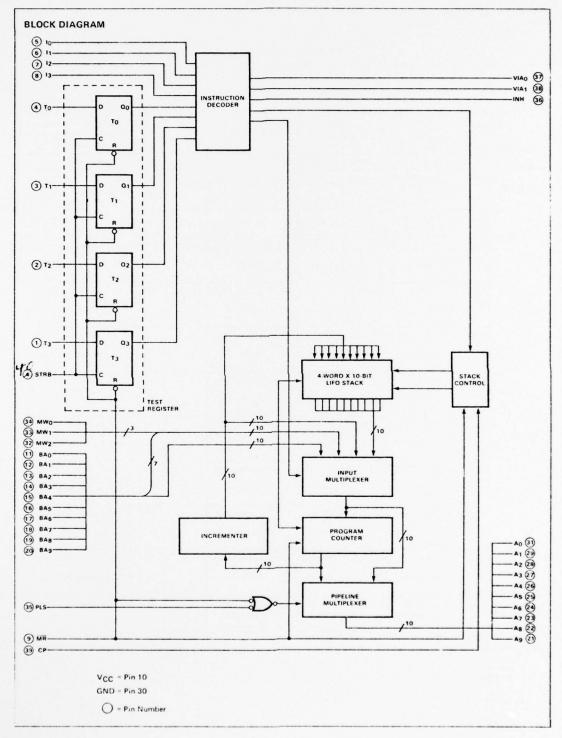
- CONTROLS 1024 WORDS OF MICROPROGRAM MEMORY (10-BIT ADDRESS)
- UNRESTRICTED BRANCHING WITHIN 10-BIT ADDRESS SPACE 16 INSTRUCTIONS
- FOUR FLIP FLOP BUFFERED TEST INPUTS FOR CONDITIONAL BRANCHES
- . 8 WAY BRANCH CAPABILITY
- PIPELINE NON-PIPELINE MODE OF OPERATION

PIN NAMES		LOADIN	G (Note a)
		HIGH	LOW
BAO BA9	Branch Address Inputs	0501	02301
To T3	Test Inputs	05 U L	023UL
MWO-MW2	Multiway Branch Inputs	OSUL	023UL
11	Instruction Input	05 U L	023UL
10.12.13	Instruction Inputs	1001	046 UL
PLS	Pipeline Select Input	OSUL	023UL
MR	Master Reset Input (Active LOW)	0501	023 UL
CP	Clock Pulse Input	1001	04601
STRB	Strobe Input	0501	02341
An An	Address Outputs	1001	SOUL
VIAO VIAI	VIA Outputs	10 U L	SOUL
INA	Inhibit Output	10 U L	SOUL

Note a 1 TTL Unit Load (U.L.) 40 µA HIGH 16 mA LOW







.

					ABLE 1 TRUCTION SET			
	MNEMONIC	DEFINITION	13121110	T3T2T1T0	090807020100	VIA1VIA0	INH	DESCRIPTION OF OPERATION
	BRVO	Branch VIAO	LHLL	XXXX	BA9 BA8-BA1 BA0	LL	н	BAO - BA9 - PC
Unconditional	BRV1	Branch VIA1	LHLH	XXXX	BA9 BA8-BA1 BA0	LH	н	BAO - BA9 → PC
Branch	BRV2	Branch VIA2	LHHL	XXXX	BA9 BA8-BA1 BA0	HL	н	BAO - BA9 → PC
branch	BRV3	Branch VIA3	LHHH	XXXX	BA9 BA8-BA1 BA0	нн	н	BAO - BA9 → PC
Instructions	BMW	Branch Multiway	ггнн	x	BA9 BA3MW2 MW0	LL	н	MW ₀ - MW ₂ , BA ₃ - BA ₉ → PC
	BSR	Branch to Subroutine	LLLH	xxxx	BA9 BA8-BA1 BA0	LL	н	$BA_0 - BA_9 \rightarrow PC \&$ Push the Stack
	втно	Branch on TO HIGH	HHLL	XXXH XXXL	BA9 BA8BA1 BA0 PC+1	LL	H	If Test Register 0 is HIGH BAO - BAO \rightarrow PC If Test Register 0 is LOW: PC+1 \rightarrow PC
	втн	Branch on T ₁ HIGH	ннгн	XXHX XXLX	BA9 BA8-BA1 BA0 PC+1	LL	н	If Test Register 1 is HIGH BA0 - BA9 \rightarrow PC If Test Register 1 is LOW: PC+1 \rightarrow PC
	втн ₂	Branch on T ₂ HIGH	нннг	XHXX XLXX	BA9 BA8-BA1 BA0 PC+1	LL	н	If Test Register 2 is HIGH: $BA_0 - BA_9 \rightarrow PC$ If Test Register 2 is LOW: $PC+1 \rightarrow PC$
Conditional Branch	втнз	Branch on T ₃ HIGH	нннµ	HXXX	8A9 8A88A1 8A0 PC+1	LL	н	If Test Register 3 is HIGH BAO - BAO \rightarrow PC If Test Register 3 is LOW: PC+1 \rightarrow PC
Instructions	BTLO	Branch on TO	HLLL	XXXL XXXH	BA9 BA8BA1 BA0 PC+1	LL	н	If Test Register 0 is LOW: $BA_0 - BA_9 \rightarrow PC$ If Test Register 0 is HIGH $PC+1 \rightarrow PC$
	BTL1	Branch on T ₁ LOW	нггн	X X L X X X H X	BA9 BA8-BA1 BAO PC+1	LL	н	If Test Register 1 is LOW: $BA_0 - BA_9 \rightarrow PC$ If Test Register 1 is HIGH $PC+1 \rightarrow PC$
	BTL2	Branch on T ₂ LOW	нгнг	X L X X X H X X	BA9 BA8-BA1 BA0 PC+1	LL	н	If Test Register 2 is LOW. BAO - BA9 → PC. If Test Register 2 is HIGH PC+1 → PC
	BTL3	Branch on T ₃ LOW	нгнн	L X X X H X X X	BA9 BA8BA1 BA0 PC+1	LL	н	If Test Register 3 is LOW: $BAO - BAO \rightarrow PC$ If Test Register 3 is HIGH $PC+1 \rightarrow PC$
Miscellaneous	RTS	Return from Subroutine	LLLL	x	Contents of the Stack Addressed by Read Pointer	LL	L	Pop the Stack
	FTCH	FETCH	LLHL	XXXX	PC+1	LL	L	PC+1→PC

FAIRCHILD . 9408

L = LOW Level H = HIGH Level X = Don't Care

FAIRCHILD • 9408

FUNCTIONAL DESCRIPTION – The 9408 Microprogram Sequencer, shown in the block diagram consists of a 10-bit Program Counter (PC), a 4-word by 10-bit Last-In First-Out (LIFO) Stack with associated control, an Input Multiplexer, a Pipeline Multiplexer, an Instruction Decoder, a 10-bit Incrementer, and a 4-bit Test Register comprised of four edge-triggered D flip-flops.

The Pipeline Multiplexer has two ports – the PC output provides the input port for the non-pipeline mode and the Input Multiplexer output provides the input port for the pipeline mode. Port selection is controlled by the Pipeline Select (PLS) and Master Reset (MR) inputs. A LOW level on the MR input forces the non-pipeline mode of operation and clears the PC. Thus when the 9408 is initialized by the MR input the AQ through Ag outputs are LOW regardless of the state of the PLS input specifies non-pipeline mode and a HIGH specifies pipeline mode.

The Program Counter is a 10-bit edge-triggered register. The LOW-to-HIGH transition on the Clock (CP) input loads the Input Multiplexer output into the PC. Because of the edge-triggered nature of the PC register, the PC output remains static for a full clock cycle. Thus, in the non-pipeline mode, the PC output can be used to address a control memory built with static devices without storing the memory output in an external microinstruction register. However, in the pipeline mode, the 9408 provides the next address information as soon as available; therefore, execution of a microinstruction can be overlapped with the fetching of the next microinstruction. To ensure microinstruction stability for a full clock cycle, the control-memory output should be buffered with an external microinstruction register.

The Input Multiplexer receives data from four different sources. One port is the output of the LIFO Stack; a second is the output of the 10-bit Incrementer. The Incrementer always adds one to the PC contents. The third and fourth ports are the branch and multiway-branch ports, the latter comprised of the seven most significant Branch Address inputs (BA3 through BA9) and the three Multiway inputs, (MW0 through MW2).

The 4-word by 10-bit LIFO Stack is a RAM and receives data from the Incrementer output. The stack control logic generates the appropriate control signals, while stack pointers in the Stack Control generate the read and write addresses.

The 4-bit Test Register consists of four type-D flip-flops. The data inputs, which are the four Test inputs (To through T3), are loaded on the LOW-to-HIGH transition of the Strobe input (STRB).

The Instruction Decoder receives the 4-bit Instruction input (I0 through I3) and the Test Register output and generates the VIA0, VIA1 and Inhibit (INH) outputs of the 9408. In addition, it generates appropriate logic signals for the Stack Control and Input Multiplexer.

Stack Control – The 9408 has a 4-level subroutine nesting capability as detailed in Figure 1. The R₀ and R₁ [Read Address] inputs to the 4-word by 10-bit LIFO Stack specify the address from which information will be read. The W₀ and W₁ (Write Address) inputs specify the address into which information will be written, and the 9408 Incrementer output provides the information to be written into the stack (see block diagram). In addition, writing into the memory is controlled by the Write Enable (\overline{WE}) and \overline{CP} inputs.

The R₀, R₁ and W₀, W₁ inputs of the LIFO Stack are derived from the outputs of a 3-bit edge-triggered register called the Stack Pointer (SP). The least significant two bits (SP₀ and SP₁) of this register are the read address inputs to the memory. The SP outputs are also connected to a Stack-Pointer Incrementer and a Decrementer that generate SP ± 1 and SP = 1 respectively. The least significant two bits of the Incrementer are the write address bits for the memory.

The outputs of the Incrementer, Decrementer and the Stack Pointer are fed as inputs to a 3-port Stack-Pointer Multiplexer which, in turn, feeds the Stack Pointer inputs. Stack pointer loading always occurs on the LOW-to-HIGH transition of the \overline{CP} input. The \overline{MR} input clears the Stack Pointer. The Stack Pointer Control receives two inputs from the 9408 Instruction Decoder – the BSR input, which is active whenever a Branch-to-Subroutine (BSR) instruction is present on the IQ through I3 inputs, and the RTS input, which is active whenever a Return-from-Subroutine (RTS) instruction is specified. The port selection of the Stack Pointer Multiplexer is controlled by the outputs of the Stack Pointer Control. For all 9408 instructions except BSR and RTS, the Stack Pointer Multiplexer selects the Stack Pointer outputs as the instruction source.

Writing into the memory takes place whenever the \overline{WE} and \overline{CP} inputs are LOW. Note that the most significant register bit, SP₂, controls the \overline{WE} input to prevent writing into the memory when all four locations are filled with return addresses. Thus the 9408 does not store and return addresses beyond four nesting levels.

APPENDIX IV MAGNETIC BUBBLE FORTRAN TEST PROGRAM

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KB: KMBMV08. LST

FORTRAN V09. 02 09:08:36 04-AUG-77 PAGE 1 MAGNETIC BUBBLE TEST PROGRAM L. R. BULDUC JULY 1977 C C C THIS PROGRAM HAS 4 MAIN FUNCTIONS CCC (1)WRITE-WRITES 144 ASCII CHARACTERS FROM KEYBOARD INTO THE FILE SPECIFIED С (2)READ-READS 144 ASCII CHARACTERS FROM THE FILE SPECIFIED TO THE KEYBOARD (3)DUMP-READS 144 ASCII CHARACTERS FROM EACH FILE C C С IN BLOCK SPECIFIED AND OUTPUTS ON KB C C (4) TEST-THREE MODES (A)FILE INTEGRITY TEST-WRITES 4 REPETITIVE С BYTES INTO EACH FILE, EACH FILE HAVING ċ A DIFFERENT PATTERN WITH THE FILE NUMBER 0000 BEING THE BASE IN THE FIRST WRITE PASS AND ALL SUCCEEDING ODD NUMBERED WRITE PASSES THE PATTERN IS AS FOLLOWS HI BYTE OF FILE ADDRESS LO BYTE OF FILE ADDRESS С 1'S COMPLEMENT OF HI ADDRESS 1'S COMPLEMENT OF LO ADDRESS CCC ALL EVEN NUMBERED WRITE PASSES HAVE c c THE 115 COMPLEMENT OF THE ABOVE PATTERN С ALL FILES ARE FIRST WRITTEN AND THEN READ IN SUCCESSION. THE READ PROCESS IS REPEATED FOR THE DESIGNATED NUMBER OF TIMES UNLESS THE MAX NUMBER OF ERRORS SPECFIED/FILE IS EXCEEDED. THE WRITE PROCESS IS REPEATED THE SPECIFIED NUMBER OF TIMES COMPLEMENTING THE PATTERN EACH TIME (B)PATTERN TEST-TESTS EACH FILE SPECIFIED INDIVIDUALLY BEFORE PRCEEDING TO THE NEXT FILE. PATTERNS OF 10 DIFFERENT BYTE VALUES MAY BE SPECIFIED, PATTERNS ARE TO BE SPECIFIED AS DECIMAL VALUES BETWEEN THE RANGE OF -128 TO +127 THE PATTERN WILL BE WRITTEN INTO THE FILE AND READ BACK THE SPECIFIED NUMBER OF TIMES UNLESS THE MAX ERROR COUNT С PER FILE IS EXCEEDED. THE PROCESS WILL BE REPEATED FOR THE NUMBER OF WRITE PASSES С BEFORE PROCEEDING TO THE NEXT FILE. 00000000000 TEST PROGRAMS WILL PRINT THE FOLLOWING INFORMATION-FILE NUMBER WRITE PASS NUMBER READ PASS NUMBER DATA WRITTEN IN FILE DATA READ FROM FILE BOARD NUMBER IN ERROR C WORD NUMBER ERROR WAS DETECTED C (C)GENERATE PATTERN-COMBINATION OF A&B c ABOVE DOES SIX DIFFERENT VARIATIONS OF SPECIFY PATERN-C C 1-WORD0=0, WORD1=-1, ETC 2-WORD0=-1, WORD1=0, ETC. C 3-ALL WORDS=-86 C

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	4-ALL WORDS=85 5-ALL WORDS=0 5-ALL WORDS=0 5-ALL WORDS=-1 THE ABOVE TESTS EVALUATE ALL CONDITIONS OF ALTERNATING BUBBLES IN MAJOR AND MINOR LOOPS.ALL OR ABSENCE OF BUBBLES IN MAJOR AND MINOR LOOPS. PATTERNS 7&8 ARE THE TWO ADDRESS BASED PATTERNS 7&8 ARE THE TWO ADDRESS BASED PATTERNS OF THE FILE INTEGRITY TESTS. PATTERNS ARE REPEATED MOD 8 UNTIL THE SPECIFIED WRITE PASSES IS EXCEEDED
0001 0002 C	BYTE A(145), B(80), C(10), W, R, T, D, F, S, G DATA W, R, T, D, F, S, G/(W), (R', (T), (D', (F', (S') (G'/
с с	INTITIAL COMMAND DETERMINATION
0003 100	WRITE (6,800)
0004	READ(6, 801)NCNT, (B(J), J=1, NCNT)
0005 800 0006 801	FORMAT (10READ,WRITE,TEST OR DUMP 1,2,111) FORMAT (0,80A1)
0007	IF (B(1), EQ. N) GO TO300
0003	IF(B(1), EQ. R) GO TO 200
0009	IF(B(1), EQ. T) GO TO 2000
8818	IF(B(1), EQ. D) GO TO 600
0011	WRITE (6,900)
0012 900	FORMAT (' WRONG ANSWER')
0013 0014 400	GO TO 100 WRITE (6,900)
0015	WRITE(6,901)
0016	GO TO 100
0017 901 C	FORMAT (1 LIMIT ADDRESS 0-640 INCLUSIVE1, 2, 1 1)
c c	ASCII FILE READ ROUTINE
0013 200	WRITE (6,810)
0019 0020	READ (6,811)NUM IF (NUM .GE.641) GO TO 400
0020	CALL MACRED (NUM, A(1))
0022	WRITE (6, 812) (A(J), J=1, 144)
0023 810	FORMAT (1 FILE NUMBER 1774 1)
0024 811	FORMAT (15)
0025 812	FORMAT (1 1,40A1,2,1 1,40A1,2,1 1,40A1,2,1 1,40A1,2,1 1,40A1)
9026	GO TO 100
C C C	ASCII FILE WRITE ROUTINE
0027 300	WRITE (6,810)
0028	READ (6, 811)NUM
0029	IF (NUM. GE. 641) GO TO 400
0030	I=0
0031 350	WRITE (6,820)
0032	READ(6, 801)NCNT, (B(J), J=1, NCNT)
9033 0034	I1=I+NCNT IF (I1.GT.144)I1=144
0035	I2=1+I
0036	13=1
0037	DO 310 J=12, 11

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0039			A(J)=B(I3)
0039	310		13=13+1
0040			IF (I1. EQ. 144)60 T0320
0041			I=I1
0042			GO TO 350
0043	320		CALL MACWRT (NUM, A(1))
0044			GO TO 100
0045	820		FORMAT (' WRITE IN DATA'/)
	c		
	с с		ASCII FILE DUMP ROUTINE
0046	600		WRITE(6,601)
0047	601		FORMAT(BEGIN FILE NUMBER?
0043	001		READ(6, 705)NUM
0049			IF (NUM, LE. 640) GOTO 610
0050			WRITE(6,900)
0051			WRITE(6,901)
0052			GOTO 600
0053	610		WRITE(6,611)
0054	611		FORMAT(END FILE NUMBER? () ()
0055			READ(6, 705)NUMMAX
0056			IF(NUMMAX, LE. 640)GOTO 620
0057 0058			WRITE(6,900) WRITE(6,901)
0059			GOTO 610
0060	620		WRITE(6, 621)
0061	621		FORMAT('0', T10, '************************************
0062			WRITE(6, 622)NUM
0063	622		FORMAT(MBM FILE DUMP() / FILE NUMBER () 13)
0064			CALL MACRED (NUM, A(1))
0065			WRITE(6,812) (A(J), J=1,144)
0066			IF (NUM. EQ. NUMMAX) GOTO 690
0067			IF (NUM, NE. 640) GOTO 630
0063 0069	630		NUM=−1 NUM=NUM+1
8878	030		GOTO 620
0071	690		WRITE(6, 691)
0072	691		FORMAT(END OF FILE DUMP)
0073			GOTO 100
	C		
	C		PATTERN TEST STARTS HERE
	C		SET KNTRL TO 0 TO DETERMINE PATTERN AND
	c		NOT FILE INTEGRITY TEST
0074	700		KNTRL=0
0075			WRITE(6,601)
0076			READ(6, 705)NUM
0077			IF(NUM. LE. 640) G0T0707
0078			WRITE(6,900)
0079			WRITE(6,901)
0080			GOTO 700
0081	707		WRITE(6,611)
0082			READ(6, 705)NUMMAX
0083 0084			IF(NUMMAX.LE. 640)GOTO 708 WRITE(6,900)
0035			WRITE(6, 901)
0036			GOTO 707
0037	708		NUMBGN=NUM
0088	500		WRITE(6, 501)
0039	501		FORMAT(NUMBER OF PATTERNS? /////)
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/L							
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0090			READ(6, 705)NUMPAT				
0091			IF (NUMPAT. LE. 10)G	010510			
0092			WRITE(6, 503)	010010			
0093	503		FORMAT (PLEASE L	IMIT TO 10	PATTERNS	· · ·	
0094	005		GUTO 500		THIT ENGL.	·	
0095	510		K=1				
0096	513		WRITE(6, 511)K				
0097	511		FORMAT(ENTER PA	TEPN NUMPE	P / 12 / /	1	
9098	211		READ(6, 512) IPAT	ITERN NONDE	K 112/7)	'	
0099	512		FORMAT(14)				
0100			IF (IPAT. LT128)G	010 515			
0101			IF (IPAT. LE. 127)60				
0102	515		WRITE(6, 514)				
0103	514		FORMATC' LIMIT RA	NGE FROM -1	28 TO +127	11/)	
0104			GOTO 513				
0105	516		C(K)=IPAT				
0106			IF (K. EQ. NUMPAT) GO	TO 517			
0107			K=K+1				
0108			GOTO 513				
0109	517		WRITE(6, 518)				
0110	518		FORMATC MAX. NUMB	FR OF ERROR	S TO BE PRIM	NTED24.2.	1 13
0111			READ(6, 705)MAXERR				
0112			IF (MAXERR, LE. 100)	GOTO 709			
0113			WRITE(6, 706)				
0114			GOTO 517				
0115	709		WRITE(6, 704)				
0116	704		FORMATC' NUMBER O	F WRITE PAS	SES24. 1.4 4	>	
0117			READ(6, 705)NUMWRT				
0118	705		FORMAT(15)				
0119			IF (NUMWRT. LE. 100)	GOTO 710			
0120			WRITE(6, 706)				
0121	706		FORMATC PLEASE L	MIT TO 100	r >		
0122			GOTO 709				
0123	710		WRITE(6, 711)				
0124	711		FORMATC' NUMBER O	F READS PER	WRITE? . /.	17	
0125			READ(6, 705)NUMRD				
0126			IF (NUMRD. LE. 100)G	010 720			
0127			WRITE(6, 786)				
0128			GOTO 710				
0129	720		WRITE(6, 702)				
0130	782		FORMATCOWRITE	READ GOO	D BAD	BOARD	WORD()
0131			WRITE(6, 703)				
0132	703		FORMAT(PASS , T1	a, ' PASS', T1	S, 'DATA', T26	S, 'DATA')	
9133			KERRAC=0				
0134	799		KNTWRT=1				
	C						
	C		COMMON ROUTINES F	DR PATTERN	AND FILE FOL	LOW	
	C		REQUIRED INFORMAT	ION SET UP	BY FILE TEST	r	
	c		ROUTINE TO CONTROL	- FOLLOWING	ROUTINES		
	C		KNTRL=0 FOR PATTE	RN TEST			
	С		=-1 FOR F	ILE TEST WR	ITE		
	С		=+1 FOR F	ILE TEST RE	AD		
	С						
0135	714		K=1				
0136	715		DO 721 J=1, 144, 1				
0137			A(J)=C(K)				
0133			IF(K. LT. NUMPAT)GO	ro 721			
0139			K=0				
0140	721		K=K+1				
0141			KNTERR=0				

*N/L		
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0142		IF(NUMWRT.EQ.0) GOTO 1000
0143		CALL MACWRT(NUM, A(1))
0144	1000	KNTRD=1
0145	1001	IF(NUMRD. EQ. 0) GOTO 770
0146	730	CALL MACRED(NUM, A(1))
0147		NUMWRD=0
0148		J=1
0149		K=1
0150	738	IF(A(J), EQ. C(K))GOTO 735
0151		IF(A(J), GT. C(K))GOTO 731
0152 0153		MDIFF=C(K)-A(J) GOTO 732
0154	731	MDIFF=A(J)-C(K)
0155	732	NUMBRD=0
0156	733	MDIFF=MDIFF/2
0157		IF (MDIFF) 734, 736, 734
0158	734	NUMBRD=NUMBRD+1
0159		GOTO 733
0160	736	IF (KNTERR) 3810, 3820, 3810
0161	3820	WRITE(6, 701)NUM
0162	701	FORMAT(' FILE NUMBER (,13)
0163	3810	WRITE(6,739)KNTWRT, KNTRD, C(K), A(J), NUMBRD, NUMWRD
0164	739	FORMAT(1 1, 14, T10, 14, T18, 14, T26, 14, T34, 13, T42, 14)
0165		KNTERR=KNTERR+1
0166		IF (KNTERR, NE. 10)GOTO 540
0167		IF(KNTERR-NUMWRD+1) 535, 729, 535
0163	729	WRITE(6,531)KNTWRT
0169	531	FORMAT(1 1, I4, T10, 1****APPARENT FATAL WRITE ERROR****1)
0170	ese	GOTO 745 IF(KNTERR. NE. KNTRD) GOTO 540
0171 0172	535	WRITE(6, 536)NUMBRD, NUMWRD
8173	536	FORMAT(/ WRITE FAILURE-BOARD //I3///WORD //I3)
0174	550	GOTO 745
0175	540	IF (KNTERR, LT. MAXERR) GOTO 735
0176		WRITE(6, 541)KNTWRT, MAXERR
0177	541	FORMAT(' ', I4, T10, '****MAX, NUMBER OF ERRORS(', I3, ')****')
0178		GOTO 745
0179	735	IF(NUMWRD.EQ. 143)GOTO 785
0130		NUMWRD=NUMWRD+1
0131		J=J+1
0182		K=K+1
0183		IF(K. LE. NUMPAT)GOTO 738
0134 0185		K=1 GOTO 738
0185	785	IF(KNTRD, GE, NUMRD)GOTO 751
0187	100	KNTRD=KNTRD+1
0188		GOTO 730
0189	751	IF (KNTERR)740,745,740
0190	741	WRITE(6, 742)KNTWRT
0191	742	FORMAT(1 1, 14, T10, 1*****NO ERRORS****1)
0192		GOTO 745
0193	740	WRITE(6,743)KNTERR
0194	743	FORMAT(1 TOTAL ERRORS 1, 15)
0195	745	KERRAC=KERRAC+KNTERR
0196		IF(NUMWRT, EQ. 0) GOTO770
0197		IF(KNTWRT. GE. NUMWRT)GOTO 770
0198		KNTWRT=KNTWRT+1 GOTO 714
0199 0200	770	IF(NUM. EQ. NUMMAX) GOTO 760
0200		IF(NUM, LT, 640)GOTO 777

*N/L		
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0202		NUM=-1
0203	777	NUM=NUM+1
0204		IF (KNTRLØ. EQ. Ø)GOTO799
0205		GOTO 714
0206	760	IF (KNTRL) 3200, 762, 3600
0207	762	IF (KNTRLO, NE. 0) GOTO 9000
0201	C	I Charles he of Goro Soco
	č	EXIT HERE IF FILE TEST
		EATI HERE IF FILE IESI
	С	
0208		WRITE(6,780)KERRAC
0209	780	FORMAT(' ACCUMULATED ERRORS=', I5)
0210		WRITE(6,761)NUMBGN, NUMMAX
0211	761	FORMAT(' END OF TEST ON FILES (13, ' THRU (13)
0212		GO TO 100
	С	
	С	INITIAL DETERMINATION OF TEST TYPE
	С	
0213	2000	WRITE(6,2001)
0214	2001	FORMAT(TYPE OF TEST-FILE INTEGRITY,
	25	PECIFY PATTERN OR GENERATE PATTERN? (1/1/1)
0215		READ(6, 801)NONT, (B(J), J=1, NONT)
0216		KNTRL0=0
0217		IF(B(1), EQ. 5)GOTO 700
9218		IF(B(1), EQ. F)G0T02010
0219		IF(B(1), EQ, G)GOTO 2009
0220		WRITE(6, 900)
0221		GOTO 2000
0222	2009	KNTRL0=1
9222	C 2003	NAIREO-1
	č	DETERMINE PARAMETERS OF FILE INTEGRITY TEST
	č	DETERMINE PARAMETERS OF FILE INTEGRITY TEST
0223	2010	WRITE(6,518)
	2010	
0224		READ(6,705)MAXERR
0225		WRITE(6,704)
0226		READ(6, 705)NUMFWT
0227		WRITE(6,711)
0228		READ(6,705)NUMFRD
0229		IF(KNTRL0, NE. 0) GOTO 5000
0230	3002	WRITE(6,3001)
0231	3001	FORMAT(' MBM FILE INTEGRITY TEST')
	C	
	С	SET INITIAL CONDITIONS FOR TEST
	C	
0232		KNTFWT=1
0233	3005	KNTERF=0
0234		KNTRLP=0
0235		KNTWRT=1
0236		IF (NUMFWT, EQ. 0)GOTO 3500
0237	3220	KNTRL=-1
0238		NUM=0
0239		NUMWRT=1
9249		NUMRD=0
0241	3300	NUMMAX=NUM
0242	3300	NUMPAT=4
0242	с	NONENT -4
	c	DETERMINE PATTERN VALUES
	č	VETENITAE FRITENN VILVES
0243	0	NUML O-NUM
0243		NUMLO=NUM NUMHI=NUMLO/256
0245		NUMLO=NUMLO-NUMHI*256
0240		NONEO-NONEO-NONET*200

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8246		IF (KNTRLP. EQ. 0)GOTO 331	R			
0247		C(1)=-1-NUMHI				
0248		C(2)=-1-NUMLO				
0249		C(3)=NUMHI				
0250		C(4)=NUMLO				
0251		GOTO 3320				
0252	3310	C(1)=NUMHI				
0253	3310	C(2)=NUMLO				
0254		C(3)=-1-NUMHI				
0255		C(4)=-1-NUMLO				
0256	3320	IF(KNTRL)714, 714, 1001				
0200	C	1 (KRIIKE/114)/14, 1001				
	č	RETURN HERE FROM WRITE	PROCES	5		
	č	Reform here their here	. NOCE-	-		
0257	3200	IF (NUM. EQ. 640)GOTO 3500				
0258		NUM=NUM+1				
0259		GOTO 3300				
0260	3500	IF (NUMFRD. EQ. 0)GOTO 410	ю			
0261		WRITE(6,702)				
0262		WRITE(6, 703)				
0263		KNTFRD=1				
0264		KNTRD=1				
0265	3550	NUMWRT=0				
0266		NUMRD=1				
0267		NUM=0				
0268		KNTRL=1				
0269		KERRFF=0				
0270		GOTO 3300				
	С					
	С	RETURN HERE FROM READ P	ROCESS			
	С					
0271	3600	KNTERF=KNTERF+KNTERR				
0272		IF (KNTERR. EQ. 0)GOT03601				
0273		KERRFF=1				
0274	3601	IF(NUM. EQ. 640) GOTO 400				
0275		IF (KNTERR. EQ. MAXERR) GOT	0 4100			
0276		KNTERR=0				
0277		NUM=NUM+1				
0278		GOTO 3300				
0279	4000	IF (KERRFF. NE. 0)GOTO 401				
0280		WRITE(6, 4011)KNTFWT, KNT				
0281 0282	4011	FORMAT(1, 14, 110, 14, 11			*)	
0282	4010	IF(KNTFRD. EQ. NUMFRD) GO	10 416	10		
0283		KNTFRD=KNTFRD+1 KNTRD=KNTFRD				
0285		GOTO 3550				
0285 0286	4100	IF (KNTFWT, EQ. NUMFWT) GOT	0 4000			
0200	4100	IF (KNTRLP. EQ. 0)GOTO 412				
0288		KNTRLP=-1	e			
0289	4120	KNTRLP=KNTRLP+1				
0290	4120	KNTFWT=KNTFWT+1				
0291		KNTWRT=KNTFWT				
0292		GOTO 3220				
0293	4200	WRITE(6, 780)KNTERF				
0294		IF (KNTRLO, NE. 0) GOT09900				
0295		WRITE(6, 4201)				
0296	4281	FORMAT (END OF MEM FIL	E INTE	GRITY TEST	>	
0297		GOTO 100				
	с					
	c	GENERATE PATTERN ROUTIN	E STAR	TS HERE		
			-			

*N/L		
FORTRAN	V09. 02	09:08:36 04-AUG-77 PAGE 8
	c c	SET UP PARAMETERS FOR COMMON ROUTINES
0298	5000	NUMGWT=NUMFWT
0299		NUMFWT=2
0300		KNTERG=0
0301		KNTGWT=1
0302	5001	WRITE(6,702)
0303		WRITE(6,703)
0304		C(1)=0
0305		C(2)=-1
0306		GOTO 6000
0307	5002	C(1)=-1
0308		C(2)=0
0309		GOTO 6000
0310	5003	C(1)=-86
0311		C(2)=-86
0312	,	GOTO 6000
0313	5004	C(1)=85
0314		C(2)=85
0315		GOTO 6000
0316	5005	C(1)=0
0317		C(2)=0
9318		GOTO 6000
0319	5006	C(1) = -1
0320		C(2)=-1
0321	6000	NUMPAT=2
0322 0323		KERRAC=0
0323		KNTRL=0
0325		NUM=0 NUMMAX=640
0326		NUMRD=NUMFRD
0327		KNTWRT=KNTGWT
0328		NUMWRT=KNTWRT
0329		WRITE(6, 6001)KNTRL0
0330	6001	FORMAT(PATTERN NUMBER (, 11)
0331		WRITE(6,6002)C(1),C(2)
0332	6002	FORMAT(' WORD0=', 14, ', WORD1=', 14, ', ETC. ')
0333		GOTO 714
	С	
	С	RETURN HERE FROM COMMON PATTERN ROUTINE
	С	
0334	9000	IF (KERRAC. NE. 0)GOT09005
0335		WRITE(6,742)KNTGWT
0336		GOTO 9001
8337	9005	WRITE(6,780)KERRAC
0338		KNTERG=KNTERG+KERRAC
0339	9001	IF (NUMGWT. EQ. KNTGWT)GOTO 8000
0340		KNTGWT=KNTGWT+1
0341		KNTRLO=KNTRLO+1
0342 0343	5007	GOTO(5001, 5002, 5003, 5004, 5005, 5006, 5007)KNTRL0 KNTFWT=KNTGWT
0344	2007	NUMFWT=KNTFWT+1
0345		WRITE(6, 3001)
0346		GOTO 3005
0540	с	
	č	RETURN HERE FROM FILE INTEGRITY TEST
	č	ALTONY HERE FROM FILE INTEGRITT TEST
0347	9900	KNTERG=KNTERG+KNTERF
0348		KNTGWT=KNTGWT+1
0349		KNTRL0=0

*N/L

W311 000 FORTRAN			-
FURIKHN	V09. 02	09:08:36 04-AUG-77 PAGE	9
0350		GOTO 9001	
0351	3000	WRITE(6,8001)KNTERG	
0352	8001	FORMAT(TOTAL ACCUMULATED ERROR= 1,15)	
0353		WRITE(6,8011)	
0354	8011	FORMAT(' END OF GENERATE PATTERN TEST)	
0355		GOTO 100	
0356		END	
	POUTTNE	S COLLED.	

MACRED, MACWRT

OPTIONS =/OP:1

BLOCK LENGTH MAIN. 3873 (017102)*

**COMPILER	CC	IRE++
PHASE	USED	FREE
DECLARATIVES	00783	02280
EXECUTABLES	01183	01880
ASSEMBLY	02750	05020

APPENDIX V MBM SUBROUTINES, MACRO KB: <MBM1. LST

MBM SUBROUTINES MACRO V06-04A 07-JUL-77 15:09 PAGE 1

1 23 TITLE MBM SUBROUTINES 4 5 GLOBL MACWRT, MACRED 6 SUBROUTINE TO WRITE 144. BYTES INTO MBM MASKW=011000 ;WRITE MASK FOR UPPER ADDRESS BITS 7 з 011000 9 000000 012767 MACWRT: MOV #MASKW, MASK1 011000 000210 10 00006 004467 JSR R4, ADDXMT 000122 11 00012 012701 MOV COUNT FOR FIRST 60 BYTES #60. , R1 000074 12 00016 032737 LOOP3: #1000, @#167774 ; TEST READY TO RECIEVE DATA BIT 001000 167774 13 00024 001774 BEQ LOOP3 14 00026 112037 LOOP4: MOVE (R0)+,0#167772 ; MOVE A BYTE 167772 15 00032 005301 DEC R1 16 00034 001374 LOOP4 ENE 17 00036 012701 #84. , R1 COUNT REST OF DATA MOY 000124 18 00042 032737 LOOP5: #200, @#167770 ; TEST FOR FIFO FULL BIT 000200 167770 19 00050 001374 BNE LOOPS (R0)+/@#167772 //NOT FULL MOVE BYTE 20 00052 112037 MOVB 167772 21 00056 005301 R1 DEC 22 00060 001370 BNE LOOPS 23 00062 000205 RTS R5 24 SUBROUTINE TO READ 144. BYTES FROM MBM 25 26 010400 MASKR=010400 READ MASK 27 00064 012767 MACRED: MOV #MASKR, MASK1 010400 000124 28 00072 004467 **JSR** R4, ADDXMT 000036 29 00076 012701 MOV #144. , R1 BYTE COUNT 000220 30 00102 032737 LOOP6: #1000, @#167774 ; TEST FOR READY BIT 001000 167774 31 00110 001774 BEQ LOOPE 32 00112 032737 LOOP7: BIT #100000, @#167770 100000 167770 33 00120 001374 BNE LOOP7 34 00122 113720 MOVE @#167774, (R0)+ ;GET A BYTE 167774 35 00126 005301 DEC R1 36 00130 001370 ENE LOOP7 37 00132 000205 P.TS R5 FINISHED

MBM SUBROUTINES MACRO V06-04A 07-JUL-77 15:09 PAGE 1-1

38 39		020000	; SUBROU	TINE TO MASK2=0	SEND 2 PARTS OF 020000	ADDRES	55(10BITS)	
			ADDXMT :	MOV	02(R5), R0	GET	ADDERSS 0	
		000002						
41	00140	012702		MOV	#8. 7 R2	SHIP	FT COUNT	
		000010						
		010001		MOV	RØ, R1			
		006201	L00P1:	ASR	R1			
		005302		DEC	R2			
45	00152	001375		ENE	LOOP1			
46	00154	066701		ADD	MASK1, R1			
		000036						
47	00160	010137		MOV	R1,0#167772			
		167772						
48	00164	042700		BIC	#177400,R0			
		177400						
49	00170	062700		ADD	#MASK2, RØ			
		020000						
50	00174	032737	L00P2:	BIT	#400,0#167774			
		000400						
		167774						
51	00202	001774		BEQ	LOOP2			
52	00204	010037		MOV	RØ, @#167772			
		167772						
53	00210	016500		MOV	4(R5), RØ	GET	ADDRESS O	F DATA
		000004						
		000204		RTS	R4			
55	00216	000000	MASK1:	WORD	0			
MBI	1 SUBRI	DUTINES	MACRO VI	06-04A (87-JUL-77 15:09	PAGE 2		
1		000001		END				

MBM SUBROUTINES MACRO V06-04A 07-JUL-77 15:09 PAGE 2-1 SYMBOL TABLE

ADD	XMT	000134R		L00P1		000146R	LOOP2	000174R	
LOO	P3	000016R		LOOP4		000026R	LOOPS	000042R	
L00	P6	000102R		LOOP7		000112R	MACRED	000064RG	
MAC	WRT	000000RG		MASKR	=	010400	MASKW =	011000	
MAS	K1	000216R		MASK2	=	020000			
A	BS.	000000	000						
		000220	001						
ERR	ORS	DETECTED	0						
FRE	E CI	DRE: 4712.	WORDS						
MBM	1, M	BM1 (MBM1, EN	D						

.

KB: <MBMV08. MAP

 MAP OF MBNV08 LDA AT 09:13 ON 05-AUG-77 BY LINK V03-03A

 *** ROOT SEG: MAIN.

 R/W MEM LIMITS: 043036 077457 034422

 IDENTIFICATION : 02

 PRG XFR ADDRESS: 043036

 PROGRAM SECTION ALLOCATION SYNOPSIS:

 (. BLK.): 043036 077457 034422

 C. ABS.): 000000 000000

 *** TITLE: MAIN.

 FILE: MEMV08.0BJ

 (. BLK.): 043036-R

 *** TITLE: MBM

 FILE: MEM1 . UBJ

 (. BLK.): 062140 062357 000220

 MACRED 062224-R

 MAX VIRTUAL ADDRESS 011053, V.M. BLOCKS USED 000000

.

APPENDIX VI PROGRAM EXAMPLES

```
EXAMPLES OF ASCII WRITE AND READ ROUTINES
RU MBMV08
READ, WRITE, TEST OR DUMP
4
FILE NUMBER
10
WRITE IN DATA
1234567890123456789012345678901234567890123456789012345678901234567890
WRITE IN DATA
12345678901234567890123456789012345678901234567890
WRITE IN DATA
123456789012345678901234567890
READ, WRITE, TEST OR DUMP
R
FILE NUMBER
10
1234567890123456789012345678901234567890
1234567890123456789012345678901234567890
1234567890123456789012345678901234567890
123456789012345678901234
READ, WRITE, TEST OR DUMP
D
BEGIN FILE NUMBER?
19
END FILE NUMBER?
11
       *****
MBM FILE DUMP
FILE NUMBER 10
1234567890123456789012345678901234567890
1234567890123456789012345678901234567890
1234567890123456789012345678901234567890
123456789012345678901234
       *****
MBM FILE DUMP
END OF FILE DUMP
```

READ, WRITE, TEST OR DUMP

```
EXAMPLE OF THE SPECIFY PATTERN TEST
5
WRONG ANSWER
READ, WRITE, TEST OR DUMP
Т
TYPE OF TEST-FILE INTEGRITY, SPECIFY PATTERN OR GENERATE PATTERN?
S
BEGIN FILE NUMBER?
0
END FILE NUMBER?
25
NUMBER OF PATTERNS?
2
ENTER PATTERN NUMBER 1
Ø
ENTER PATTERN NUMBER 2
-1
MAX. NUMBER OF ERRORS TO BE PRINTED?
3
NUMBER OF WRITE PASSES?
1
NUMBER OF READS PER WRITE?
5
WRITE READ GOOD BAD BC
PASS PASS DATA DATA
ACCUMULATED ERRORS= 0
END OF TEST ON FILES 0 THRU 25
                                 BOARD WORD
READ, WRITE, TEST OR DUMP
TYPE OF TEST-FILE INTEGRITY, SPECIFY PATTERN OR GENERATE PATTERN?
S
BEGIN FILE NUMBER?
10
END FILE NUMBER?
11
NUMBER OF PATTERNS?
3
ENTER PATTERN NUMBER 1
1
ENTER PATTERN NUMBER 2
-3
ENTER PATTERN NUMBER 3
4
ENTER PATTERN NUMBER 4
-9
```

```
ENTER PATTERN NUMBER 5
16
ENTER PATTERN NUMBER 6
-33
ENTER PATTERN NUMBER 7
64
ENTER PATTERN NUMBER 8
-128
MAX. NUMBER OF ERRORS TO BE PRINTED?
10
NUMBER OF WRITE PASSES?
0
NUMBER OF READS PER WRITE?
1
HRITE READ GOOD
PASS PASS DATA
FILE NUMBER 10
1 1 1
                         BAD
                                 BOARD WORD
                         DATA
                         ø
                                 0
```

1	1	-3	-1	1	1
1	1	4	0	2	2
1	1	-9	-1	3	3
1	1	16	0	4	4
1	1	-33	-1	5	5
1	1	64	0	6	6
1	1	-128	-1	6	7
1	1	1	. 0	0	8
1	1	-3	-1	1	9
1	****MAX	NUMBER	OF ERRORS(10)****	
FILE	NUMBER 11				
1	1	1	0	0	0
1	1	-3	-1	1	1
1	1	4	0	2	2
1	1	-9	-1	3	3
1	1	16	0	4	4
1	1	-33	-1	5	5
1	1	64	0	6	6
1	1	-128	-1	6	7
1	1	1	0	0	8
1	1	-3	-1	1	9
1	****MAX	NUMBER	OF ERRORS(10)****	
ACCU			20		
END	OF TEST ON	FILES 1	O THRU 11		

READ, WRITE, TEST OR DUMP

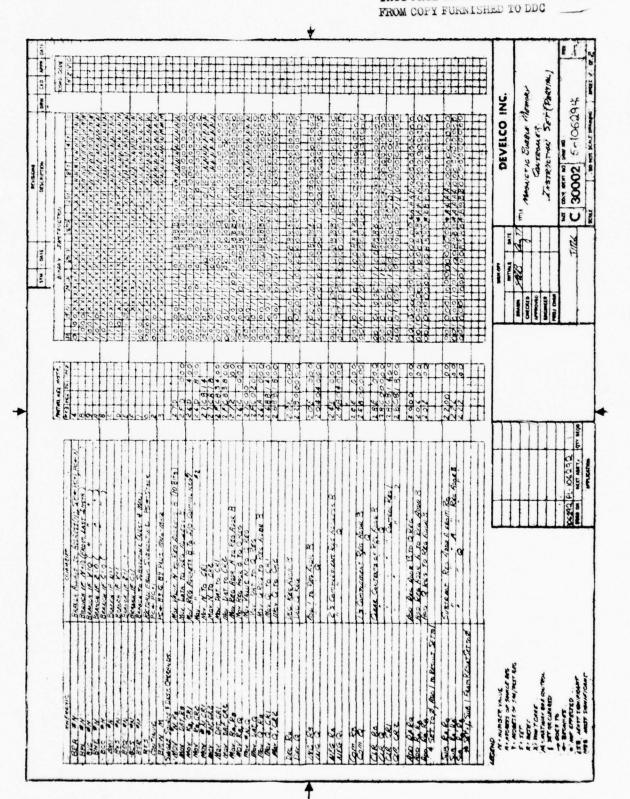
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```
EXAMPLE OF GENERATE PATTERN TEST
T
TYPE OF TEST-FILE INTEGRITY, SPECIFY PATTERN OR GENERATE PATTERN?
G
MAX. NUMBER OF ERRORS TO BE PRINTED?
NUMBER OF WRITE PASSES?
9
NUMBER OF READS PER WRITE?
1
               GOOD
DATA
WRITE READ
                            BAD
                                     BOARD
                                              WORD
PASS
        PASS
                           DATA
PATTERN NUMBER 1
WORDØ= 0,WORD1= -1,ETC.
FILE NUMBER 488
                          -2
            1 -1
RS 1
                                       ø
                                                47
   1
TOTAL ERRORS
ACCUMULATED ERRORS=
                          1
PATTERN NUMBER 2
WORD0= -1, WORD1= 0, ETC.
2 *****NO ERRORS****
PATTERN NUMBER 3
WORDØ= -86, WORD1= -86, ETC.
3 *****NO ERRORS****
PATTERN NUMBER 4
WORDØ= 85,WORD1= 85,ETC.
4 *****NO ERRORS****
PATTERN NUMBER 5
WORDØ= Ø,WORD1= Ø,ETC.
5 *****NO ERRORS****
PATTERN NUMBER 6
WORDØ= -1, WORD1= -1, ETC.
6 *****NO ERRORS****
MBM FILE INTEGRITY TEST
                  GOOD BAD
DATA DATA
WRITE READ
                                     BOARD
                                              WORD
PASS PHES
FILE NUMBER 281
1 25
PASS
         PASS
                            17
                                     3
                                               109
                1
TOTAL ERRORS
WRITE
         READ
                  GOOD
                            BAD
                                     BOARD
                                              WORD
PASS PASS
                           DATA
                  DATA
                  ***NO ERRORS***
          1
  3
ACCUMULATED ERRORS=
                          1
WRITE
         READ
                  GOOD
                         DATA
                           BAD
                                    BOARD
                                              MORD
PASS PHSS UNTERN NUMBER 1
WORDØ= Ø,WORD1= -1,ETC.
9 *****NO ERRORS****
        PASS
PASS
                  DATA
TOTAL ACCUMULATED ERROR=
                                2
END OF GENERATE PATTERN TEST
READ, WRITE, TEST OR DUMP
```

EXAMPLE OF FILE INTEGRITY TEST т TYPE OF TEST-FILE INTEGRITY, SPECIFY PATTERN OR GENERATE PATTERN? F MAX. NUMBER OF ERRORS TO BE PRINTED? 3 NUMBER OF WRITE PASSES? 2 NUMBER OF READS PER WRITE? 2 MBM FILE INTEGRITY TEST GOOD BAD DATA DATA ***NO ERRORS*** ***NO ERRORS*** WRITE READ BOARD WORD PASS 1 PASS $\begin{array}{ccc} 1 & 1 \\ 1 & 2 \end{array}$ WRITE READ GOOD BAD BOARD PASS PASS DATA DATA 2 1 ***NO ERRORS*** 2 2 ***NO ERRORS*** ACCUMULATED ERRORS= 0 END OF MBM FILE INTEGRITY TEST WORD READ, WRITE, TEST OR DUMP

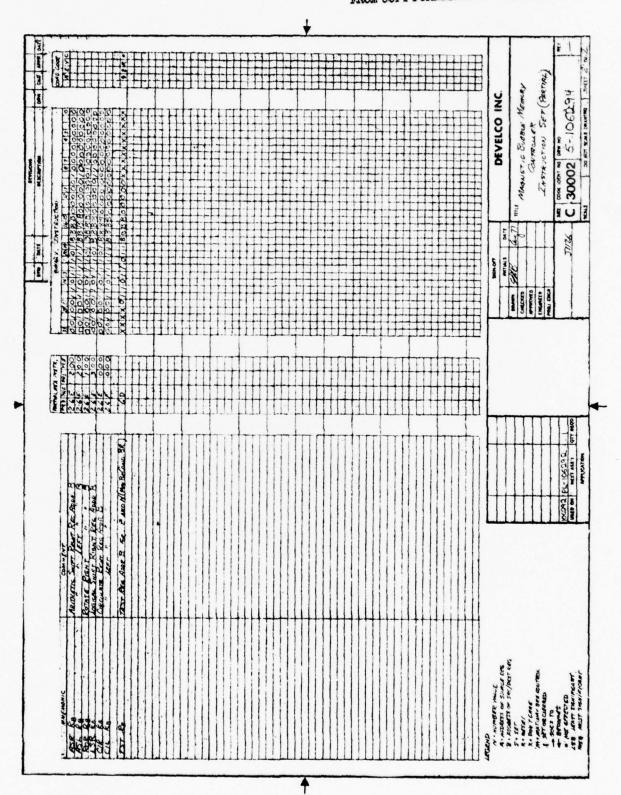
APPENDIX VII

MBM CONTROLLER INSTRUCTION SET (PARTIAL)



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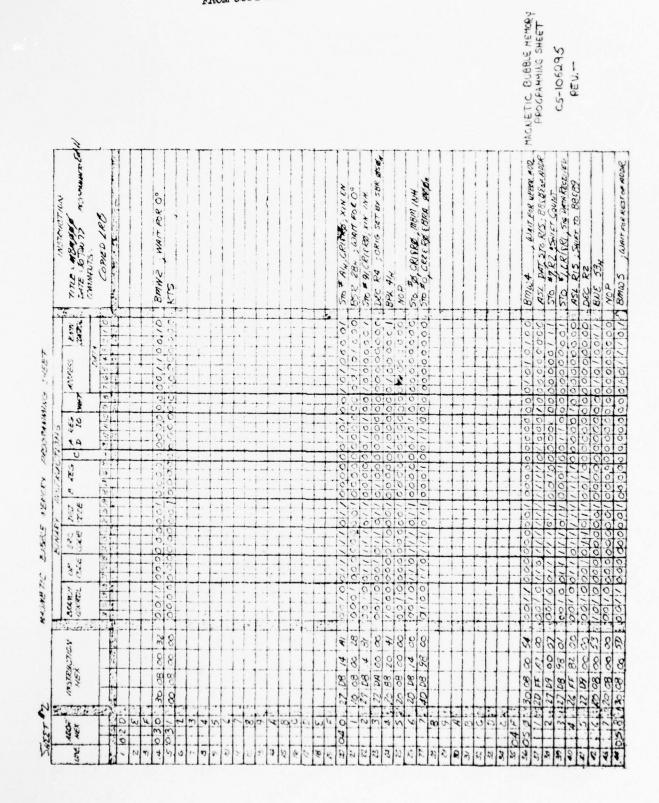


APPENDIX VIII MAGNETIC BUBBLE MEMORY PROGRAM

135

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	<i>H</i>					: 1	TH FR	IS OM	PA CO	.GE IPY	F	s e ur	SES NI	SH	QU	IAL	II D C	נ צי סספ	PR.	AC	TI	CA	BI	E						MAGNETIC BUBBLE MEMORY	PROGRAMMING SHEET	C5-106245	Key		
11.11.E . MON 000	CONNENTS:	GPED UND	CLR RD, BIIWE	(LR RI, BRA DOBA (WETC)	CLR RI, BRA PRONEMO)			BSR SZN	STO #424, ORCANU WRTEN, GOT ADDR		570 # 54, E2 , SHET CNT: 228.		0		570 #99, RI, ADOGENEN	~	914.	DEC P2	BYE		STO # 91, CRISTER ; ANN INH.	BSP 284 , WAIT FORO.	DEC 22	184 - 2	BKN 40N , STE BUBBLES							RAWI WALFORD	10	1 1	
OF SEL ET 2 ES A RES ARES	DE CTRE C D IN MA	2 1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	110/10000010100000000000000000000000000	1011000100011001	101100010011000100000			0000/00/0000000000000000000000000000000	000110010001011011	00100100101010000011011	0070077700000000000000770			10/1/00/0000000000001001	1/0000011	1000000000000000000	00/00/0/000000/		00/000000000000000000000000000000000000	1,100100000000000001	1/100000101000000	000000000000000000000000000000000000000	11001000000000000000	00/100000000000000000000000000000000000	000000000000000000000000000000000000000							000000000000000000000000000000000000000	000010000000000000000000000000000000000		
ADDE ADDENCHON	Part - mar - march		1 10 00 38 08 14 001 001	2 2 2 2 2 49 28 98 08 08 01 00	4 004 148 28 28 80 31 001 00			5 0 08 10 08 00 50 00 01	\$ 49 127 08 58 42 10010	00100146 14 127 26 14 91 - 00010	1 0018 27 09 00 24 1001 01011	000 00 00 00 00 00 00 00 00 00 00 00 00	200 00 00 00 10 10 10	50011-27 05 CO 20 0010	0100 16 1/ 20 12 01.0.	011 110 08 00 28 : 10 001	2 01 12 12 198 14 81 001 0	2 0 1 3 1/0 08 CC 28 0000 0000000	101.5 00 00 00 11 1010	20100 31 02 02 10	50171.12 D8 × 81 0010	\$ 0.1 8 \$110 08 00 28 00 01	0100 00.00 51 2 510	0 101 81 00 80 2V 8 10 V	00/0 00 00 20 20 00 00	 3	1 × 1/2	2020	-	-	12 1 2 2 1		0000000 01 00 000000	1111	 1 3 4

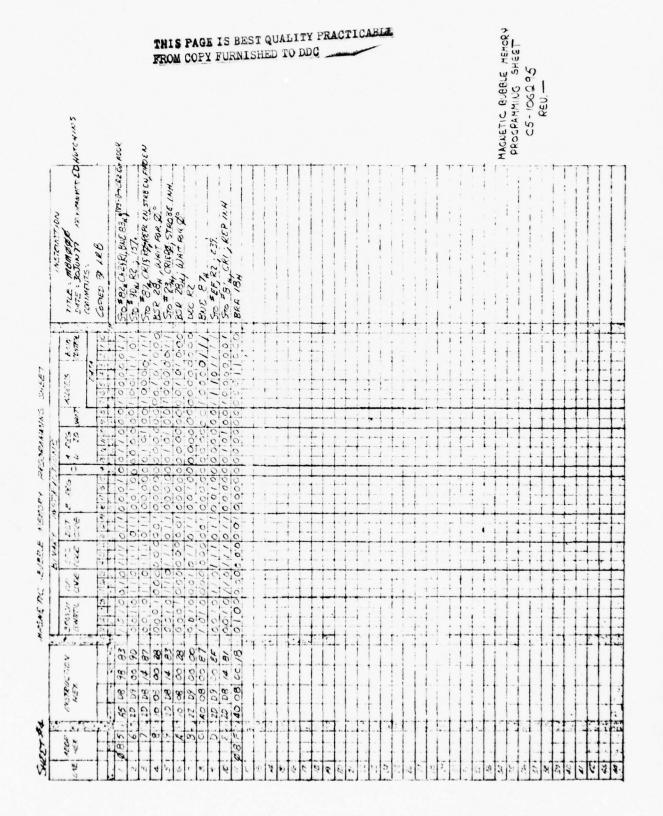


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Mark Josen Josen <thj< th=""><th>1 our</th><th>Inc Purch</th><th></th><th></th><th>1</th><th>-</th><th>*</th><th>101</th><th>SILCH</th><th></th><th>1</th><th></th><th>INSTERION</th><th></th></thj<>	1 our	Inc Purch			1	-	*	101	SILCH		1		INSTERION																																																																																																																																																																																																																																																																																																																												
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1 1	Ħ		11	5 2 2 N	2 100	2	2 5 5	116 3	2		.9	0172	0																																																																																																																																																																																																																																																																																																																												
(1) (2) (× 1	20 DF 20	18	01.00	0/1	1110	1	0011	0001	10	000	0000	2																																																																																																																																																																																																																																																																																																																												
B) (B) (B		20 40 02	18	00100	110	1110	110	1000	0000	1	0000	1000	+-																																																																																																																																																																																																																																																																																																																												
0 18: 33/16 1: 7: 7: 70: 50: 50: 50: 50: 50: 50: 50: 50: 50: 5	Ł .	20 55 38	.00	0/00	000	100	111	11/10	1110	10	0000	0000	-																																																																																																																																																																																																																																																																																																																												
B B <td></td> <td>0:08:00</td> <td>19</td> <td>0111</td> <td>000</td> <td>0000</td> <td>010</td> <td>0000</td> <td>00,00</td> <td>10</td> <td>00.11</td> <td>1.000</td> <td>1 .</td> <td></td>		0:08:00	19	0111	000	0000	010	0000	00,00	10	00.11	1.000	1 .																																																																																																																																																																																																																																																																																																																												
(1) (3) <td></td> <td>\$1 BG 02</td> <td>1 -</td> <td>0100</td> <td>0.1.1</td> <td>1110</td> <td>011.</td> <td>0000</td> <td>1019</td> <td>10</td> <td>0000</td> <td>0</td> <td>STO "I, CRISKO: MEN EN</td> <td></td>		\$1 BG 02	1 -	0100	0.1.1	1110	011.	0000	1019	10	0000	0	STO "I, CRISKO: MEN EN																																																																																																																																																																																																																																																																																																																												
Product	ω	10:08:00	182	1000	0000	000			00100	0000	010	000	356 264 : WAIT FOR 2																																																																																																																																																																																																																																																																																																																												
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APPENDIX IX

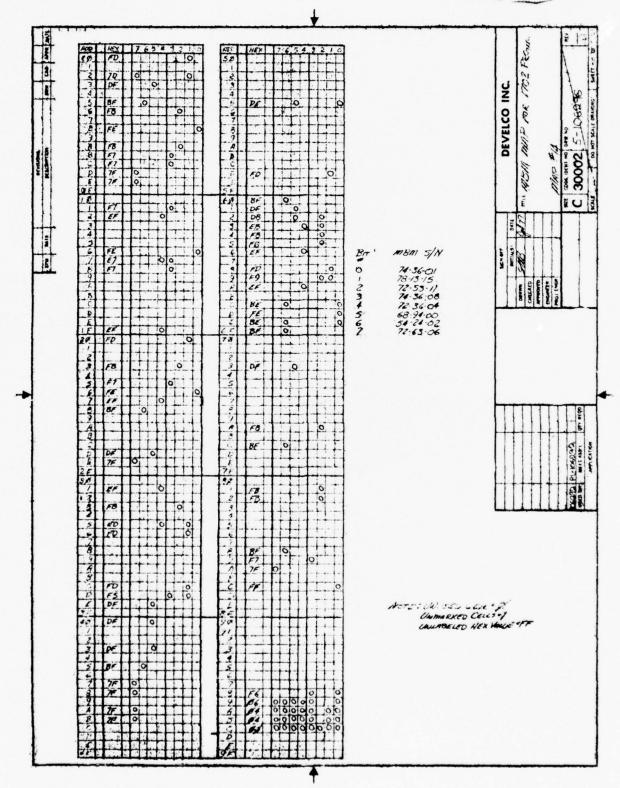
EXAMPLE OF TEXAS INSTRUMENTS MBM TEST DATA

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APPENDIX X MBM MAP FOR 1702 PROM

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APPENDIX XI PROM CODE FOR FUNCTION TIMING GENERATOR

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	£	08	08 08	08	08	OA	08	10	08	08	08	08	08	08	08	08	
	A	00	00	04	10	88	20	25	05	10	08	,20	24	04	00	00	CIMAL
ALOK	6	08	08 08	08	08	08	08	10	00	08	08	08	08	08	08	08	HEXADECIMAL
FUNCTION TIMING GENERATOR	ø	00	00	04	10	88	28	21	05	10	08	28	20	04	00	00	A IN F
IMING	~	08	08 08	98	08	08	OA	00	00	08	08	08	08	08	08	08	PROM DATA IN
CTION	9	00	000	04	10	08	28	21	05	10	08	28	20	04	8	8	Hd
FUN	Ś	08	08 08	08	08	08	0A	08	00	08	08	08	08	08	08	80	
	4	00	88	04	10	18	88	21	05	10	18	08	20	04	8	8	
	e	08	08 08	08	08	60	V0	08	1C	08	08	08	08	08	08	08	
	5	00	000	04	10	18	88	21	05	11	18	08	20	04	00	00	
	-	08	08 08	08	08	08	0A	08	10	08	08	08	08	08	08	08	
	0	-07	88	04	14	10	C8	21	05	15	12	08	20	04	04	8	
		00	10 20	30	40	50	60	70	80	06	CV	BO	00	DQ	EO	FO	(ASM)

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74S471 PROM CODE FOR FUNCTION TIMING GENERATOR

ÁDDRESS (LSB) APPENDIX XII

TEST REPORT MEMOS TO TEXAS INSTRUMENTS

RD7/1126-M286 16 August 1977

MEMO TO:	Gerald Cox Texas Instruments	cc:	J1126 C.A. Snyder T.C. Moore	
FROM:	Larry Bulduc, Develco		I.L. Moore	
SUBJECT:	Magnetic Bubble Memories			

Under a separate cover, (9) TBM0101 memories - 8 of which are on boards - are being returned to you for reevaluation.

Our test consists of 8 patterns each of which is repeated every 8 write cycles. The pattern values consist of 1 or 2 8 bit words which are repeated in a file (8 bit wide system).

The patterns are as follows:

Pattern	Word Ø	Word 1	Reason
1	ØØØØØØØØ	1111111	Test for Alternate minor loop
			interference
2	ווווווו	<i>øøøøøøø</i>	Complement of Pattern 1
3	10101010	10101010	System noise test
4	01010101	01010101	Complement of Pattern 3
5	00000000	00000000	To discriminate between system
			noise and effects of entire
			bubble in 1 state
6	1111111	1111111	Complement of Pattern 5

The above 6 patterns are written and verified a number of times into each file individually (e.g.; file numbers > the test file contain the last test pattern).

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Patterns 7 and 8 are for testing file integrity.

Pattern 7 writes 4 bytes (to the 8 wide memory) which are repeated for the 144 bytes/file.

The four bytes are file address based

Word 0 - High byte of Address
Word 1 - Low byte of Address
Word 2 - 1's complement of Word Ø
Word 3 - 1's complement of Word 1

Pattern 8 is the complement of Pattern 7 (e.g.; Word $\emptyset \leftarrow$ Word 2, Word 1 \leftarrow Word 3, Word 2 \leftarrow Word 0 and Word 3 \leftarrow Word 1).

In patterns 7 and 8 the entire memory is written first. Then each file is read 1 time in succession. The entire memory is read a specified number of times.

On August 5 - August 7 a test was conducted writing into the entire memory 610 times and reading the entire memory six times for every write. This would test each pattern approximately 78 times.

The number of bits read calculates to be

3.4 x 10[°]/board 2.7 x 10[°]/system.

or

A total of 112 errors were recorded on 5 of the 8 boards. This does not include successive errors of the same bit on the same write cycle but only the first occurrence.

Overall analysis of the test is shown in Table 1.

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Repetitive errors occurred at the following word numbers (0-143)

TBM S/N	Word #	# Frequency
72-63-06	11	10
54-24-04	32	2
54-24-04	96	2
54-24-04	116	2
54-24-04	124	2
78-13-15	97	2
78-13-15	69	2

It is believed that the reoccurring Word errors on boards 4 and 5 are within normal probabilities for the number of failures. However it is also believed that Word 11 on Board 5 is bad.

Only 3 instances of file reoccurrences were found, each having a frequency of 2.

TBM S/N	Fib #	Word #
78-13-15	0	40 & 24
72-63-06	295	11
72-63-06	369	11

However the frequency of errors did tend to increase with the file number as shown in Table 2.

Our current measurements on these boards are shown in Table 3. x and y coil currents were measured at 12.5 V, all other currents are at 12.0 volts.

In order to insure the above results were not our system problems, the (4) lowest error rate boards were exchanged with the highest error rate boards.

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The test was repeated for 100 write cycles. All errors moved with the bubbles and bubble boards. No errors were detected in positions previously in error. It was therefore concluded that the cause of errors were <u>not</u> related to components or wiring in our system which are unique to each bit position.

If you have any questions please call me at (408) 734-5700.

Again I would like to repeat that your expedient attention to this matter is of the utmost importance to us in completing our report, in that we wish the report to be as complete and accurate as possible.

Larry Bulduc Project Engineer

LB:nlh

TABLE 1

TBM S/N	BRD S/N	Bit Position		Fa	ilur	Failures vs. Pattern	s. P	attei	u		Total Failures	Types	Types of Failures	ilures	Hard Errors on lst Read	But	Bubble
			-	2	m	4	2 2	9	2	ω		Soft	Hard	Error Shift		Lost	Gained
72-53-11	60	0	2	-	-	0	2	0	-	en	13	8	10	F	9	4	6
74-36-08	05	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
74-36-01	10	2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
78-13-15	08	ß	6	σ	0	0	0	0	د	1	34	0	33	-	33	-	33
54-24-02	02	4	7	13	-	0	0	0	7	15	43	0	40	e	38	т	40
72-63-06	07	2	4	4	വ	0	-	2	0	4	20	0	19	-	12	2	18
72-63-04	90	9	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
68-94-00	03	7	0	-	0	0	-	0	0	0	2	0	-	-	-	-	-
		TOTAL	28 28	28	7	0	4	2	13	33	112	2	103	7			

TA	\BL	.E	2

TBM S/N →	72-53-11	78-13-15	54-24-02	72-63-06	68-94-00	TOTAL
File #						
0-49	0	4	4	1	1	10
50-99	0	0	2	1	0	3
100-149	0	5	0	2	0	7
150-199	1	2	1	0	0	4
200-249	3	5	2	1	0	11
250-299	0	3	4	2	0	9
300-349	1	2	4	1	0	8
350-399	1	1	2	4	0	8
400-449	0	0	4	2	0	6
450-499	1	1	5	0	1	8
500-549	2	4	3	4	0	13
550-599	3	5	6	1	0	15
600-649	1	3	5	1	0	10

3
5

MBM S/N	I _x	Ι _Υ	I _{xo}	I _{xo}	I _R	IA	I _G
72-63-06	±470	±480	39	28	120	55	240
74-36-08	±460	±475	39	28	116	55	245
72-53-11	±465	±480	39	25	120	56	230
54-24-02	±455	±475	38	29	120	55	230
78-13-15	±460	±485	40	30	122	57	235
68-94-00	±455	±480	40	30	124	58	230
74-36-01	±465	±475	40	31	125	55	235
72-63-04	±465	±485	40	25	120	55	240

CURRENT (mA)

RD7/1126-M276 5 August 1977

MEMO TO: Gerald Cox cc: J1126 File Texas Instruments FROM: Larry Bulduc, Develco SUBJECT: Magnetic Bubble Memories

Presently being shipped to T.I. are (5) TBM0103 memories which I believe are defective.

Our findings on each are as follows:

S/N 74-19-12

Analysis - Minor Loop #114 defective in addition to original 13 bad loops.

Test Conditions (mA)

$$I_{x} = \pm 470$$

 $I_{y} = \pm 485$
 $I_{G} = 230$
 $I_{x0} = 41$
 $I_{x1} = 29$
 $I_{R} = 130$
 $I_{A} = 55$

Comments - This mode of failure in the loop would not maintain a bubble.

S/N 74-24-07

Analysis - When writing all bubbles into a file exhibits soft errors at a rate of $60/.9x16^6$. This unit previously exhibited 0 errors in $8.2x10^7$ bits when writing 2 bytes of the file address and complement in each file.

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Example: Odd write passes
$$ADD_{H}$$

 ADD_{L}
 ADD_{H}
 ADD_{L}
 ADD_{L}
Even write passes ADD_{H}
 ADD_{L}
 ADD_{L}
 ADD_{L}
 ADD_{L}

Each write was verified 6 times. In failure mode all bubbles were annihilated, then each file was written, read 10 times before proceeding to the next file. Another unit was installed in the same board and did not exhibit this problem.

Test Conditions

I _x	=	480	I _{XI}	=	30
I y	=	490	I _R	=	120
$I_{_{\rm G}}$	=	230	IA	=	55
I _{xo}	=	39			

Note: I_{R} pulse width = 5.25 µs.

S/N 74-20-02

Analysis - Minor loops 107, 115, 116, 117, 127 defective plus "random" errors. Test Conditions

I _x	=	460	I _{XI} =	
I _Y	=	480	I _R =	120
$I_{_{\rm G}}$	=	220	I _A =	53
I _{xo}	=	40		

Comments - Collapsing field produced no improvement. Error rate >1/92,000.

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S/N 74-20-10

Analysis - Random errors. Error rate approx. $25/5x10^5$ before collapsing field. Error rate = $12/5x10^5$ after collapsing field. Reduced error rate obtained by increasing X, Y coil drive. At 5% over maximum spec error rate $\approx 3/5x10^5$.

Test Conditions

Not known precisely but within spec limits for 25°C.

S/N 72-63-15

Analysis - loops 124, 140 defective. Originally 12 loops defective. Collapsing field reduced error rate from $4/5 \times 10^5$ to $5/2.5 \times 10^6$.

Test Condition

Not known precisely but within specification limits for 25°C.

For your further information:

The bad loops in thirteen of the fourteen TBM0103's in our possession had been written into. This was the result of an earlier discussion with TI which at that time lead us to believe that it was allowable to write into bad loops. (The one exception is S/N 74-19-12 which is being returned to you.)

As a result I attempted collapsing the fields in the TBM0103's that were producing errors. The procedure was per your instructions in our telephone conversation of 28 July 77.

E.G. using a magnet with a field strength of 40 Oe or greater, introduce the field perpendicular to the front surface of the OlO3 at a distance that erases the bubbles.

This procedure worked on 3 of 7 units. The remaining 7 units were apparently not affected by writing in the bad loops as they have error rates of $<1/2.6x10^7$.

Digital timing on our system was measured as follows:

All leading edges with respect to CXB

SIGNAL	LEADING EDGE (µs)	WIDTH (µs)
СХВ	0	3.0
СҮВ	2.5	3.0
СХА	5.0	3.0
СҮА	7.5	3.0

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5)

*Actual test conditions produced by original timing map supplied by TI. Changed to 5.25 μs after these tests.

Your prompt attention to these units will enable us to accurately complete our report to our customer.

Original Develco P.O. #9786 Returned under TI RMR #DL9190-10

Larry Bulduc

Project Engineer

LB:1c

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